

**MAX25169****Automotive, I<sup>2</sup>C-Controlled, 6-Channel, 150mA  
Backlight Driver and 4-Output TFT-LCD Bias  
with ASIL B Features****General Description**

The MAX25169 is a highly integrated TFT power supply and LED backlight driver IC for automotive TFT-LCD applications. This IC integrates one boost converter, one inverting buck-boost converter, two gate-driver supplies, and a boost/SEPIC controller that can power 1 to 6 strings of LEDs in the display backlight.

The source-driver power supplies consist of a boost converter which can provide up to +18V in unipolar mode and an inverting buck-boost converter that can generate a voltage down to -10.5V. The AVDD output can deliver up to 300mA at 13.5V, while NAVDD can provide up to 200mA. The positive source-driver supply-regulation voltage ( $V_{AVDD}$ ) is set using internal NV memory or through I<sup>2</sup>C. The negative source-driver supply voltage ( $V_{NAVDD}$ ) is always tightly regulated to  $-V_{AVDD}$ . The source-driver supplies operate from an input voltage between 2.65V and 5.5V.

The gate-driver power supplies consist of regulated charge pumps that generate up to +31.5V and down to -18V and can deliver up to 15mA each.

The IC features a 6-string LED driver with input switch control (NGATE) that can power up to 6 strings of LEDs with 150mA (max) of current per string.

Logic-controlled and I<sup>2</sup>C-controlled pulse-width modulation (PWM) dimming are included, with minimum pulse widths as low as 300ns and the option of phase shifting the LED strings with respect to one another. When phase shifting is enabled, each string is turned on at a different time, reducing the input and output ripple, as well as audible noise. With phase shifting disabled, the current sinks turn on simultaneously and parallel connection of current sinks is possible.

The startup and shutdown sequences for all power domains are controlled using one of the eight preset modes, which are selectable using internal nonvolatile memory or through the I<sup>2</sup>C interface.

The MAX25169 is available in a 7mm x 7mm, 48-pin TQFN package with an exposed pad, and operates over the -40°C to +125°C ambient temperature range.

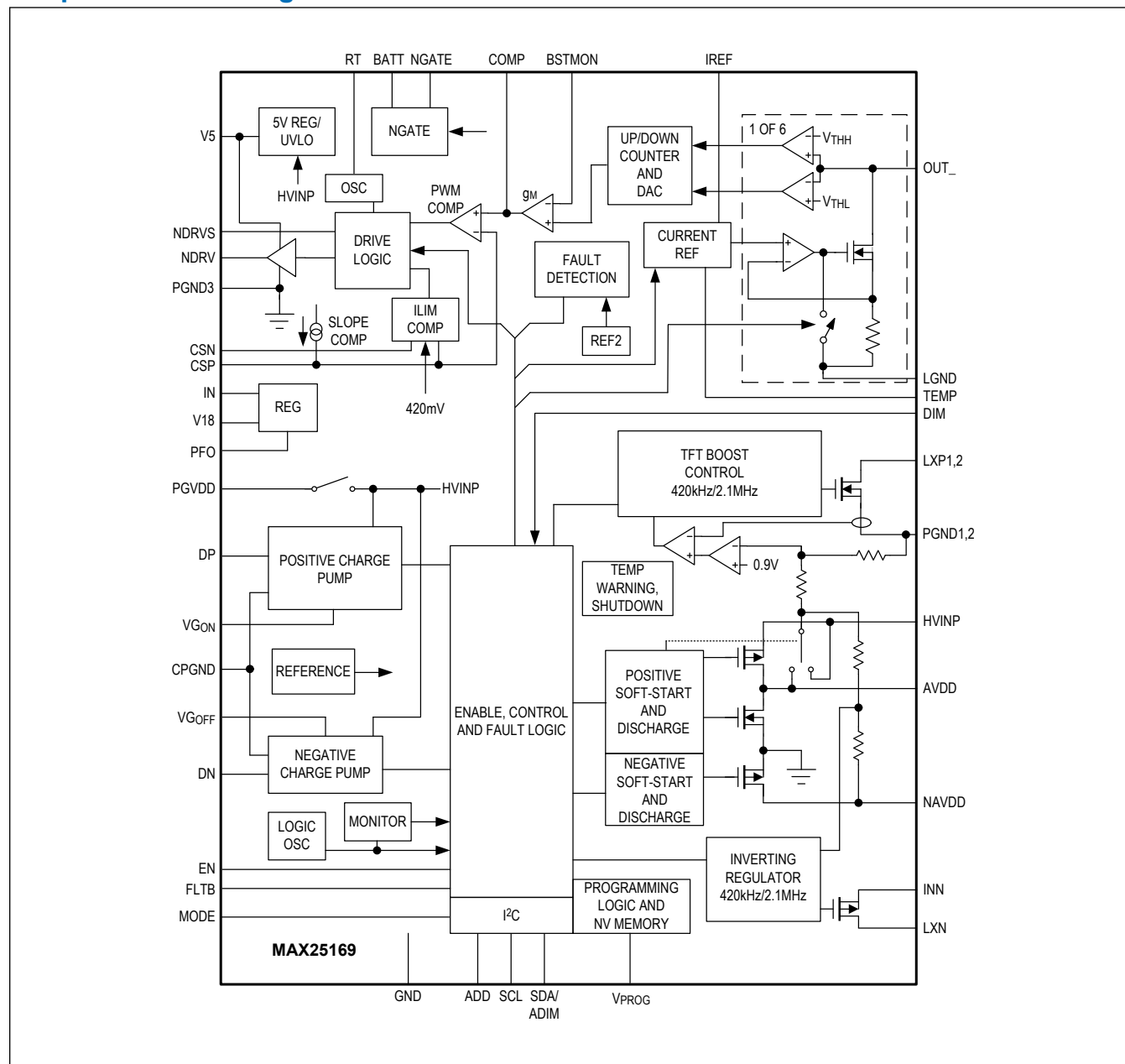
**Applications**

- Automotive Dashboards
- Automotive Central Information Displays
- Automotive Head-Up Displays
- Automotive Navigation Systems

**Benefits and Features**

- 4-Output TFT-LCD Bias Power
  - 2.65V to 5.5V Input for the TFT-LCD Section
  - Integrated 420kHz or 2.1MHz Boost and Buck-Boost Converters
  - Positive and Negative 15mA Gate Voltage Regulators with Adjustable Output Voltage (Tripler/Inverting Doubler)
  - Flexible Sequencing
  - Undervoltage Detection on All Outputs
  - Low-Quiescent-Current Standby Mode
- 6-Channel, 36V LED Backlight Driver
  - NGATE Control for External NMOSFET Series Switch
  - Programmable nMOSFET Current Limit
  - Up to 150mA Current per Channel
  - 4.5V to 36V Input Voltage Range, 3V Operation after Startup
  - Integrated Boost/SEPIC Controller (400kHz to 2.2MHz with Synchronization)
  - Dimming Ratio 16,667:1 at 200Hz
  - Adaptive Voltage Optimization to Reduce Power Dissipation in LED Current Sinks
  - Open-String, Shorted-LED, and Short-to-GND Diagnostics
- Low EMI
  - Phase-Shift Dimming of LED Strings
  - Spread Spectrum on LED Driver and TFT Outputs
  - Selectable Switching Frequency
- I<sup>2</sup>C Interface for Control and Diagnostics
  - Fault Indication through the FLTB Pin and I<sup>2</sup>C
  - Nonvolatile Configuration Memory
- Overload and Thermal Protection
- ASIL B Compliant
- -40°C to +125°C Ambient Temperature Operation
- 7mm x 7mm, 48-Pin TQFN Package with Exposed Pad
- AEC-Q100 Grade 1

## Simplified Block Diagram



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## Absolute Maximum Ratings

BATT, OUT1-6, BSTMON to GND ..... -0.3V to +42V  
 NGATE to BATT ..... +6V  
 NGATE to GND ..... -0.3V to +42V  
 IN, INN, FLTB, PFO, DIM, EN, SDA, SCL to GND... -0.3V to +6V  
 NDRV, NDRVS to GND ..... -0.3V to V<sub>5</sub> + 0.3V  
 TEMP, MODE, CSP, COMP, IREF, RT, ADD to GND ..... -0.3V to V<sub>18</sub> + 0.3V  
 HVINP to GND ..... -0.3V to +22V  
 LXP to GND ..... -0.3V to +30V  
 LXP1/2, PGND1/2 RMS Total Current Rating ..... 2.4A  
 V<sub>5</sub> to GND ..... -0.3V to MIN (6, HVINP + 0.3)V  
 V<sub>18</sub> to GND ..... -0.3V to MIN (2.2, IN + 0.3)V  
 PGVDD, AVDD, DP, DN to GND ..... -0.3V to HVINP + 0.3V  
 LXN to INN ..... -22V to +0.3V  
 LXN, INN RMS Current Rating ..... 1.6A  
 VG<sub>ON</sub> to GND ..... -0.3V to +40V

V<sub>PROG</sub> to GND ..... -0.3V to +12V  
 NAVDD to GND ..... V<sub>V18</sub> - 16V to V<sub>V18</sub> + 0.3V  
 VG<sub>OFF</sub> to GND ..... V<sub>V18</sub> - 22V to V<sub>V18</sub> + 0.3V  
 GND to PGND1, PGND2, PGND3 ..... -0.3V to +0.3V  
 GND to LGND ..... -0.3V to +0.3V  
 GND to CPGND ..... -0.3V to +0.3V  
 GND to CSN ..... -0.3V to +0.3V  
 Continuous Power Dissipation (T<sub>A</sub> = +70°C)  
 48-Pin TQFN-EP (derate 43mW/°C above +70°C), (multilayer board) ..... 3433mW  
 Operating Temperature Range ..... -40°C to +125°C  
 Junction Temperature ..... +150°C  
 Storage Temperature Range ..... -65°C to +150°C  
 Lead Temperature (soldering, 10s) ..... +300°C  
 Soldering Temperature (reflow) ..... +260°C

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

## Package Information

### 48 TQFN

|                                              |                         |
|----------------------------------------------|-------------------------|
| Package Code                                 | T4877+9C                |
| Outline Number                               | <a href="#">21-0144</a> |
| Land Pattern Number                          | <a href="#">90-0464</a> |
| <b>Thermal Resistance, Four-Layer Board:</b> |                         |
| Junction to Ambient (θ <sub>JA</sub> )       | 23.3°C/W                |
| Junction to Case (θ <sub>JC</sub> )          | 1°C/W                   |

For the latest package outline information and land patterns (footprints), go to [www.maximintegrated.com/packages](http://www.maximintegrated.com/packages). Note that a "+", "#", or "-" in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing pertains to the package regardless of RoHS status.

Package thermal resistances were obtained using the method described in JEDEC specification JESD51-7, using a four-layer board. For detailed information on package thermal considerations, refer to [www.maximintegrated.com/thermal-tutorial](http://www.maximintegrated.com/thermal-tutorial).

## Electrical Characteristics

(V<sub>IN</sub> = 3.3V, V<sub>BATT</sub> = 12V, typical operating circuit, T<sub>A</sub> = T<sub>J</sub> = -40°C to +125°C, unless otherwise noted. Typical values are at T<sub>A</sub> = +25°C. ([Note 1](#)))

| PARAMETER                                             | SYMBOL                | CONDITIONS                                  | MIN  | TYP | MAX  | UNITS |
|-------------------------------------------------------|-----------------------|---------------------------------------------|------|-----|------|-------|
| <b>INPUT SUPPLY</b>                                   |                       |                                             |      |     |      |       |
| IN, INN Voltage Range                                 | V <sub>IN_RNG</sub>   |                                             | 2.65 |     | 5.5  | V     |
| IN UVLO Threshold, Rising                             | V <sub>IN_UVLOR</sub> | IN voltage rising                           | 2.4  | 2.5 | 2.57 | V     |
| IN UVLO Threshold, Falling                            | V <sub>IN_UVLOF</sub> |                                             | 2.3  |     | 2.5  | V     |
| PFO Threshold                                         | V <sub>PFO</sub>      | IN falling, pfo_th = 0, PFO output goes low | 2.4  | 2.5 | 2.6  | V     |
| Total Input Shutdown Current (IN + INN + HVINP + LXP) | I <sub>IN_SHDN</sub>  | EN = GND, T <sub>A</sub> = +25°C            |      | 3.5 | 15   | μA    |

**Electrical Characteristics (continued)**

(V<sub>IN</sub> = 3.3V, V<sub>BATT</sub> = 12V, typical operating circuit, T<sub>A</sub> = T<sub>J</sub> = -40°C to +125°C, unless otherwise noted. Typical values are at T<sub>A</sub> = +25°C. ([Note 1](#)))

| PARAMETER                                                 | SYMBOL                      | CONDITIONS                                                                                                                           |                                      | MIN   | TYP  | MAX  | UNITS |
|-----------------------------------------------------------|-----------------------------|--------------------------------------------------------------------------------------------------------------------------------------|--------------------------------------|-------|------|------|-------|
| IN + INN Quiescent Current                                | I <sub>IN_Q</sub>           | V <sub>EN</sub> = 3.3V, no switching                                                                                                 |                                      |       | 2    | 4    | mA    |
| V18 REGULATOR                                             |                             |                                                                                                                                      |                                      |       |      |      |       |
| V18 Output Voltage                                        | V <sub>V18_ACC</sub>        | No load on V18                                                                                                                       |                                      | 1.72  | 1.8  | 1.88 | V     |
| V18 Current Limit                                         | I <sub>LIM_V18</sub>        | V <sub>V18</sub> = 1V                                                                                                                |                                      | 50    |      |      | mA    |
| V18 Undervoltage Lockout                                  | V <sub>V18_UVLO</sub>       | V18 voltage rising                                                                                                                   |                                      | 1.6   | 1.65 | 1.7  | V     |
| V18 Undervoltage Hysteresis                               | V <sub>V18_UVLO_HYS</sub>   |                                                                                                                                      |                                      |       | 150  |      | mV    |
| V18OOR Diagnostic Levels                                  |                             |                                                                                                                                      |                                      |       | ±8   |      | %     |
| TFT POWER SECTION / OSCILLATOR                            |                             |                                                                                                                                      |                                      |       |      |      |       |
| Operating Frequency                                       | f <sub>BOOSTH</sub>         | f <sub>SW</sub> bit = 0, dither disabled                                                                                             |                                      | 1950  | 2100 | 2250 | kHz   |
|                                                           | f <sub>BOOSTL</sub>         | f <sub>SW</sub> bit = 1, dither disabled                                                                                             |                                      | 380   | 420  | 460  |       |
| Frequency Dither                                          | f <sub>BOOSTD</sub>         |                                                                                                                                      |                                      |       | ±6   |      | %     |
| TFT POWER SECTION / BOOST REGULATOR                       |                             |                                                                                                                                      |                                      |       |      |      |       |
| HVINP Output Voltage Range                                | V <sub>HVINP</sub>          | dis_navdd = 0                                                                                                                        |                                      | 4.9   |      | 10.5 | V     |
|                                                           |                             | dis_navdd = 1                                                                                                                        |                                      | 11.7  |      | 18   |       |
| AVDD Adjustment Step Size                                 | V <sub>STEP</sub>           |                                                                                                                                      |                                      |       | 0.1  |      | V     |
| AVDD Output Regulation                                    | V <sub>AVDD_ACC</sub>       | avdd[5:0] = 0x1A, dis_navdd = 0                                                                                                      |                                      | 6.66  | 6.8  | 6.94 | V     |
| LXP Maximum Duty Cycle                                    | D <sub>LXP_MAX</sub>        | 420kHz switching frequency                                                                                                           |                                      | 91.75 | 95   |      | %     |
|                                                           |                             | 2.1MHz switching frequency                                                                                                           |                                      | 91.75 | 95   |      |       |
| Low-Side Switch On-Resistance                             | R <sub>ON_LS_LXP</sub>      | I <sub>LXP</sub> = 0.1A                                                                                                              |                                      |       | 0.1  | 0.2  | Ω     |
| LXP Leakage Current                                       | I <sub>LEAK_LXP</sub>       | V <sub>EN</sub> = 0V, V <sub>LXP</sub> = 15V                                                                                         |                                      |       |      | 6    | μA    |
| LXP Current Limit                                         | I <sub>LIMPHB</sub>         | dis_navdd = 0                                                                                                                        | Duty cycle = 80%,<br>Lxp_Lim_Low = 0 | 1.5   | 1.8  | 2.1  | A     |
|                                                           | I <sub>LIMPLB</sub>         |                                                                                                                                      | Duty cycle = 80%,<br>Lxp_Lim_Low = 1 |       | 1    |      |       |
|                                                           | I <sub>LIMPHU</sub>         | dis_navdd = 1                                                                                                                        | Duty cycle = 80%,<br>Lxp_Lim_Low = 0 | 2.3   | 2.7  | 3.2  |       |
|                                                           | I <sub>LIMPLU</sub>         |                                                                                                                                      | Duty cycle = 80%,<br>Lxp_Lim_Low = 1 |       | 1.35 |      |       |
| Soft-Start Period                                         | t <sub>BOOST_SS</sub>       | Current-limit ramp                                                                                                                   |                                      |       | 5    |      | ms    |
| TFT POWER SECTION / INVERTING REGULATOR                   |                             |                                                                                                                                      |                                      |       |      |      |       |
| LXN Maximum Duty Cycle                                    | D <sub>LXN_MAX</sub>        | f <sub>SW</sub> = 420kHz or 2.1MHz                                                                                                   |                                      | 91.75 | 95   |      | %     |
| V <sub>AVDD</sub> + V <sub>NAVDD</sub> Regulation Voltage | V <sub>NAVDD_AVDD_REG</sub> | V <sub>INN</sub> = 2.65V to 5.5V, V <sub>AVDD</sub> = 6.8V, 1mA < I <sub>NAVDD</sub> < 200mA, I <sub>AVDD</sub> = same load as NAVDD |                                      | -34   | 0    | 34   | mV    |
| LXN On-Resistance                                         | R <sub>ON_LXN</sub>         | I <sub>LXN</sub> = 0.1A                                                                                                              |                                      |       | 0.25 | 0.5  | Ω     |

**Electrical Characteristics (continued)**

( $V_{IN} = 3.3V$ ,  $V_{BATT} = 12V$ , typical operating circuit,  $T_A = T_J = -40^{\circ}C$  to  $+125^{\circ}C$ , unless otherwise noted. Typical values are at  $T_A = +25^{\circ}C$ . (*Note 1*))

| PARAMETER                                         | SYMBOL            | CONDITIONS                                                 | MIN  | TYP  | MAX         | UNITS      |
|---------------------------------------------------|-------------------|------------------------------------------------------------|------|------|-------------|------------|
| LXN Leakage Current                               | $I_{LXN\_LEAK}$   | $V_{LXN} = V_{NAVDD} = -6.8V$ , $T_A = +25^{\circ}C$       |      |      | 20          | $\mu A$    |
| LXN Current Limit                                 | $I_{LIMNL}$       | Duty cycle = 80%, $Lxp\_Lim\_low = 1$                      | 0.6  | 0.8  |             | A          |
|                                                   | $I_{LIMNH}$       | Duty cycle = 80%, $Lxp\_Lim\_low = 0$                      | 1.55 | 1.9  | 2.25        |            |
| Soft-Start Period                                 | $t_{INV\_SS}$     | Current-limit ramp                                         |      | 5    |             | ms         |
| <b>TFT POWER SECTION / CHARGE-PUMP REGULATORS</b> |                   |                                                            |      |      |             |            |
| PGVDD Operating Voltage Range                     | $V_{PGVDD}$       |                                                            | 4.9  |      | $V_{HVINP}$ | V          |
| HVINP-PGVDD Threshold for $V_{GON}$ Startup       | $V_{HVINP-PGVDD}$ | $V_{HVINP} = 5V$                                           | 360  | 520  | 680         | mV         |
| High-Side DP/DN Current Limit                     | $I_{DR\_HS}$      | $V_{HVINP} = 6.8V$ , $V_{DP} = V_{DN} = 3V$                | 95   |      |             | mA         |
| Low-Side DP/DN Current Limit                      | $I_{DR\_LS}$      | $V_{DP} = V_{DN} = 3V$                                     | 95   |      |             | mA         |
| High-Side DP/DN On-Resistance                     | $R_{DR\_HS}$      | $I_{DP} = I_{DN} = -20mA$ , $V_{PGVDD} = V_{HVINP} = 6.8V$ |      | 5    | 8           | $\Omega$   |
| Low-Side DP/DN On-Resistance                      | $R_{DR\_LS}$      | $I_{DP} = I_{DN} = 20mA$                                   |      | 3    | 6           | $\Omega$   |
| $V_{GON}$ Unipolar Voltage Range                  | $V_{GON\_RNG}$    | $dis\_navdd = 1$                                           | 12.6 |      | 31.5        | V          |
| $V_{GON}$ Bipolar Voltage Range                   | $V_{GONRNGB}$     | $dis\_navdd = 0$                                           | 8.4  |      | 21          | V          |
| $V_{GON}$ Unipolar Adjustment Step Size           | $LSB_{VGON}$      | $dis\_navdd = 1$                                           |      | 0.3  |             | V          |
| $V_{GON}$ Bipolar Adjustment Step Size            | $LSB_{VGONB}$     | $dis\_navdd = 0$                                           |      | 0.2  |             | V          |
| $V_{GON}$ Internal Feedback Resistor Value        | $R_{VGON}$        |                                                            | 700  |      | 1250        | k $\Omega$ |
| $V_{GON}$ Output Voltage Accuracy                 | $ACC_{VGON}$      | 0x16h setting                                              | -2   |      | 2           | %          |
| $V_{GOFF}$ Voltage Range                          | $V_{GOFF\_RNG}$   |                                                            | -18  |      | -4          | V          |
| $V_{GOFF}$ Adjustment Step Size                   | $LSB_{VGOFF}$     |                                                            |      | 0.25 |             | V          |
| $V_{GOFF}$ Output-Voltage Accuracy                | $ACC_{VGOFF}$     | 0x16h setting                                              | -3   |      | +3          | %          |
| <b>TFT POWER SECTION / SEQUENCE SWITCHES</b>      |                   |                                                            |      |      |             |            |
| AVDD Switch On-Resistance                         | $R_{ON\_AVDD}$    | $V_{HVINP} = 6.8V$ , $I_{AVDD} = -100mA$                   |      | 0.9  | 1.6         | $\Omega$   |
| AVDD Switch Current Limit                         | $I_{LIM\_AVDD}$   |                                                            | 400  | 500  | 650         | mA         |
| AVDD Discharge Resistance                         | $R_{AVDD\_DIS}$   | AVDD disabled, $V_{V18} > V_{V18\_UVLO}$                   |      | 1.2  |             | k $\Omega$ |
| PGVDD On-Resistance                               | $R_{ON\_PGVDD}$   | ( $HVINP - PGVDD$ ), $I_{PGVDD} = 10mA$                    |      | 2.5  | 5           | $\Omega$   |

**Electrical Characteristics (continued)**

(V<sub>IN</sub> = 3.3V, V<sub>BATT</sub> = 12V, typical operating circuit, T<sub>A</sub> = T<sub>J</sub> = -40°C to +125°C, unless otherwise noted. Typical values are at T<sub>A</sub> = +25°C. (*Note 1*))

| PARAMETER                                       | SYMBOL                 | CONDITIONS                                               | MIN  | TYP | MAX  | UNITS |
|-------------------------------------------------|------------------------|----------------------------------------------------------|------|-----|------|-------|
| PGVDD Current Limit                             | I <sub>LIM_PGVD</sub>  | V <sub>PGVDD</sub> = 3V, V <sub>HVINP</sub> = 6.8V       | 70   | 100 |      | mA    |
| VG <sub>ON</sub> Discharge Resistance           | R <sub>DIS_VGON</sub>  |                                                          | 2    | 3   | 4    | kΩ    |
| VG <sub>OFF</sub> Discharge Current             | I <sub>DIS_VGOFF</sub> |                                                          |      | 1.5 |      | mA    |
| NAVDD Discharge Resistance                      | R <sub>NAVDD_DIS</sub> | NAVDD disabled, V <sub>V18</sub> > V <sub>V18_UVLO</sub> |      | 1   |      | kΩ    |
| <b>TFT POWER SECTION / TFT FAULT PROTECTION</b> |                        |                                                          |      |     |      |       |
| Fault Timeout                                   | t <sub>FAULT</sub>     | tfault[1:0] = 10                                         |      | 60  |      | ms    |
| Fault Retry Time                                | t <sub>AUTO</sub>      | tretry[1:0] = 10 or 11                                   |      | 1.9 |      | s     |
| FLTB Output Frequency                           |                        | Stand-alone mode only                                    | 0.88 | 1   | 1.12 | kHz   |
| HVINP/AVDD Undervoltage Fault Threshold         | THR <sub>UV</sub>      | Relative measurement between HVINP and AVDD              | 81   | 85  | 89   | %     |
| HVINP/AVDD Overvoltage Fault Threshold          | THR <sub>OV</sub>      | Percentage of set value, voltage rising                  | 111  | 115 | 119  | %     |
| HVINP/AVDD Short-Circuit Fault Threshold        | THR <sub>SHRT</sub>    |                                                          | 36   | 40  | 44   | %     |
| NAVDD Undervoltage Fault Threshold              | THR <sub>UV</sub>      | Of AVDD regulation voltage, NAVDD rising                 | 81   | 85  | 89   | %     |
| NAVDD Overvoltage Fault Threshold               | THR <sub>OV</sub>      | Of AVDD regulation voltage, NAVDD voltage falling        | 111  | 115 | 119  | %     |
| NAVDD Short-Circuit Fault Threshold             | THR <sub>SHRT</sub>    | Of AVDD regulation voltage, NAVDD voltage rising         | 36   | 40  | 44   | %     |
| VG <sub>ON</sub> Undervoltage Fault Threshold   | THR <sub>UV</sub>      | Of set value, VG <sub>ON</sub> voltage falling           | 81   | 85  | 89   | %     |
| VG <sub>ON</sub> Overvoltage Fault Threshold    | THR <sub>OV</sub>      | Of set value, VG <sub>ON</sub> voltage rising            | 111  | 115 | 119  | %     |
| VG <sub>OFF</sub> Undervoltage Fault Threshold  | THR <sub>UV</sub>      | Of set value, VG <sub>OFF</sub> voltage rising           | 78   |     | 88   | %     |
| VG <sub>OFF</sub> Overvoltage Fault Threshold   | THR <sub>OV</sub>      | Of set value, VG <sub>OFF</sub> voltage falling          | 105  |     | 120  | %     |
| Short-Circuit Fault Delay                       |                        | After completion of soft-start                           |      | 10  |      | μs    |
| Bandgap Out-of-Range Diagnostic Threshold       |                        |                                                          |      | ±11 |      | %     |
| <b>LED BACKLIGHT DRIVER</b>                     |                        |                                                          |      |     |      |       |
| BATT Operating Voltage Range                    | V <sub>BATT</sub>      |                                                          | 4.5  |     | 36   | V     |
| BATT Operating Voltage Range after Startup      | V <sub>BATT</sub>      | Maximum duration 100ms                                   | 3    |     | 36   | V     |
| BATT Quiescent Supply Current                   | I <sub>Q_BATT</sub>    |                                                          |      | 5   | 10   | μA    |

**Electrical Characteristics (continued)**

( $V_{IN} = 3.3V$ ,  $V_{BATT} = 12V$ , typical operating circuit,  $T_A = T_J = -40^{\circ}C$  to  $+125^{\circ}C$ , unless otherwise noted. Typical values are at  $T_A = +25^{\circ}C$ . (*Note 1*))

| PARAMETER                                          | SYMBOL                 | CONDITIONS                                                                                               | MIN  | TYP  | MAX  | UNITS |
|----------------------------------------------------|------------------------|----------------------------------------------------------------------------------------------------------|------|------|------|-------|
| BATT Shutdown Supply Current                       | I <sub>BATT_SHDN</sub> | V <sub>EN</sub> = 0V, T <sub>A</sub> = +25°C, typical application circuit                                |      | 1    | 3    | μA    |
| BATT Undervoltage Lockout, Rising                  | V <sub>BATT_UVR</sub>  | BATT voltage rising                                                                                      | 4.15 | 4.29 | 4.4  | V     |
| BATT Undervoltage Lockout, Falling                 | V <sub>BATT_UVF</sub>  | BATT voltage falling                                                                                     | 2.77 | 2.9  | 2.95 | V     |
| BATT Threshold for Low-Voltage Operation Mode      | V <sub>BATT_LVF</sub>  | BATT voltage falling                                                                                     | 5.35 | 5.5  | 5.65 | V     |
|                                                    | V <sub>BATT_LVR</sub>  | BATT voltage rising                                                                                      | 5.55 | 5.72 | 5.85 |       |
| LED BACKLIGHT DRIVER / V5 REGULATOR                |                        |                                                                                                          |      |      |      |       |
| V5 Output Voltage                                  | V <sub>V5</sub>        | 5.75V < V <sub>HVINP</sub> < 18V, I <sub>V5</sub> = 1mA to 10mA                                          | 4.8  | 5    | 5.2  | V     |
| V5 Dropout Voltage                                 | V <sub>V5_DRP</sub>    | V <sub>HVINP</sub> = 4.9V, I <sub>V5</sub> = 5mA                                                         |      | 0.05 | 0.12 | V     |
| V5 Undervoltage Lockout                            | V <sub>V5_UVLOR</sub>  | V5 voltage rising                                                                                        | 3.8  | 3.9  | 4.1  | V     |
|                                                    | V <sub>V5_UVLOF</sub>  | V5 voltage falling                                                                                       | 3.6  | 3.7  | 3.8  |       |
| V5 Short-Circuit Current Limit                     | I <sub>V5_SC</sub>     | V5 shorted to GND                                                                                        | 50   |      |      | mA    |
| V5 Overvoltage Threshold                           |                        |                                                                                                          | 5.6  | 5.75 | 5.9  | V     |
| LED BACKLIGHT DRIVER / NGATE OUTPUT                |                        |                                                                                                          |      |      |      |       |
| NGATE Output Voltage                               | V <sub>NGATE</sub>     | Above V <sub>BATT</sub> , 3.3V < V <sub>BATT</sub> < 33V, I <sub>NGATE</sub> = 1μA                       | 4.3  | 5.25 | 6    | V     |
| NGATE Source Current                               | I <sub>NG_SO</sub>     | V <sub>NGATE</sub> = V <sub>BATT</sub>                                                                   | 30   | 50   |      | μA    |
| NGATE Sink Current                                 | I <sub>NG_SINK</sub>   |                                                                                                          | 0.4  | 0.7  |      | mA    |
| NGATE Output Voltage at High Input Voltage         | V <sub>NGATE_HV</sub>  | Above V <sub>BATT</sub> , V <sub>BATT</sub> > 35.5V, I <sub>NGATE</sub> = 1μA                            | -0.3 |      | 0    | V     |
| BATT HV Comparator Threshold                       | V <sub>LD_THR</sub>    | BATT voltage rising                                                                                      | 33   |      | 35.5 | V     |
| BATT HV Comparator Hysteresis                      | V <sub>LD_HYS</sub>    |                                                                                                          |      | 0.7  |      | V     |
| NGATE Start Delay                                  | t <sub>NG_DEL</sub>    | Delay between NGATE charge-pump turning on and BSTMON rising                                             |      | 2    | 2.2  | ms    |
| LED BACKLIGHT DRIVER / RT OSCILLATOR               |                        |                                                                                                          |      |      |      |       |
| Switching Frequency Range                          | f <sub>SW_RT</sub>     | Frequency dithering disabled                                                                             | 400  |      | 2200 | kHz   |
| Oscillator Frequency Accuracy                      |                        | I <sub>RT</sub> = 13.85μA (f <sub>SW</sub> = 400kHz), I <sub>RT</sub> = 75μA (f <sub>SW</sub> = 2200kHz) | -10  |      | 10   | %     |
| Boost Converter Maximum Duty Cycle, High Frequency |                        | 1.3MHz to 2.2MHz                                                                                         | 89   | 91   | 94   | %     |
| Boost Converter Maximum Duty Cycle, Low Frequency  |                        | f <sub>SW</sub> = 400kHz to 1.3MHz                                                                       | 94   |      | 98   | %     |

**Electrical Characteristics (continued)**

(V<sub>IN</sub> = 3.3V, V<sub>BATT</sub> = 12V, typical operating circuit, T<sub>A</sub> = T<sub>J</sub> = -40°C to +125°C, unless otherwise noted. Typical values are at T<sub>A</sub> = +25°C. ([Note 1](#)))

| PARAMETER                                              | SYMBOL                 | CONDITIONS                                                            | MIN   | TYP  | MAX   | UNITS |
|--------------------------------------------------------|------------------------|-----------------------------------------------------------------------|-------|------|-------|-------|
| Boost Minimum On-Time                                  |                        |                                                                       |       | 60   |       | ns    |
| Frequency Dither, High Setting                         | SSHI                   | bl_ssl = 0                                                            |       | ±6   |       | %     |
| Frequency Dither, Low Setting                          | SSLO                   | bl_ssl = 1                                                            |       | ±4   |       | %     |
| RT Output Voltage                                      | V <sub>RT</sub>        | R <sub>RT</sub> = 65kΩ or R <sub>RT</sub> = 10kΩ                      | 0.875 | 0.9  | 0.925 | V     |
| Sync Threshold                                         | V <sub>RT_SYNC</sub>   | V <sub>RT</sub> rising                                                | 0.77  |      | 0.84  | V     |
| Sync Frequency Duty-Cycle                              | D <sub>SYNC</sub>      |                                                                       |       | 50   |       | %     |
| Sync Frequency Range                                   |                        |                                                                       | 400   |      | 2200  | kHz   |
| <b>LED BACKLIGHT DRIVER / SLOPE COMPENSATION</b>       |                        |                                                                       |       |      |       |       |
| Peak Slope-Compensation Current Ramp per Cycle         | I <sub>SLOPE</sub>     | Current ramp added to CS                                              | 42    | 50   | 60    | μA    |
| <b>LED BACKLIGHT DRIVER / CURRENT-LIMIT COMPARATOR</b> |                        |                                                                       |       |      |       |       |
| CSP Threshold Voltage                                  | V <sub>CSP-CSNL</sub>  | bl_ilim = 1                                                           | 275   | 300  | 325   | mV    |
|                                                        | V <sub>CSP-CSN</sub>   | bl_ilim = 0                                                           | 380   | 410  | 440   |       |
| CSP Threshold Voltage During Low Voltage               | V <sub>CSP_LV</sub>    | V <sub>BATT</sub> < V <sub>BATT_LVF</sub> , V <sub>BATT</sub> falling | 560   | 600  | 640   | mV    |
| CSP Input Current                                      | I <sub>CSP</sub>       | V <sub>EN</sub> = 0V, V <sub>CSP</sub> = 0.4V                         |       |      | +1    | μA    |
| <b>LED BACKLIGHT DRIVER / ERROR AMPLIFIER</b>          |                        |                                                                       |       |      |       |       |
| OUT_Regulation High Threshold                          | V <sub>THH</sub>       | V <sub>OUT_</sub> rising                                              | 0.825 | 0.85 | 0.875 | V     |
| OUT_Regulation Low Threshold                           | V <sub>THL</sub>       | V <sub>OUT_</sub> falling                                             | 0.55  | 0.58 | 0.61  | V     |
| Transconductance                                       | g <sub>M</sub>         |                                                                       | 410   | 630  | 890   | μS    |
| COMP Sink Current                                      | I <sub>COMP_SINK</sub> | V <sub>COMP</sub> = 1V                                                | 270   | 380  | 500   | μA    |
| COMP Source Current                                    | I <sub>COMP_SRC</sub>  | V <sub>COMP</sub> = 1V                                                | 270   | 380  | 500   | μA    |
| <b>LED BACKLIGHT DRIVER / MOSFET DRIVER</b>            |                        |                                                                       |       |      |       |       |
| NDRV On-Resistance                                     | R <sub>NDRV_LS</sub>   | V <sub>V5</sub> = 5V, I <sub>NDRV</sub> = 100mA                       |       | 1.2  | 2     | Ω     |
|                                                        | R <sub>NDRV_HS</sub>   | V <sub>V5</sub> = 5V, I <sub>NDRV</sub> = -100mA                      |       | 1.5  | 3     |       |
| NDRV Rise Time                                         | t <sub>NDRV_R</sub>    | C <sub>NDRV</sub> = 1nF, ( <a href="#">Note 2</a> )                   |       | 8    |       | ns    |
| NDRV Fall Time                                         | t <sub>NDRV_F</sub>    | C <sub>NDRV</sub> = 1nF, ( <a href="#">Note 2</a> )                   |       | 8    |       | ns    |
| NDRVS Input Logic-Low                                  | V <sub>IL_NDRVS</sub>  | V <sub>NDRVS</sub> falling                                            |       | 2    | 2.4   | V     |
| NDRVS Input Logic-High                                 | V <sub>IH_NDRVS</sub>  | V <sub>NDRVS</sub> rising                                             | 2.55  | 3.3  |       | V     |
| NDRVS Input Current                                    | I <sub>NDRVS</sub>     | V <sub>NDRVS</sub> = 5V                                               |       | 60   |       | μA    |
| <b>LED BACKLIGHT DRIVER / LED CURRENT SINKS</b>        |                        |                                                                       |       |      |       |       |
| IREF Output Voltage                                    | V <sub>IREF</sub>      | I <sub>IREF</sub> = 40μA                                              | 0.86  | 0.88 | 0.9   | V     |

**Electrical Characteristics (continued)**

( $V_{IN} = 3.3V$ ,  $V_{BATT} = 12V$ , typical operating circuit,  $T_A = T_J = -40^{\circ}C$  to  $+125^{\circ}C$ , unless otherwise noted. Typical values are at  $T_A = +25^{\circ}C$ . (*Note 1*))

| PARAMETER                                                             | SYMBOL              | CONDITIONS                                                                                                      | MIN  | TYP  | MAX   | UNITS   |
|-----------------------------------------------------------------------|---------------------|-----------------------------------------------------------------------------------------------------------------|------|------|-------|---------|
| Full-Scale OUT_ Output Current                                        | $I_{OUT\_}$         | iset[6:0] = 0x7F, 150mA setting                                                                                 | 145  | 150  | 154   | mA      |
|                                                                       | $I_{OUT100}$        | iset[6:0] = 0x4D, 100mA setting                                                                                 | 97   | 100  | 103   |         |
|                                                                       | $I_{OUT50}$         | iset[6:0] = 0x1B, 50mA setting                                                                                  | 48   | 50   | 52    |         |
|                                                                       | $I_{OUT23}$         | iset[6:0] = 0x00, 23mA setting                                                                                  | 21.5 | 23   | 25.2  |         |
| Current Regulation Between Strings                                    | $I_{OUT\_MATCH150}$ | $I_{OUT\_} = 150mA$ , design target                                                                             | -2   |      | +2    | %       |
| Current-Setting Resolution                                            | $I_{OUT\_LSB}$      |                                                                                                                 |      | 1    |       | mA      |
| OUT_ Leakage Current                                                  | $I_{OUT\_LEAK}$     | $V_{OUT\_} = 36V$ , DIM = 0, all OUT_ pins shorted together, $T_A = +25^{\circ}C$                               |      | 0.1  | 5     | $\mu A$ |
|                                                                       |                     | $V_{OUT\_} = 36V$ , DIM = 0, all OUT_ pins shorted together                                                     |      | 0.1  | 15    | $\mu A$ |
| OUT_ Minimum Pulse Width                                              |                     |                                                                                                                 |      | 300  |       | ns      |
| OUT_ Minimum Negative Pulse Width                                     |                     |                                                                                                                 |      | 90   |       | ns      |
| $I_{OUT\_}$ Rise Time                                                 | $I_{OUT\_TR}$       | $I_{OUT\_} = 150mA$ , 10% to 90% $I_{OUT\_}$                                                                    |      | 150  |       | ns      |
| $I_{OUT\_}$ Fall Time                                                 | $I_{OUT\_TF}$       | $I_{OUT\_} = 150mA$ , 90% to 10% $I_{OUT\_}$                                                                    |      | 20   |       | ns      |
| <b>LED BACKLIGHT DRIVER / DIM, ADIM INPUTS</b>                        |                     |                                                                                                                 |      |      |       |         |
| DIM Frequency Range                                                   |                     |                                                                                                                 | 90   |      | 50000 | Hz      |
| DIM Sampling Frequency                                                |                     |                                                                                                                 |      | 20   |       | MHz     |
| ADIM Input Frequency Range                                            |                     |                                                                                                                 | 10   |      | 100   | kHz     |
| <b>LED BACKLIGHT DRIVER / LED FAULT DETECTION</b>                     |                     |                                                                                                                 |      |      |       |         |
| LED Short-Detection Threshold                                         | $V_{THSHRT}$        | I <sup>2</sup> C mode, bit configuration = 11 (00: short detection disabled), default value in stand-alone mode | 7.7  | 8    | 8.3   | V       |
|                                                                       |                     | I <sup>2</sup> C mode, led_short_th[1:0] = 10                                                                   | 5.75 | 6    | 6.25  |         |
|                                                                       |                     | I <sup>2</sup> C mode, led_short_th[1:0] = 01                                                                   | 2.8  | 3    | 3.2   |         |
| OUT_ Check-LED-Source Current                                         | $I_{OUT\_CKLED}$    | $V_{OUT\_} = 0.5V$                                                                                              | 50   | 60   | 70    | $\mu A$ |
| OUT_ Short-to-GND Detection Threshold                                 | $V_{OUT\_GND}$      | $V_{OUT\_}$ falling                                                                                             | 230  | 250  | 270   | mV      |
| OUT_ Unused-Detection High Threshold                                  | $V_{OUT\_UN}$       |                                                                                                                 | 0.8  | 0.85 | 0.9   | V       |
| OUT_ Open-LED-Detection Threshold                                     | $V_{OUT\_OPEN}$     |                                                                                                                 | 230  | 250  | 270   | mV      |
| Shorted-LED-Detection Flag Delay                                      | $t_{SHRT}$          |                                                                                                                 |      | 6.8  |       | $\mu s$ |
| <b>LED BACKLIGHT DRIVER / OVERVOLTAGE AND UNDERVOLTAGE PROTECTION</b> |                     |                                                                                                                 |      |      |       |         |
| BSTMON Overvoltage Threshold                                          | $V_{BSTMON\_OV}$    | $V_{BSTMON}$ rising                                                                                             | 0.92 | 0.95 | 0.98  | V       |

**Electrical Characteristics (continued)**

(V<sub>IN</sub> = 3.3V, V<sub>BATT</sub> = 12V, typical operating circuit, T<sub>A</sub> = T<sub>J</sub> = -40°C to +125°C, unless otherwise noted. Typical values are at T<sub>A</sub> = +25°C. (*Note 1*))

| PARAMETER                                                    | SYMBOL                     | CONDITIONS                                                                           | MIN   | TYP   | MAX   | UNITS |    |
|--------------------------------------------------------------|----------------------------|--------------------------------------------------------------------------------------|-------|-------|-------|-------|----|
| BSTMON Overvoltage Hysteresis                                | V <sub>BSTMON_OV_HYS</sub> |                                                                                      | 50    |       |       | mV    |    |
| BSTMON Input Bias Current                                    | I <sub>BSTMON</sub>        | 0 < V <sub>BSTMON</sub> < 1V                                                         | -1    |       | +1    | μA    |    |
| BSTMON Undervoltage-Trip Threshold                           | V <sub>OVPUVLO</sub>       | V <sub>BSTMON</sub> rising                                                           | 0.384 | 0.4   | 0.416 | V     |    |
| Boost Undervoltage-Detection Delay                           | OVP <sub>UVLO_B</sub> LK   |                                                                                      | 10    |       |       | μs    |    |
| Boost Undervoltage-Blanking Time                             |                            | After soft-start, fast <sub>ss</sub> = 1                                             | 26.28 | 28.46 | 30.74 | ms    |    |
|                                                              |                            | After soft-startup, fast <sub>ss</sub> = 0                                           | 49    | 53.25 | 57.5  |       |    |
| TEMP PIN                                                     |                            |                                                                                      |       |       |       |       |    |
| TEMP Pin Voltage                                             | V <sub>TEMP</sub>          | I <sub>TEMP</sub> = -10μA                                                            | 380   | 400   | 420   | mV    |    |
| TEMP to IOUT_ Gain                                           |                            |                                                                                      | 0.667 |       |       | %/μA  |    |
| TEMP Pin Disable Threshold                                   |                            |                                                                                      | 0.5   |       |       | V     |    |
| TEMP Pin Leakage Current                                     |                            | +25°C                                                                                | 0.05  |       |       | 1     | μA |
| TEMP Current for LED Current Disable                         | I <sub>TEMPD</sub>         |                                                                                      | 80    | 120   | 160   | μA    |    |
| PROGRAMMING VOLTAGE                                          |                            |                                                                                      |       |       |       |       |    |
| V <sub>PROG</sub> Voltage                                    |                            |                                                                                      | 8.2   | 8.5   | 8.8   | V     |    |
| V <sub>PROG</sub> Voltage Undervoltage Threshold             |                            | V <sub>PROG</sub> rising                                                             | 8     |       |       | 8.2   | V  |
| V <sub>PROG</sub> Voltage Overvoltage Threshold              |                            | V <sub>PROG</sub> falling                                                            | 8.8   | 9     |       | V     |    |
| V <sub>PROG</sub> Input Current                              |                            | During NV programming, T <sub>A</sub> = +25°C                                        | 9     |       |       | 25    | mA |
| NV Programming Time                                          |                            |                                                                                      | 16    |       |       | 20    | ms |
| LOGIC INPUTS AND OUTPUTS (EN, SCL, SDA, DIM, ADD, MODE, PFO) |                            |                                                                                      |       |       |       |       |    |
| Digital Inputs Logic-High                                    | V <sub>IH</sub>            |                                                                                      | 1.25  |       |       | V     |    |
| Digital Inputs Logic-Low                                     | V <sub>IL</sub>            |                                                                                      | 0.5   |       |       | V     |    |
| Digital Inputs Hysteresis                                    | V <sub>HYS</sub>           |                                                                                      | 300   |       |       | mV    |    |
| EN Input Pull-down Resistor                                  |                            |                                                                                      | 100   | 165   |       | kΩ    |    |
| EN Blanking Time                                             | t <sub>EN_BLK</sub>        |                                                                                      | 10    |       |       | μs    |    |
| DIM Pull-up Current                                          | I <sub>DIM</sub>           | V <sub>DIM</sub> = 0V                                                                | 5     |       |       | μA    |    |
| ADD and MODE Pull-up Current                                 | I <sub>ADD_MODE</sub>      | V <sub>ADD</sub> = V <sub>MODE</sub> = 0V                                            | 2     |       |       | μA    |    |
| SCL Input Current                                            | I <sub>SCL</sub>           | V <sub>SCL</sub> = +5V                                                               | +1    |       |       | μA    |    |
| PFO, FLTB, SDA Output Low Voltage                            | V <sub>OL_OUT</sub>        | I <sub>FLTB</sub> = I <sub>SDA</sub> = I <sub>PFO</sub> = 5mA                        | 0.4   |       |       | V     |    |
| PFO, FLTB, SDA Output Leakage Current                        | I <sub>OUT_LEAK</sub>      | V <sub>EN</sub> = 0V, V <sub>FLTB</sub> = V <sub>SDA</sub> = V <sub>PFO</sub> = 5.5V | +1    |       |       | μA    |    |

**Electrical Characteristics (continued)**

(V<sub>IN</sub> = 3.3V, V<sub>BATT</sub> = 12V, typical operating circuit, T<sub>A</sub> = T<sub>J</sub> = -40°C to +125°C, unless otherwise noted. Typical values are at T<sub>A</sub> = +25°C. ([Note 1](#)))

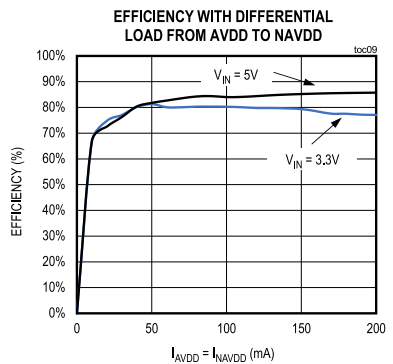
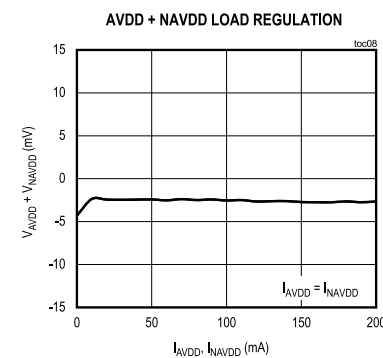
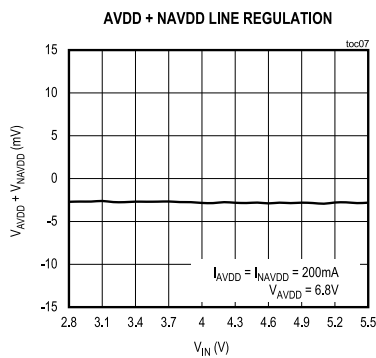
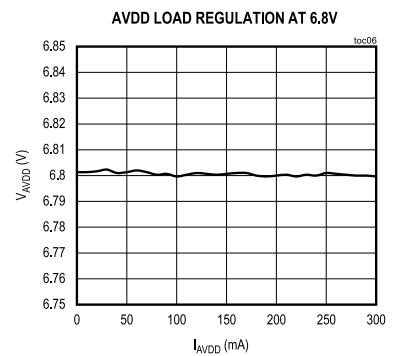
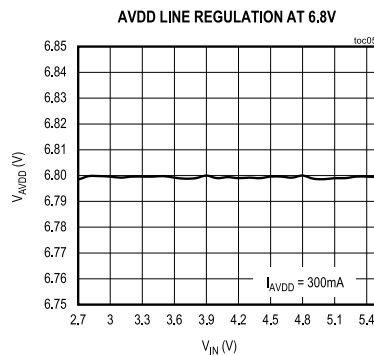
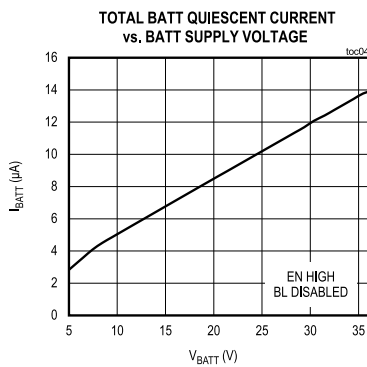
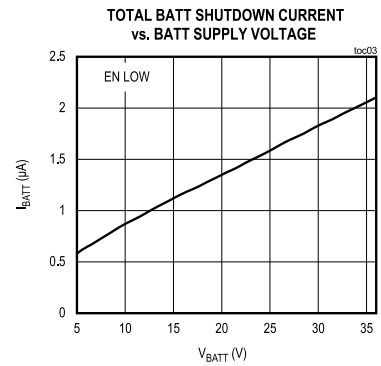
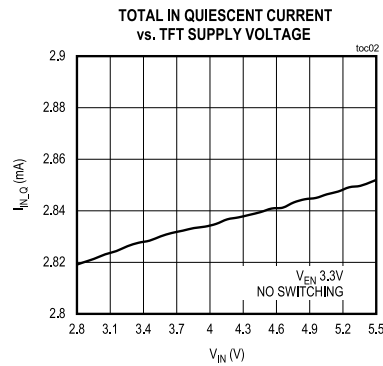
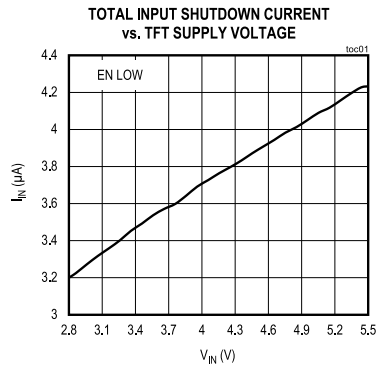
| PARAMETER                                     | SYMBOL                            | CONDITIONS                 | MIN  | TYP    | MAX | UNITS |
|-----------------------------------------------|-----------------------------------|----------------------------|------|--------|-----|-------|
| <b>THERMAL WARNING/SHUTDOWN</b>               |                                   |                            |      |        |     |       |
| Thermal-Warning Threshold, TFT Section        | T <sub>WARN_TFT</sub>             | Temperature rising         |      | 125    |     | °C    |
| Thermal-Warning Threshold, Backlight Section  | T <sub>WARN_BL</sub>              |                            |      | 125    |     | °C    |
| Thermal-Shutdown Threshold, TFT Section       | T <sub>SHDN_TFT</sub>             | Temperature rising         |      | 165    |     | °C    |
| Thermal-Shutdown Threshold, Backlight Section | T <sub>SHDN_BL</sub>              | Temperature rising         |      | 160    |     | °C    |
| Thermal-Shutdown Hysteresis                   | T <sub>SHDN_HYS</sub>             |                            |      | 17     |     | °C    |
| <b>ANALOG-TO-DIGITAL CONVERTER</b>            |                                   |                            |      |        |     |       |
| ADC Measurement Resolution                    | ADC <sub>BIT</sub>                | ( <a href="#">Note 2</a> ) |      | 8      |     | bits  |
| Total Measurement Error, Current              | E <sub>ADC<sub>OUT</sub></sub>    | 150mA setting              | -8   |        | +8  | mA    |
| Total Measurement Error, BSTMON               | E <sub>ADC<sub>BSTMON</sub></sub> | V <sub>BSTMON</sub> = 0.9V | -70  |        | 70  | mV    |
| ADC Gain Error                                | ADC <sub>GAIN</sub>               | 150mA setting              | -4   |        | +4  | %     |
| ADC Offset Error                              | ADC <sub>OFF</sub>                | 150mA setting              | -4   |        | +4  | LSB   |
| Measurement Resolution, Current               | LSB <sub>OUT</sub>                |                            |      | 0.64   |     | mA    |
| Measurement Resolution, BSTMON                | LSB <sub>BSTMON</sub>             |                            |      | 3.9216 |     | mV    |
| <b>I<sup>2</sup>C INTERFACE</b>               |                                   |                            |      |        |     |       |
| Clock Frequency                               | f <sub>SCL</sub>                  |                            |      | 0.4    |     | MHz   |
| Hold Time (Repeated) START                    | t <sub>HD:STA</sub>               |                            | 600  |        |     | ns    |
| SCL Low Time                                  | t <sub>LOW</sub>                  |                            | 1300 |        |     | ns    |
| SCL High Time                                 | t <sub>HIGH</sub>                 |                            | 600  |        |     | ns    |
| Setup Time (Repeated) START                   | t <sub>SU:STA</sub>               |                            | 600  |        |     | ns    |
| Data Hold Time                                | t <sub>HD:DAT</sub>               |                            | 0    |        |     | ns    |
| Data Setup Time                               | t <sub>SU:DAT</sub>               |                            | 100  |        |     | ns    |
| Setup Time for STOP Condition                 | t <sub>SU:STO</sub>               |                            | 600  |        |     | ns    |
| Spike Suppression                             |                                   |                            |      | 50     |     | ns    |

**Note 1:** Limits are 100% tested at T<sub>A</sub> = +25°C, T<sub>A</sub> = +125°C. Limits over the operating temperature range and relevant supply voltage range are guaranteed by design and characterization.

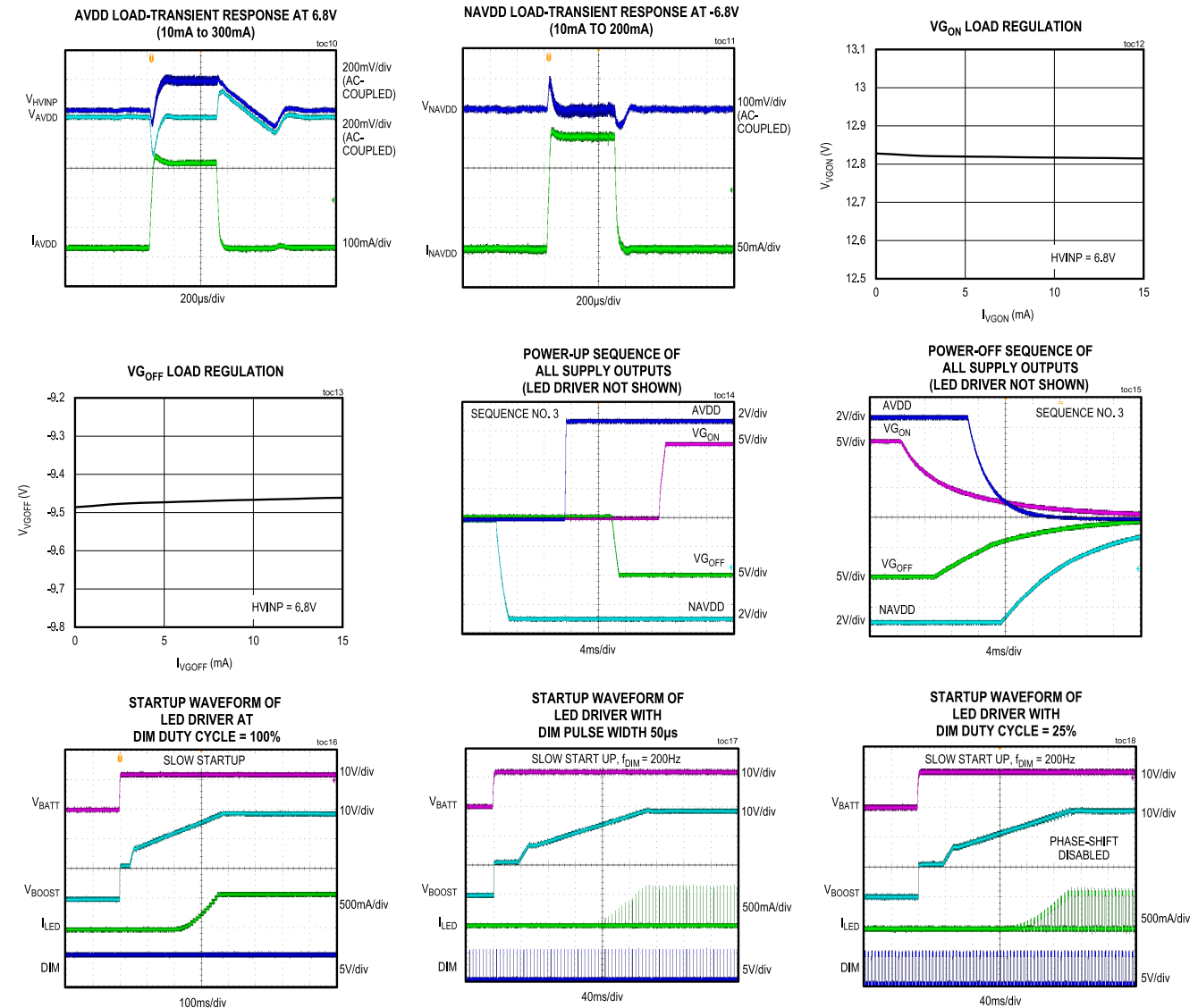
**Note 2:** Guaranteed by design. Not production tested.

## Typical Operating Characteristics

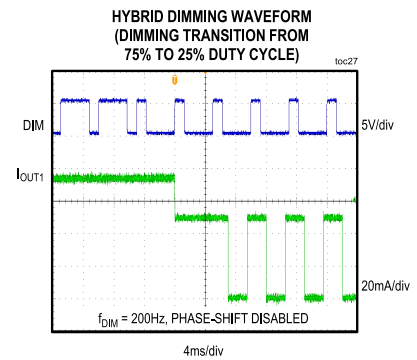
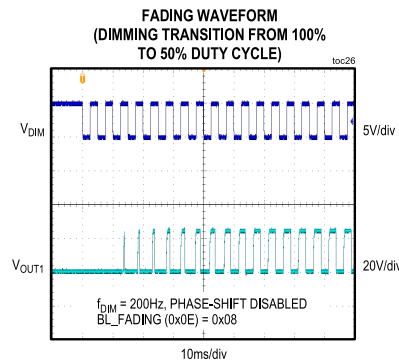
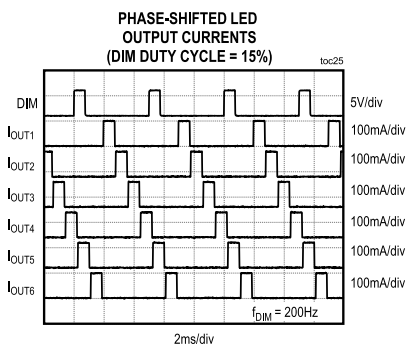
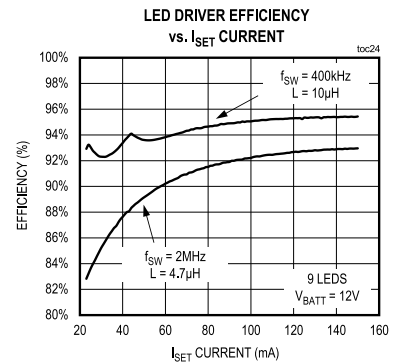
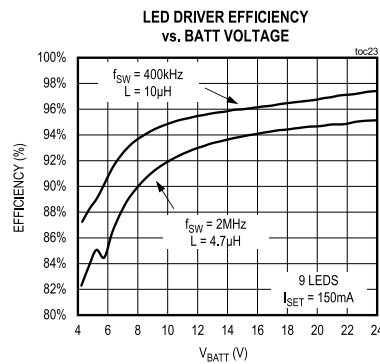
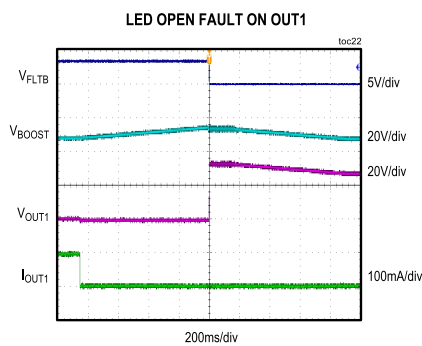
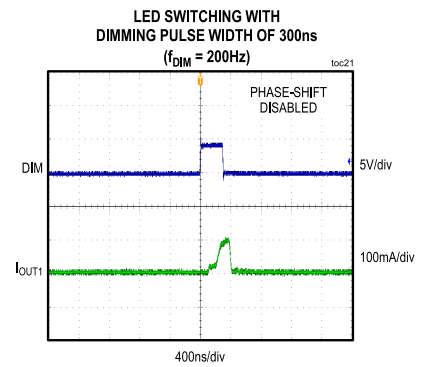
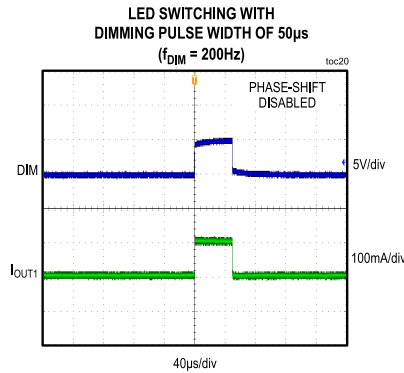
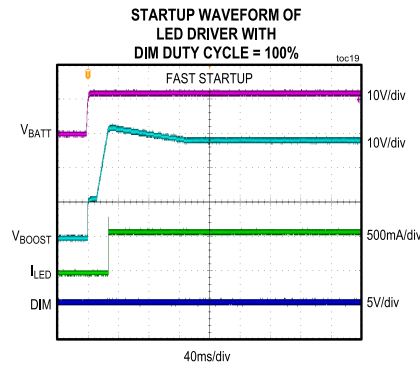
( $T_A = +25^\circ\text{C}$ ,  $V_{IN} = V_{INN} = 3.3\text{V}$ ,  $V_{BATT} = 12\text{V}$ ,  $f_{DIM} = 200\text{Hz}$ , unless otherwise noted.)



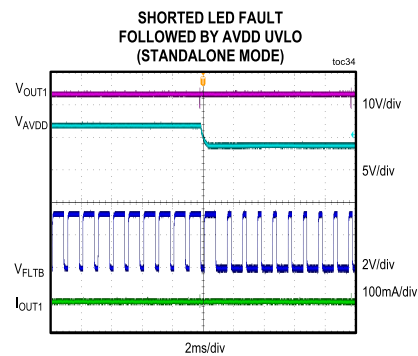
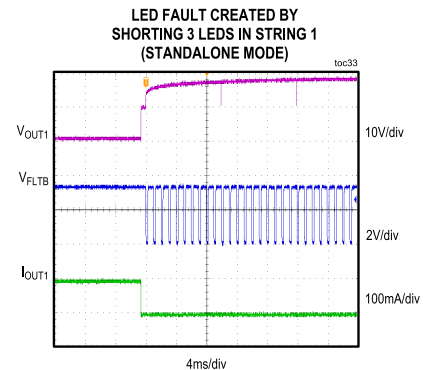
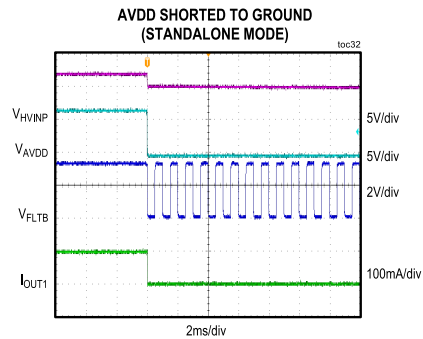
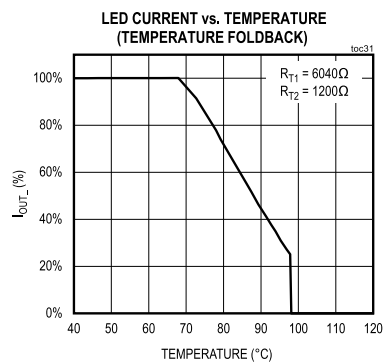
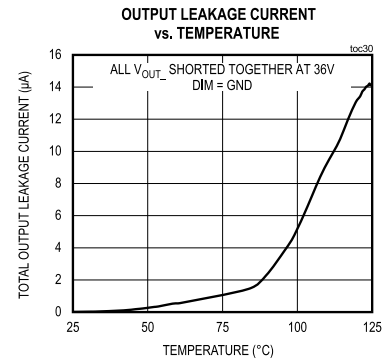
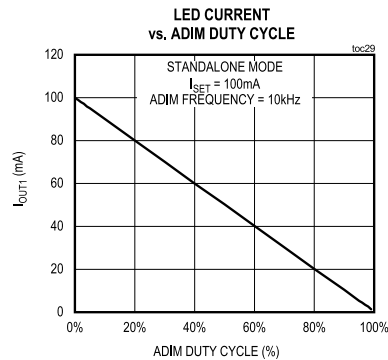
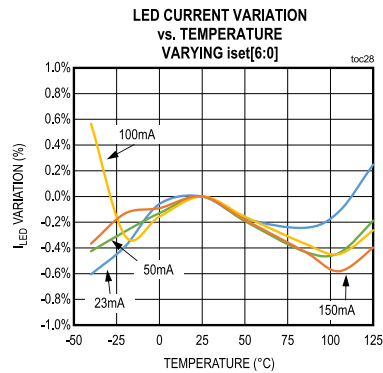
## Typical Operating Characteristics (continued)

(T<sub>A</sub> = +25°C, V<sub>IN</sub> = V<sub>INN</sub> = 3.3V, V<sub>BATT</sub> = 12V, f<sub>DIM</sub> = 200Hz, unless otherwise noted.)

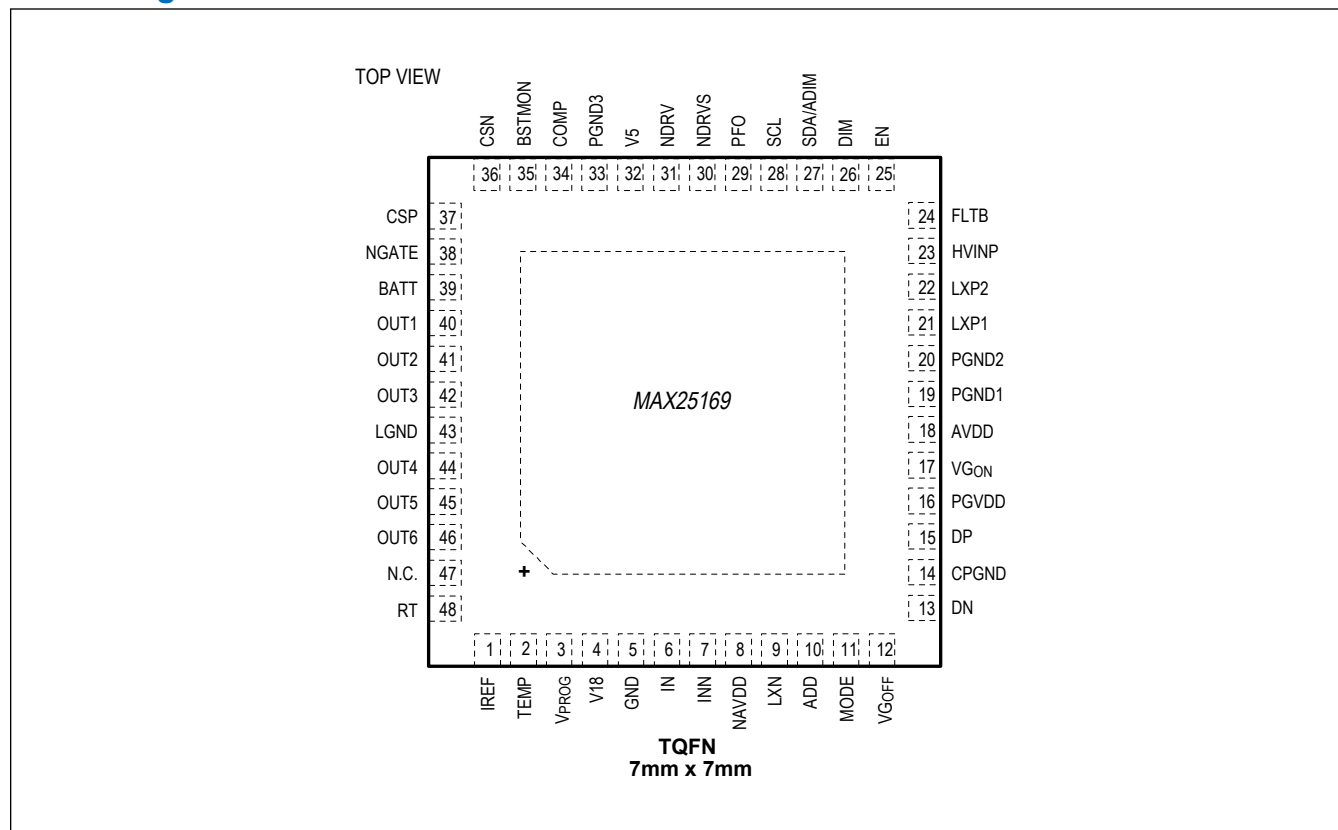
## Typical Operating Characteristics (continued)

(T<sub>A</sub> = +25°C, V<sub>IN</sub> = V<sub>INN</sub> = 3.3V, V<sub>BATT</sub> = 12V, f<sub>DIM</sub> = 200Hz, unless otherwise noted.)

## Typical Operating Characteristics (continued)

(T<sub>A</sub> = +25°C, V<sub>IN</sub> = V<sub>INN</sub> = 3.3V, V<sub>BATT</sub> = 12V, f<sub>DIM</sub> = 200Hz, unless otherwise noted.)

## Pin Configuration



## Pin Description

| PIN | NAME              | FUNCTION                                                                                                                                                                                                                               |
|-----|-------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 1   | IREF              | Reference Current Set Pin. Connect a 1% resistor of value 22kΩ from IREF to GND.                                                                                                                                                       |
| 2   | TEMP              | Temperature Sensor Input. To implement LED current reduction at high temperatures, connect an NTC temperature sensor (e.g., the NTCLE100E3103G) to GND with resistors from the NTC to TEMP and to V18. If unused, connect TEMP to V18. |
| 3   | V <sub>PROG</sub> | Programming Voltage. Apply a voltage of 8.5V to this pin during the programming of nonvolatile registers. Connect to GND through a resistor during normal operation.                                                                   |
| 4   | V18               | Output of Internal 1.8V Regulator. Connect 1μF and 22nF capacitors in parallel from V18 to GND with an additional 100nF capacitor close to the V18 and GND pins.                                                                       |
| 5   | GND               | Ground Connection                                                                                                                                                                                                                      |
| 6   | IN                | Supply Input. Connect at least one 10μF ceramic capacitor from IN to GND for proper operation.                                                                                                                                         |
| 7   | INN               | Buck-Boost Converter Input. Connect a 10μF ceramic capacitor from INN to GND for proper operation.                                                                                                                                     |
| 8   | NAVDD             | Negative Source-Driver Output Voltage                                                                                                                                                                                                  |
| 9   | LXN               | DC-DC Inverting Converter Inductor/Diode Connection                                                                                                                                                                                    |
| 10  | ADD               | Device Address Select Pin. Connect to GND or V18 to select the device I <sup>2</sup> C address. See <a href="#">Table 5</a> . ADD has an internal pull-up to V18.                                                                      |
| 11  | MODE              | Mode Selector Pin. Together with ADD, this pin determines the mode of operation of the I <sup>2</sup> C interface and whether it is used. See <a href="#">Table 3</a> . MODE has an internal pull-up to V18.                           |

## Pin Description (continued)

| PIN | NAME              | FUNCTION                                                                                                                                                                                                                                                                         |
|-----|-------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 12  | VG <sub>OFF</sub> | Output of Negative Charge-Pump Block. Connects directly to the negative charge-pump output to facilitate VG <sub>OFF</sub> discharge through an internal switch connected between VG <sub>OFF</sub> and GND. VG <sub>OFF</sub> is also the regulator feedback pin.               |
| 13  | DN                | Regulated Charge-Pump Driver for the Negative Charge Pump. Connect to an external flying capacitor.                                                                                                                                                                              |
| 14  | CPGND             | Charge Pump Ground                                                                                                                                                                                                                                                               |
| 15  | DP                | Regulated Charge-Pump Driver for Positive Charge Pump. Connect to an external flying capacitor.                                                                                                                                                                                  |
| 16  | PGVDD             | Switched Version of HVINP Voltage for the Positive Charge Pump. Provides soft-start control of the VG <sub>ON</sub> output. Bypass PGVDD with a 1µF ceramic capacitor to GND.                                                                                                    |
| 17  | VG <sub>ON</sub>  | Output of Positive Charge-Pump Block. VG <sub>ON</sub> connects directly to the positive charge-pump output to facilitate VG <sub>ON</sub> discharge through an internal switch connected between VG <sub>ON</sub> and GND. VG <sub>ON</sub> is also the regulator feedback pin. |
| 18  | AVDD              | Positive Source-Driver Output Voltage. Bypass AVDD with a capacitor to GND.                                                                                                                                                                                                      |
| 19  | PGND1             | Power-Ground Connection                                                                                                                                                                                                                                                          |
| 20  | PGND2             | Power-Ground Connection                                                                                                                                                                                                                                                          |
| 21  | LXP1              | Boost HVINP Converter Switching-Node Connection. Connect LXP1 to the external inductor and rectifier diode.                                                                                                                                                                      |
| 22  | LXP2              | Boost HVINP Converter Switching-Node Connection. Connect LXP2 to the external inductor and rectifier diode.                                                                                                                                                                      |
| 23  | HVINP             | Boost Output and Input for the AVDD, PGVDD, and Charge Pumps                                                                                                                                                                                                                     |
| 24  | FLT <sub>B</sub>  | Active-Low, Open-Drain Fault Indication Output. Connect an external pull-up resistor from FLT <sub>B</sub> to an external supply lower than 5V.                                                                                                                                  |
| 25  | EN                | Enable Input. When EN is high, the device is enabled. With EN low, the device is in shutdown with low quiescent current. EN has an internal pull-down resistor.                                                                                                                  |
| 26  | DIM               | PWM Dimming Input. DIM has an internal pull-up to V18.                                                                                                                                                                                                                           |
| 27  | SDA/ADIM          | I <sup>2</sup> C Data I/O. Connect a pull-up resistor from SDA to the system logic supply. In standalone mode, this pin is the analog dimming input (if unused, connect to GND).                                                                                                 |
| 28  | SCL               | I <sup>2</sup> C Clock Input. Connect a pull-up resistor from SCL to the system logic supply.                                                                                                                                                                                    |
| 29  | PFO               | Open-Drain Power-Fail Indicator Pin. When the IN voltage is below a threshold, the PFO output goes low. Add an external pull-up resistor between PFO and IN.                                                                                                                     |
| 30  | NDRVS             | Sense Connection for Gate of External MOSFET. Connect NDRVS directly to the gate after the gate resistor.                                                                                                                                                                        |
| 31  | NDRV              | Switching nMOSFET Gate-Driver Output. Connect NDRV to the gate of the external switching-power MOSFET. Typically, a small resistor (1Ω to 22Ω) is inserted between the NDRV output and nMOSFET gate to decrease the slew rate of the gate driver and reduce the switching noise. |
| 32  | V5                | 5V Regulator Output, Voltage Supply for NDRV Gate Driver. Place a 2.2µF ceramic capacitor as close as possible to V5 and PGND3.                                                                                                                                                  |
| 33  | PGND3             | Power-Ground Connection                                                                                                                                                                                                                                                          |
| 34  | COMP              | LED Driver Switching-Converter Compensation Input. Connect an RC network from COMP to GND to compensate the backlight boost converter (see the <a href="#">Feedback Compensation</a> section).                                                                                   |
| 35  | BSTMON            | LED Driver Output-Voltage-Sensing Input. This voltage is used for overvoltage and undervoltage protection.                                                                                                                                                                       |
| 36  | CSN               | LED Driver MOSFET Negative Current-Sense Connection. Connect this pin directly to the GND side of the compensation network connected to the COMP pin.                                                                                                                            |

## Pin Description (continued)

| PIN | NAME  | FUNCTION                                                                                                                                                                                                                                                                                 |
|-----|-------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 37  | CSP   | LED Driver MOSFET Positive Current-Sense Connection. Connect a sense resistor from the MOSFET source to PGND and a further resistor from the MOSFET source to the CSP pin to set the slope compensation (see the <a href="#">Current-Sense Resistor and Slope Compensation</a> section). |
| 38  | NGATE | Gate Connection for External Series nMOSFET Driven by the Internal Charge Pump                                                                                                                                                                                                           |
| 39  | BATT  | LED Driver Supply Input. Connect BATT to a 4.5V to 36V supply. Bypass BATT to ground with a ceramic capacitor.                                                                                                                                                                           |
| 40  | OUT1  | LED String 1 Cathode Connection                                                                                                                                                                                                                                                          |
| 41  | OUT2  | LED String 2 Cathode Connection. Connect OUT2 to ground using a 9.1kΩ resistor, if not used.                                                                                                                                                                                             |
| 42  | OUT3  | LED String 3 Cathode Connection. Connect OUT3 to ground using a 9.1kΩ resistor, if not used.                                                                                                                                                                                             |
| 43  | LGND  | LED Ground Connection                                                                                                                                                                                                                                                                    |
| 44  | OUT4  | LED String 4 Cathode Connection. Connect OUT4 to ground using a 9.1kΩ resistor, if not used.                                                                                                                                                                                             |
| 45  | OUT5  | LED String 5 Cathode Connection. Connect OUT4 to ground using a 9.1kΩ resistor, if not used.                                                                                                                                                                                             |
| 46  | OUT6  | LED String 6 Cathode Connection. Connect OUT4 to ground using a 9.1kΩ resistor, if not used.                                                                                                                                                                                             |
| 47  | N.C.  | Not internally connected.                                                                                                                                                                                                                                                                |
| 48  | RT    | Frequency Setting Resistor for Backlight Boost Converter                                                                                                                                                                                                                                 |
| —   | EP    | Exposed Pad. Connect to a large contiguous copper-ground plane for optimal heat dissipation. Do not use EP as the only electrical ground connection.                                                                                                                                     |

## Detailed Description

The MAX25169 is a highly integrated TFT power supply and LED backlight driver IC for automotive TFT-LCD applications. The IC integrates one boost converter, one inverting buck-boost converter, two gate-driver supplies, and a boost/SEPIC controller that can power 1 to 6 strings of LEDs in the display backlight. The complete device configuration can be stored in on-board nonvolatile memory.

The source-driver power supplies consist of a boost converter and an inverting buck-boost converter that can generate voltages up to +18V and down to -10.5V. The positive source-driver can deliver up to 300mA at 13.5V, while the negative source driver is capable of 200mA. The positive source-driver-supply regulation voltage ( $V_{AVDD}$ ) is set through I<sup>2</sup>C. The negative source-driver-supply voltage ( $V_{NAVDD}$ ) is always tightly regulated to  $-V_{AVDD}$ . The source-driver supplies operate from an input voltage between 2.65V and 5.5V.

The gate-driver-power supplies consist of regulated charge pumps that generate up to +31.5V and down to -18V and can deliver up to 15mA each.

The IC features a 6-string LED driver with input switch control (NGATE) that can power up to 6 strings of LEDs with 150mA (max) of current per string. Logic-controlled and I<sup>2</sup>C-controlled pulse-width modulation (PWM) dimming are included, with minimum pulse widths as low as 300ns and the option of phase shifting the LED strings with respect to one another. When phase shifting is enabled, each string is turned on at a different time, reducing the input and output ripple, as well as audible noise. With phase shifting disabled, each current sink turns on at the same time and allows parallel connection of current sinks.

The startup and shutdown sequences for all power domains are controlled using one of the eight preset modes that are selectable using a nonvolatile setting. When a regulator other than HVINP is enabled, the HVINP boost is automatically enabled (if not previously active). In this case, the second regulator is enabled when the soft-start of HVINP has completed.

## Supply Voltages

The voltage on IN is the main supply voltage for the device. An on-chip regulator derives a 1.8V supply from the voltage on IN, and this 1.8V supply provides power to most of the on-chip circuitry. The IN voltage must be greater than  $V_{IN\_UVLO}$  to allow device operation. In addition, V18 must be greater than  $V_{V18\_UVLO}$  for the device to function. If the voltage on IN drops below  $V_{PFO}$ , the PFO output asserts low until the V18 supply reaches its undervoltage lockout level. When IN is connected directly to EN, a  $vin\_uvlo$  fault may be detected at power-up. To avoid this, place a filter with a time constant of at least 10ms composed of a resistor from IN to EN and a capacitor from EN to GND.

The voltage on the BATT pin is the reference for the NGATE drive output. The voltage on BATT must exceed  $V_{BATT\_UVR}$  in order for the backlight section to work. (V5 must also exceed  $V_{VCC\_UVLOR}$ .) Once the backlight block is operating, the BATT voltage can drop as low as  $V_{BATT\_UVF}$  while maintaining operation (and V5 must remain above  $V_{VCC\_UVLOF}$  at all times). The drive output for the external boost MOSFET (NDRV) is powered from the V5 voltage, which is nominally 5V. V5 is derived from the HVINP voltage. In the case of HVINP voltages less than 5V, the V5 regulator will be in dropout and the NDRV output will not reach 5V.

## PFO Output

PFO is an open-drain output which indicates that the voltage on the IN pin is below a threshold of  $V_{PFO\_F}$ . The PFO output asserts low in this situation.

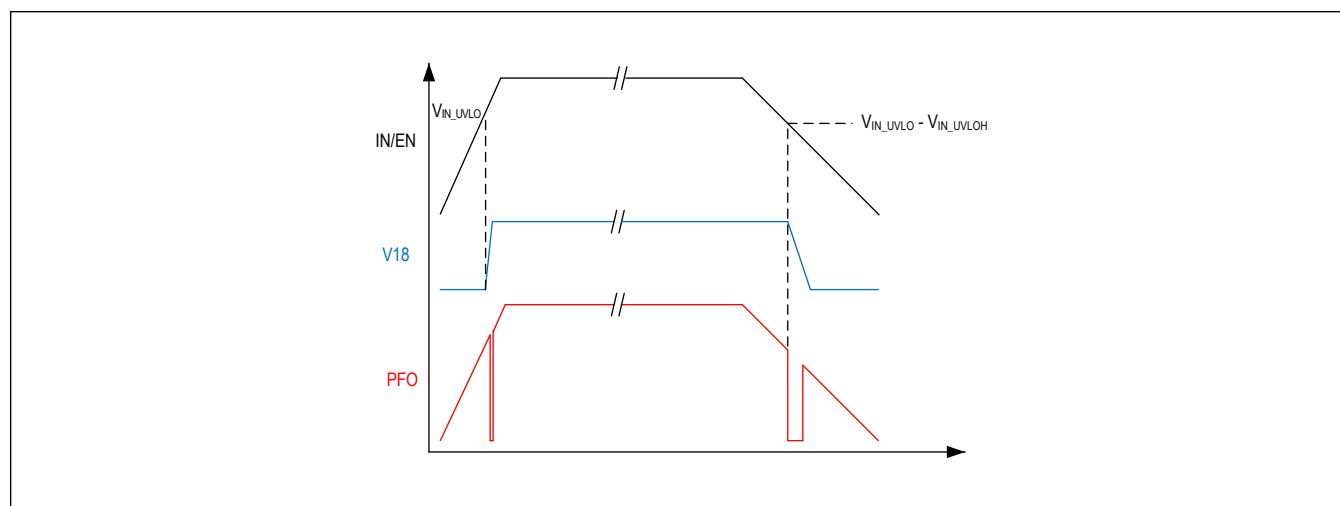


Figure 1. PFO Waveform

The threshold for the PFO output can be selected using the pfo\_th bit in the SEQ register (address 0x09). This bit can also be stored in nonvolatile memory. The nominal thresholds are shown in [Table 1](#):

**Table 1. PFO Thresholds**

| SETTING OF pfo_th BIT | PFO FALLING THRESHOLD (V) |
|-----------------------|---------------------------|
| 0 (default)           | 2.5                       |
| 1                     | 2.4                       |

## TFT Power Section

### Source-Driver Power Supplies

The source-driver power supplies consist of a boost converter (with output at HVINP) with output switch and an inverting buck-boost converter that can be used in one of two ways:

- **Boost converter only or unipolar mode:** In this case, the boost converter output voltage range is from 11.7V to 18V, the V<sub>GON</sub> range is from 12.6V to 31.5V, and the inverting converter is not used. To invoke this mode, set the dis\_navdd bit in register TFT\_CONFIG to 1. In this mode, the external components on LXN and NAVDD can be omitted and INN should be connected to IN.
- **Bipolar mode:** In this mode, both converters operate and the inverting converter output voltage tracks the output voltage of the boost converter. V<sub>NAVDD</sub> cannot be adjusted independently of V<sub>AVDD</sub>. In this mode, the boost converter output voltage range is 4.9V to 10.5V, and the V<sub>GON</sub> range is 8.4V to 21V. This is the default mode of operation (dis\_navdd = 0).

### AVDD Switch

To facilitate sequencing, the AVDD current-limited switch connects the output of the HVINP boost converter to the capacitor at AVDD. When the AVDD output is turned on, the current limit of the switch is increased in eight steps to its final value. The total time to reach the maximum current limit setting is half of the soft-start time as set by the tstart[1:0] field in the SEQ register. This avoids a sudden drop in HVINP voltage or a surge in input current from IN during AVDD start-up.

### Gate-Driver Power Supplies

The positive gate-driver power supply (V<sub>GON</sub>) generates up to +31.5V (max) and the negative gate-driver power supply (V<sub>GOFF</sub>) generates as low as -18V (min). Both can supply up to 15mA output current in tripler/doubling inverter configurations. The V<sub>GON</sub> and V<sub>GOFF</sub> regulation voltages are set independently by writing to the vgon[5:0] and vgo[5:0] fields in the V<sub>GON</sub> and V<sub>GOFF</sub> registers. Note that the V<sub>GON</sub> voltage also depends on the setting of the dis\_navdd bit in

the TFT\_CONFIG register (address 0x07).

## Sequencing

When the start bit in the START register is set to 1, the outputs are enabled in the sequence programmed in the seq\_set bits. The start bit can be set to 1 and stored in the nv\_start nonvolatile bit so that the device powers up automatically when the EN pin is taken high. The setting should be written before the sequence is executed and should not be changed during the turn-on or turn-off sequences. The sequence options are shown in [Table 2](#):

**Table 2. Sequencing**

| SEQUENCE NO. | SEQUENCE SET BITS |          |          | POWER-ON          |                   |                   |                   | POWER-OFF (REVERSE-ORDER OF POWER-ON) |                   |                   |                   |
|--------------|-------------------|----------|----------|-------------------|-------------------|-------------------|-------------------|---------------------------------------|-------------------|-------------------|-------------------|
|              | seq_set2          | seq_set1 | seq_set0 | 1st               | 2nd after t1 ms   | 3rd after t2 ms   | 4th after t3 ms   | 1st                                   | 2nd after t3 ms   | 3rd after t2 ms   | 4th after t1 ms   |
| 1            | 0                 | 0        | 0        | AVDD              | NAVDD             | VG <sub>OFF</sub> | VG <sub>ON</sub>  | VG <sub>ON</sub>                      | VG <sub>OFF</sub> | NAVDD             | AVDD              |
| 2            | 0                 | 0        | 1        | AVDD              | NAVDD             | VG <sub>ON</sub>  | VG <sub>OFF</sub> | VG <sub>OFF</sub>                     | VG <sub>ON</sub>  | NAVDD             | AVDD              |
| 3 (default)  | 0                 | 1        | 0        | NAVDD             | AVDD              | VG <sub>OFF</sub> | VG <sub>ON</sub>  | VG <sub>ON</sub>                      | VG <sub>OFF</sub> | AVDD              | NAVDD             |
| 4            | 0                 | 1        | 1        | NAVDD             | AVDD              | VG <sub>ON</sub>  | VG <sub>OFF</sub> | VG <sub>OFF</sub>                     | VG <sub>ON</sub>  | AVDD              | NAVDD             |
| 5            | 1                 | 0        | 0        | NAVDD             | VG <sub>OFF</sub> | AVDD              | VG <sub>ON</sub>  | VG <sub>ON</sub>                      | AVDD              | VG <sub>OFF</sub> | NAVDD             |
| 6            | 1                 | 0        | 1        | VG <sub>OFF</sub> | VG <sub>ON</sub>  | NAVDD             | AVDD              | AVDD                                  | NAVDD             | VG <sub>ON</sub>  | VG <sub>OFF</sub> |
| 7            | 1                 | 1        | 0        | AVDD/<br>NAVDD    | VG <sub>OFF</sub> | VG <sub>ON</sub>  | —                 | VG <sub>ON</sub>                      | VG <sub>OFF</sub> | AVDD/<br>NAVDD    | —                 |
| 8            | 1                 | 1        | 1        | AVDD/<br>NAVDD    | VG <sub>ON</sub>  | VG <sub>OFF</sub> | —                 | VG <sub>OFF</sub>                     | VG <sub>ON</sub>  | AVDD/<br>NAVDD    | —                 |

When dis\_navdd is set to 1 and the NAVDD output is disabled, the NAVDD slot in [Table 2](#) remains without the output being turned on.

The times in [Table 2](#) are determined by the delayt1, delayt2, and delayt3 settings in the DELAY register (address 0x08). The fastest power-up is obtained by setting the delays to 0. After all of the TFT outputs have exceeded their power-good levels, the backlight block is turned on.

The output voltages are not monitored during off sequencing; each output is turned off in turn using the programmed delays, as seen in [Figure 2](#). When the delays are set to 0, outputs are turned off in sequence with 1ms delays. A sequence can be stored in nonvolatile memory by writing to the burn\_otp\_reg register.

The V18 linear regulator is powered down 200ms after the power-down sequence is complete if power-down is performed using the EN pin. After this time, the device is in shutdown mode and can be restarted by setting the EN input high. If the outputs are turned off by taking the START bit low, the V18 regulator remains on.

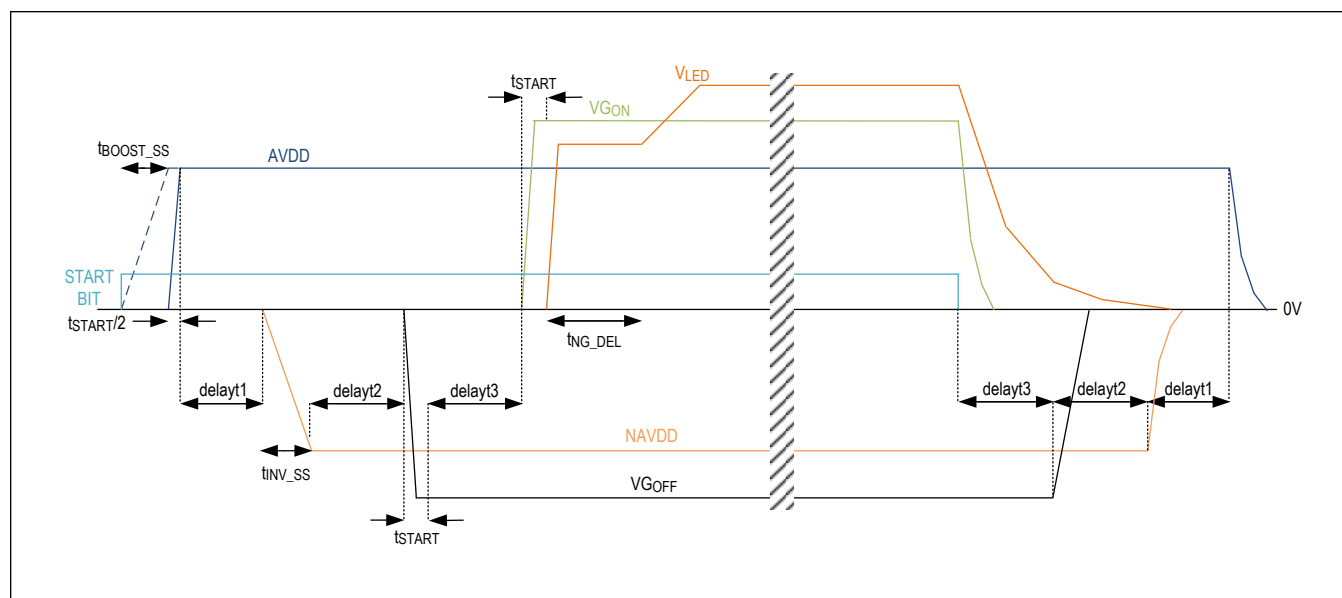


Figure 2. Output Sequencing

### Description of the LED Driver

The IC also includes a high-efficiency, high-brightness LED driver that integrates all of the necessary features to implement a high-performance backlight driver to power LEDs in medium-to-large-sized displays for automotive and general applications. The IC provides load-dump voltage protection up to 40V in automotive applications and incorporates two major blocks: a DC-DC controller with peak current-mode control to implement a boost, or a SEPIC-type switched-mode power supply and a 6-channel LED driver with 23mA to 150mA constant-current-sink capability per channel.

The IC features constant-frequency, peak current-mode control with programmable slope compensation to control the duty cycle of the PWM controller. The DC-DC converter implemented using the controller generates the required supply voltage for the LED strings from a wide input-supply range. Connect LED strings from the DC-DC converter output to the 6-channel constant-current-sink drivers (OUT1–OUT6) to control the current through the LED strings. The LED current in all 6 LED strings is set by writing to the `iset[6:0]` field in the `ISET` register (address 0x0A).

The IC features adaptive voltage control that adjusts the converter output voltage depending on the forward voltage of the LED strings. This feature minimizes the voltage drop across the constant-current-sink drivers and reduces power dissipation in the device. The backlight boost and current sinks are enabled when the complete sequence of the TFT bias section is completed.

The IC provides a very wide (16,666:1) PWM dimming range at 200Hz dimming frequency (with a dimming pulse as narrow as 300ns). The internal dimming signal is derived from the `DIM` signal or from the phase-shift dimming logic. Phase shifting of the LED strings can be disabled by writing to the `psen` bit in the `BL_CONFIG1` register (address 0x0B).

Other advanced features include detection and string disconnect for open-LED strings, partially or fully shorted strings, and unused strings. Overvoltage protection clamps the `BSTMON` voltage and thus the converter output voltage in the event of an open-LED condition.

The shorted-LED string threshold is programmable using the `sldet[1:0]` field in the `BL_CONFIG2` register (address 0x0C). The `FLTB` signal asserts low to indicate open-LED, shorted-LED, and overtemperature conditions if they are not masked. Disable individual current-sink channels by connecting the corresponding `OUT_` to `LGND_` through a 9.1kΩ resistor (starting with OUT6). In this case, `FLTB` will not indicate an open-LED condition for the disabled channel.

### Undervoltage Lockout

The `WLED` section features two UVLOs that monitor the input voltage at `BATT` and the output of the internal LDO

regulator at V5. The backlight boost is active only when both BATT and V5 exceed their respective UVLO thresholds.

### Low-Voltage Operation

After the boost soft-start is completed, the MAX25169 can continue to operate with BATT voltages as low as 3V.

At very low input voltages, the efficiency of the boost converter reduces and the input current can reach very high levels as a consequence. When the BATT voltage falls below  $V_{BATT\_LVF}$ , the boost converter current limit is automatically increased to  $V_{CSP\_LV}$ , and the switching frequency is reduced if it is greater than 1.35MHz. In this mode, if the standard current limit is exceeded on four consecutive cycles, a 100ms timer is started which returns the current limit to its original value when it expires. When the input voltage returns above  $V_{BATT\_LVR}$ , operation at the normal switching frequency is resumed.

The external boost converter components must be selected for worst-case operation. An alternative is to reduce the output power at low input voltages.

If the voltage at BATT drops below the undervoltage lockout level ( $V_{BATT\_UVF}$ ) at any time, the boost converter is disabled.

### Oscillator Frequency/External Synchronization

The internal oscillator frequency is programmable between 400kHz and 2.2MHz using a timing resistor ( $R_{RT}$ ) connected from the RT pin to GND. Use the following equation to calculate the value of  $R_{RT}$  for the desired switching frequency ( $f_{SW}$ ):

$$R_{RT} = \frac{26400000}{f_{SW}} - 0.32$$

where  $R_{RT}$  is in k $\Omega$  and  $f_{SW}$  is in Hz. If the value of the RT resistor is too low or if the pin is shorted to GND, the boost converter does not start, the FLTB pin goes low, and the rtor0 bit in the BL\_DIAG register is set.

To synchronize the oscillator with an external clock, AC-couple the external clock to the RT input. The value of the capacitor used for AC-coupling is  $C_{SYNC} = 10\text{pF}$ , and the duty cycle of the external clock should be 50%. When synchronizing the converter, do not apply the synchronizing signal to the RT pin at startup, as this may cause the RT resistor value check to fail.

At low input voltages and when the switching frequency is above 1.35MHz, the switching frequency is automatically reduced to 1.35MHz to enable high-duty-cycle operation and maintain output voltage regulation. This does not apply when the device is synchronized to an external frequency.

### Spread-Spectrum Modulation

The IC includes a spread-spectrum mode that reduces peak electromagnetic interference (EMI) at the switching frequency and its harmonics. Spread spectrum can be enabled and disabled using the  $bl\_ss\_off$  bit in the BL\_CONFIG2 register (address 0x0C).

Spread spectrum uses a pseudorandom dithering technique where the switching frequency is varied in the 94% to 106% or 97% to 103% range (set by the  $bl\_ssl$  bit in BL\_CONFIG2) of the programmed switching frequency set through the external resistor from RT to GND. When spread spectrum is used, the total energy at the fundamental and each harmonic is spread over a wider bandwidth, thus reducing the peak energy at the relevant frequency.

Spread spectrum is disabled if external synchronization is used.

### LED Forward Voltage

The forward voltage of the LEDs driven by the MAX25169 varies with current and temperature. While the LED forward voltage increases with current, it decreases with temperature. The highest voltage across a string of LEDs is thus encountered at the minimum operating temperature. When using the MAX25169, the worst-case total string voltage (at the minimum operating temperature) including the voltage across the device OUT\_ pins should be kept below the absolute maximum rating of 42V. Under normal operating conditions and over temperature, it is recommended that the boost output voltage be less than or equal to 36V. Select the BSTMON resistor-divider in order to guarantee a maximum voltage of 42V using the procedure described in the [Open-LED Management and Overvoltage Protection \(OVP\)](#) section.

**LED Current Control**

The IC features 6 identical constant-current sources used to drive multiple high-brightness LED strings. The current through each of the channels is adjustable between 23mA and 150mA by setting the 7-bit value *iset* in the *ISET* register. Multiple channels can be paralleled together for string currents exceeding 150mA.

**Current-Mode DC-DC Controller**

The IC backlight boost is a constant-frequency, current-mode controller designed to drive the LEDs in a boost or SEPIC configuration. The IC features multiloop control to regulate the peak current in the inductor, as well as the voltage across the LED current sinks to minimize power dissipation.

Programmable slope compensation is used to avoid subharmonic oscillation that can occur at > 50% duty cycles in continuous-conduction mode.

The external nMOSFET is turned on at the beginning of every switching cycle. The inductor current ramps up linearly until it is turned off at the peak current level set by the feedback loop. The peak inductor current is sensed from the voltage across the current-sense resistor ( $R_{CS}$ ) that is connected from the source of the external nMOSFET to PGND.

The IC features leading-edge blanking to suppress the external nMOSFET switching noise. A PWM comparator compares the current-sense voltage plus the slope-compensation signal with the output of the transconductance error amplifier. The controller turns off the external nMOSFET when the voltage at CS exceeds the error amplifier's output voltage (at the COMP pin). This process repeats every switching cycle to achieve peak current-mode control.

In addition to the peak current-mode-control loop, the IC has two other feedback loops for control. The converter output voltage is sensed through the BSTMON input, which goes to the inverting input of the error amplifier.

The BSTMON gain ( $A_{OVP}$ ) is defined as  $V_{OUT}/V_{BSTMON}$ , or  $(R17 + R16)/R16$  (see the [Typical Application Circuit](#)). The other feedback comes from the OUT\_ current sinks. This loop controls the headroom of the current sinks to minimize total power dissipation, while still ensuring accurate LED current matching. Each current sink has a window comparator with a low threshold of 0.58V and a high threshold of 0.85V. These comparators drive logic that controls an up/down counter. The up/down counter is updated on every falling edge of the DIM input and drives an 8-bit digital-to-analog converter (DAC), which sets the reference to the error amplifier. When the system is in steady state, all of the active OUT\_ pin voltages should be over the minimum window threshold, and at least one should be lower than the upper threshold.

**9-Bit Digital-to-Analog Converter (DAC)**

The error amplifier's reference input is controlled with an 9-bit DAC. The DAC output is ramped up during startup to implement a soft-start function (see the [Startup Sequence](#) section). During normal operation, the DAC output range is limited to between 0.482V and 0.996V. Because the DAC output is limited to no less than 0.482V during normal operation, the overvoltage threshold for the output should be set to a value less than twice the minimum LED forward voltage. The DAC LSB determines the minimum output-voltage step according to the following equation:

$$V_{STEP\_MIN} = V_{DAC\_LSB} \times A_{OVP}$$

where  $V_{STEP\_MIN}$  is the minimum output-voltage step,  $V_{DAC\_LSB}$  is 1.95mV (typ), and  $A_{OVP}$  is the BSTMON resistor-divider gain.

**Startup Sequence**

The WLED section startup sequence occurs in three stages, which are described in the following sections and illustrated in [Figure 3](#). The overall startup time can be selected using the *fast\_ss* bit in the *BL\_CONFIG1* register. The boost output voltage at the end of soft-start (the end of Stage 2) differs between the slow- and fast-startup modes.

**Stage 1**

After the TFT sequence has been completed, the controller turns on the charge-pump for the external nMOSFET if the *V5* and *BATT* voltages are above their respective undervoltage thresholds. The output current of the charge-pump charges the gate of the external nMOSFET, thus turning it on. After a 2ms timeout, stage 2 of the startup begins. If *NGATE* is unused, set the *cp\_dis* bit in the *BL\_DIS* register (address 0x0D) to disable the *NGATE* charge pump.

**Stage 2**

After the external MOSFET on *NGATE* has been enabled, the IC goes through its power-up checks, including unused

string detection, OUT\_ short-to-ground detection, RT pin open/short detection, and IREF short detection. To avoid possible damage, the converter does not start if any OUT\_ is detected as shorted to ground.

Any current sinks detected as unused are disabled to prevent a false fault-flag assertion during normal operation. After these checks have been performed, the converter begins to operate and the output voltage begins to ramp up. The DAC reference to the error amplifier is stepped upwards until the BSTMON pin reaches 0.48V (or 0.88V in fast-startup mode). This stage duration is fixed at approximately 50ms (22ms in fast-startup mode).

### Stage 3

The third stage begins once the second stage is complete and the DIM input goes high. During Stage 3, the output of the converter is adjusted until the minimum OUT\_ voltage falls within the window comparator limits of 0.58V (typ) and 0.85V (typ). The output ramp is again controlled by the DAC, which provides the reference for the error amplifier. The DAC output is updated on each rising edge of the DIM input. If the DIM input is a 100% duty cycle (DIM = high), then the DAC output is updated once every 10ms.

The total soft-start time can be calculated using the following equation in slow-startup mode:

$$t_{SS} = 50\text{ms} + \frac{V_{LED} + 0.875 - (0.48 \times A_{OVP})}{f_{DIM} \times 0.01 \times A_{OVP}}$$

where  $t_{SS}$  is the total soft-start time, 50ms is the fixed Stage 1 duration,  $V_{LED}$  is the total forward voltage of the LED strings, 0.715V is midpoint of the window comparator,  $A_{OVP}$  is the gain of the OVP resistor-divider,  $f_{DIM}$  is the dimming frequency (use 100Hz if the DIM input duty cycle is 100%), and 0.01V is the maximum voltage step per clock cycle of the DAC.

In fast-startup mode (with the fast\_ss bit in the BL\_CONFIG1 (0x0B) register set to 1), the following equation should be used:

$$t_{SS} = 22\text{ms} + \frac{0.88 \times A_{OVP} - (V_{LED} + 0.875)}{f_{DIM} \times 0.01 \times A_{OVP}}$$

### Backlight Boost Startup

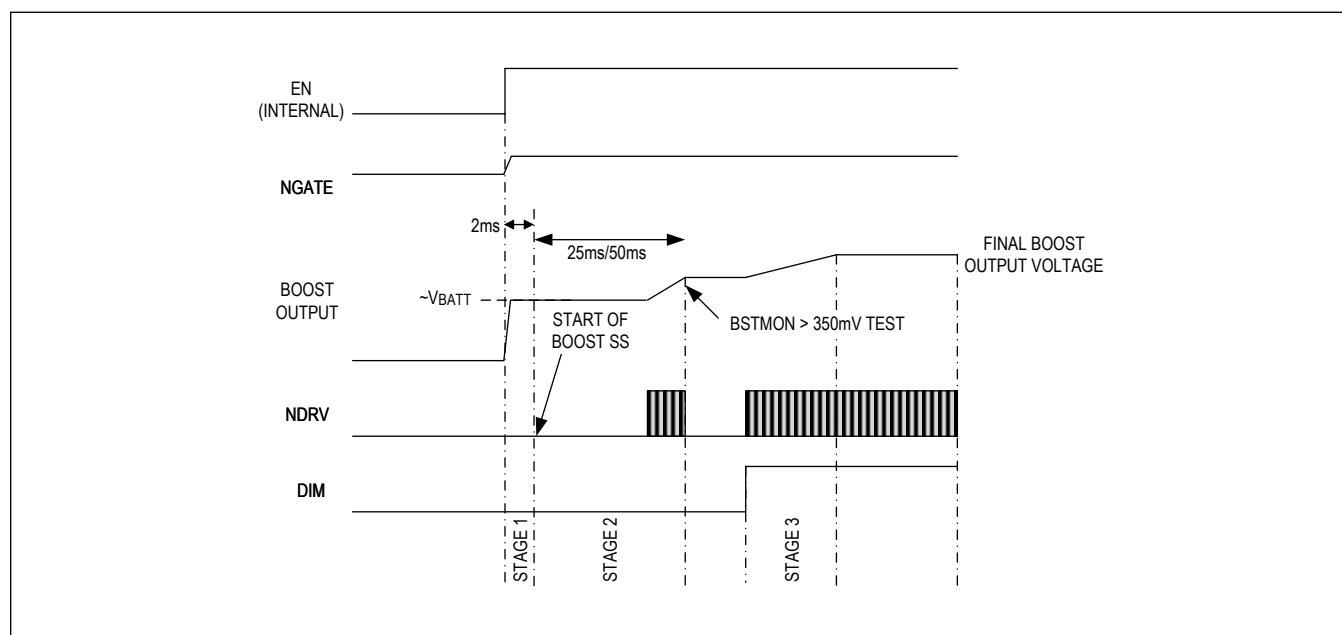


Figure 3. Backlight Boost Startup

**Open-LED Management and Overvoltage Protection (OVP)**

On power-up, the IC detects and disconnects any unused current-sink channels before entering the DC-DC converter soft-start. This avoids asserting the FLTB output for the unused channels. After soft-start, the IC detects open strings and disconnects them from the internal minimum OUT\_ voltage detector. This keeps the DC-DC converter output voltage within safe limits and maintains high efficiency.

If any LED string is open, the voltage at the open OUT\_ goes to GND. The DC-DC converter output voltage then increases to the overvoltage-protection threshold set by the voltage-divider network connected between the converter output, BSTMON input, and GND (the threshold at which the PWM controller is switched off, holding NDRV low). At that point, any current-sink output with  $V_{OUT\_} < 250\text{mV}$  (typ) is disconnected from the minimum-voltage detector. Select  $V_{OUT\_OVP}$  (which is the maximum voltage that the boost converter can produce) according to the following equation:

$$V_{OUT\_OVP} > 1.1 \times (V_{LED\_MAX} + 1)$$

where  $V_{LED\_MAX}$  is the maximum expected LED string voltage.  $V_{OUT\_OVP}$  should also be chosen such that the voltage at the OUT\_ pins does not exceed the absolute maximum rating.

The upper resistor in the BSTMON resistor-divider (R17) can be selected using the following equation:

$$R17 = R16 \times \left( \frac{V_{OUT\_OVP}}{0.95} - 1 \right)$$

where 0.95V is the typical BSTMON threshold. Ensure that the minimum voltage on the BSTMON pin is always greater than 0.4V to avoid the boost converter latching off due to undervoltage by checking the following:

$$(V_{LED\_MIN} + 0.55) \times \frac{R16}{R16 + R17} > 0.4V$$

where  $V_{LED\_MIN}$  is the worst-case minimum LED string voltage.

When an open-LED condition occurs, FLTB is asserted low, and the bit corresponding to the channel with the fault is set to 1.

If the boost voltage reaches the BSTMON overvoltage threshold without any open channels, the converter is immediately disabled until the BSTMON voltage drops by 50mV, upon which switching resumes. In this condition, the boost converter output voltage is triangular due to the hysteretic mode of operation, and the bstov bit in the BL\_DIAG register is set.

**Short-LED Detection**

The IC checks for shorted LEDs at the falling edge of OUT\_. An LED short is detected at OUT\_ if the OUT\_ voltage is greater than the value programmed using the sldet[1:0] field in the BL\_CONFIG2 register. Once a short is detected on any of the strings, the LED strings with the short are disconnected and the FLTB output flag asserts (unless the fault is masked) until the device detects that the shorts are removed on any of the following rising edges of DIM. Short-LED detection is disabled in low-dimming mode. If the DIM input is connected high, short-LED detection is performed continuously.

Short-LED detection is also disabled in cases where all active OUT\_ channels rise above the threshold set by the sldet[1:0] bits in register BL\_CONFIG2 (address 0x0C). This can occur in a boost-converter application when the input voltage becomes higher than the total LED string voltage drop, such as during a battery load dump. If a short-LED fault occurs during a load dump, the fault flag does not assert until the load dump is over and the minimum OUT\_ voltage has fallen below 2.028V. If a load dump occurs after a short LED is detected, the fault flag deasserts until the load dump is over and the minimum OUT\_ voltage has fallen below 2.028V, at which point the fault flag reasserts.

**Dimming**

Dimming can be performed using an external PWM signal applied to the DIM pin or by writing to the TON\_ registers. The signal on the DIM pin is sampled with a 20MHz internal clock except when phase-shifting is disabled, in which case the DIM signal controls the OUT\_ outputs directly.

**Low-Dimming Mode**

The IC's operation changes at very narrow dimming pulses to ensure a consistent dimming response of the LEDs. If the dimming on-time is lower than 50μs (typ), the device enters low-dimming mode. In this state, the converter switches continuously and LED short detection is disabled. When the DIM input is greater than 51μs (typ), the device goes back

into normal operation, enabling the short-LED detection and switching the power FET only when the effective dimming signal is high.

### Phase-Shift Dimming

When the *psen* bit in register *BL\_CONFIG1* (address 0x0B) is set, phase shifting of the LED strings is enabled. To achieve this, the DIM signal is sampled internally by a 20MHz clock. The device automatically sets the phase shift between strings to a value depending on the number of strings enabled.

When phase shifting is enabled, the sampled DIM input is used to generate separate dimming signals for each LED string that is shifted in phase. The resolution with which the DIM signal is captured degrades at higher DIM input frequencies; therefore, dimming frequencies between 100Hz and 3kHz are recommended, although higher dimming frequencies are technically possible. The phase shift between strings is determined by the following equation:

$$\Theta = 360/n$$

where *n* is the total number of strings being used and  $\Theta$  is the phase shift in degrees. See [Figure 4](#) for a timing diagram example with phase shifting enabled.

When phase shifting is disabled, all strings turn on/off at the same time. If multiple current sinks are being connected in parallel, phase shifting should be disabled.

If a fault is detected, resulting in a string being disabled during normal operation, the phase shifting adjusts to the new situation.

When disabling unused strings, disable the higher-numbered OUT\_ current sinks first.

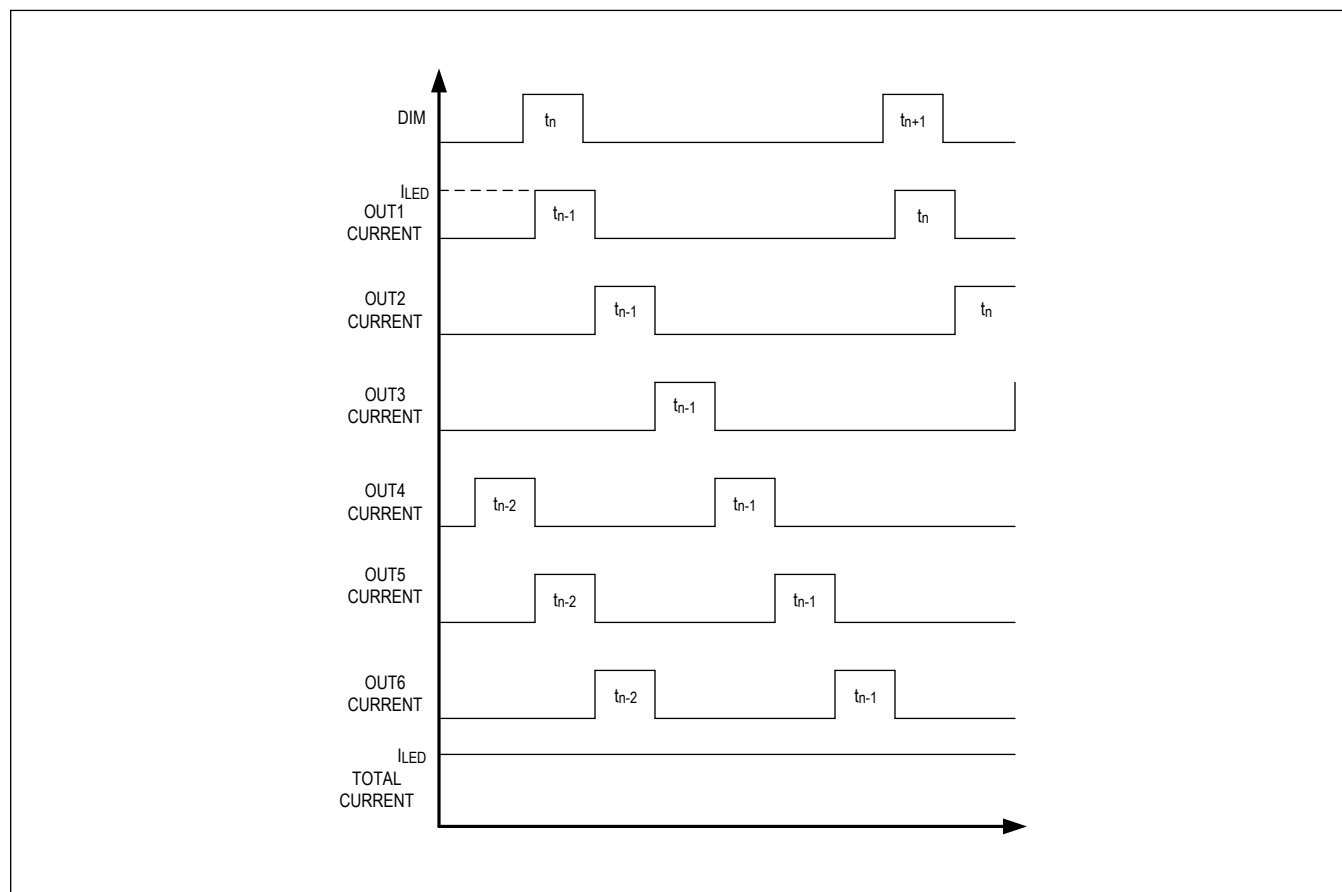


Figure 4. Phase-Shifted Outputs

**Automatic Fade-In/Fade-Out During Dimming**

The device can be configured to perform a smooth change in brightness, even when the DIM input duty cycle or TON\_ setting is suddenly changed by setting the FADE\_IN\_OUT bit in the BL\_FADING register to 1.

When using the fade function, it is important to maintain the DIM frequency constant while entering and leaving 100% duty cycle. This is necessary in order to avoid erroneous frequency measurement that can change the speed of the fade-in/out.

The step size in the dimming transition is either 6.25% or 12.5%, depending on the setting of the FADE\_GAIN bit. The total transition time can be set by writing the TDIM field to a value between 0 to 5, where the value sets the update speed to once every 2<sup>TDIM</sup>. The transition time depends on the initial and final dimming values according to:

$$t = \frac{1}{f_{\text{DIM}}} \times 2^{\text{TDIM}} \times \frac{\ln(\text{DIM}_F) - \ln(\text{DIM}_i)}{\text{FADE\_GAIN}}$$

where  $f_{\text{DIM}}$  is the dimming frequency, TDIM is the TDIM register setting, DIM<sub>F</sub> is the final dimming setting, DIM<sub>i</sub> is the initial dimming setting, and FADE\_GAIN is either 0.0625 or 0.125. For this equation, DIM<sub>F</sub> should be larger than DIM<sub>i</sub> but, since the fading function is symmetrical, the values can be swapped if the final dimming ratio is lower than the initial one.

When transitioning to 100% dimming with fading enabled, do not change the input dimming from 100% until the complete fading transition to 100% is complete.

If fade-in is enabled at startup, the device will transition smoothly to the desired dimming level from 0. When the start bit is taken low or the EN pin set to ground, fade-out is not performed.

**Disabling Individual Strings**

To disable an unused LED string, connect the unused OUT\_ to ground through a 9.1kΩ resistor, or set the corresponding DIS\_ bit to 1 in the BL\_DIS register (address 0x0D) before the start bit is set. During backlight boost startup, the device sources 60μA (typ) current through the OUT\_ pins and measures the corresponding voltage. For the string to be properly disabled, the OUT\_ voltage should measure between 270mV and 775mV during this check. The maximum threshold for the OUT\_ short-to-ground check is 270mV, and the minimum unused string-detection threshold is 775mV.

**Note:** When disabling unused strings, start by disabling the highest numbered current sinks first (e.g., if two strings need to be disabled, disable OUT6 and the next channel down. Do not disable any two strings at random). During normal operation, strings can be selectively turned off by changing the corresponding TON\_ setting to 0. This is only possible when internal dimming is used (not when using the DIM input pin).

**Hybrid Dimming**

To enable hybrid dimming, set the hdim bit in register BL\_CONFIG1 (address 0x0B). With hybrid dimming enabled, the ADIM pin has no effect on device operation. In hybrid dimming mode, the external LEDs are dimmed by first reducing their current as the dimming duty-cycle decreases from 100% (see [Figure 5](#)). At the crossover level set by the hdim\_thr[1:0] bits, dimming transitions to PWM dimming where the LED current is chopped. Depending on the dim\_ext bit, the device functions in one of two ways:

- (dim\_ext = 1) measures the duty cycle on the DIM pin and translates it into a combined LED current value and PWM setting.
- (dim\_ext = 0) takes the 18-bit value from the TON1 register and translates it into a combined LED current value and PWM setting.

[Figure 6](#) illustrates the difference between standard and hybrid dimming with phase-shifting enabled.

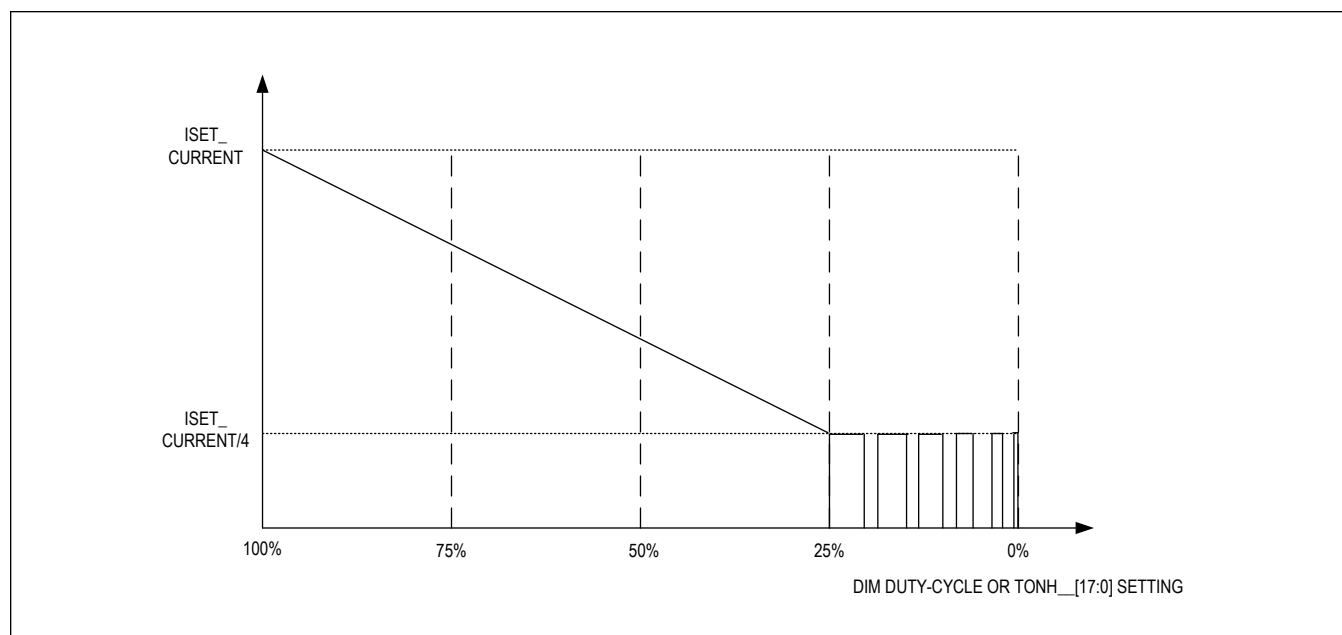


Figure 5. Hybrid Dimming Operation with  $hdim\_thr[1:0] = 10$  (25%)

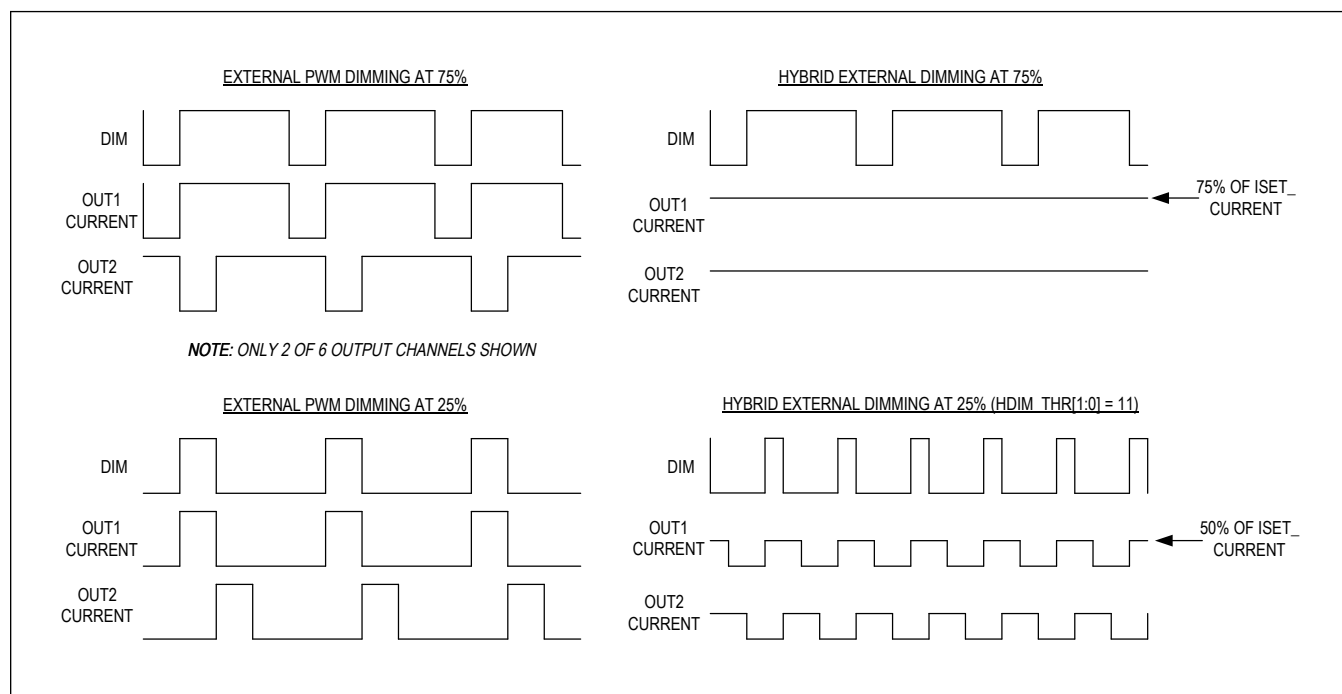


Figure 6. Hybrid Dimming Operation Modes

### Temperature Foldback

When an NTC temperature sensor is connected between GND and a resistor (RT1) connected to the V18 supply, with a further resistor (RT2) connected from the junction of the NTC and RT1 to the TEMP pin, temperature foldback is implemented. When the temperature reaches the temperature T1 (set by RT1), the current in the LEDs is reduced according to the linear scheme shown in [Figure 7](#). The slope of the current reduction is set by RT2. The MAX25169 is

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Automotive, I<sup>2</sup>C-Controlled, 6-Channel, 150mA Backlight Driver and 4-Output TFT-LCD Bias with ASIL B Features

specifically designed to be used with the NTCLE100E3103G or a similar NTC device. [Table 3](#) illustrates some examples of RT1 and RT2 values to obtain certain values of T1 and T<sub>DELTA</sub>.

Table 3. Temperature Foldback Examples

| RT1 (kΩ) | RT2 (kΩ) | T1 (°C) | T <sub>DELTA</sub> (°C) |
|----------|----------|---------|-------------------------|
| 6.04     | 1.2      | 70      | 30                      |
| 6.04     | 2        | 70      | 50                      |

When the temperature reaches T1, the OTW bit in register DIAG\_REG is asserted. When the temperature reaches T<sub>OFF</sub>, the LED current is turned off, the bl\_ot bit is set high, and the FLTB pin asserts low.

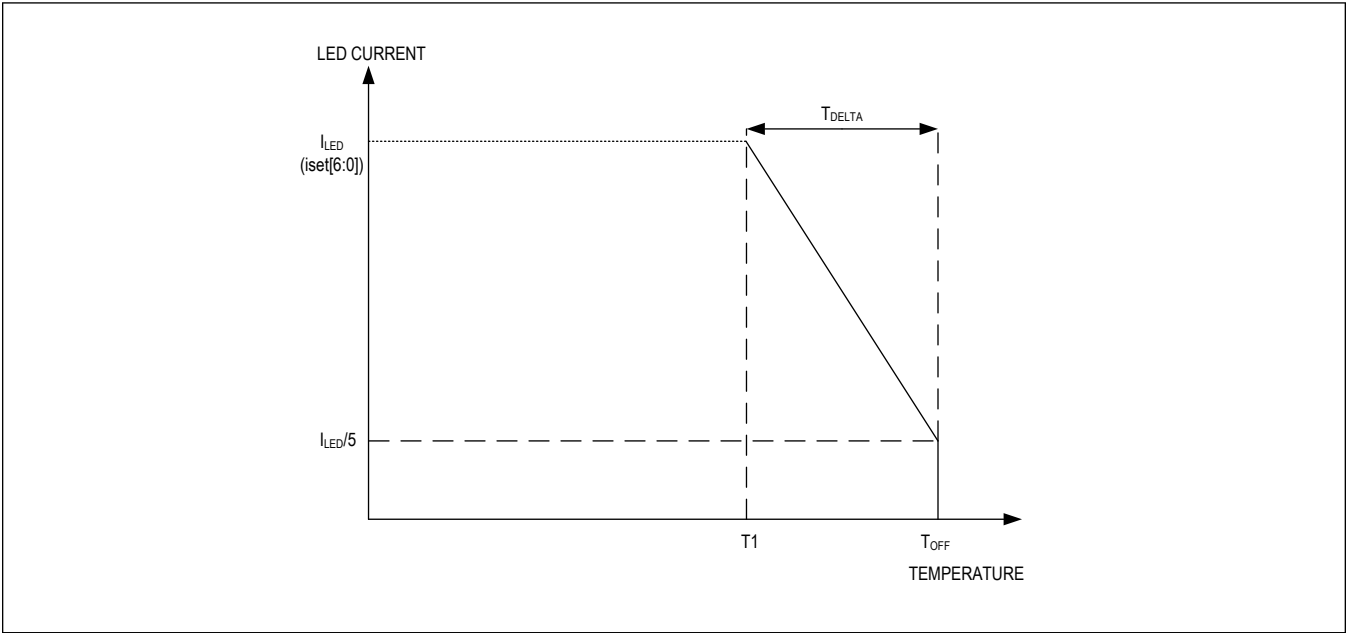


Figure 7. Temperature Foldback Curve

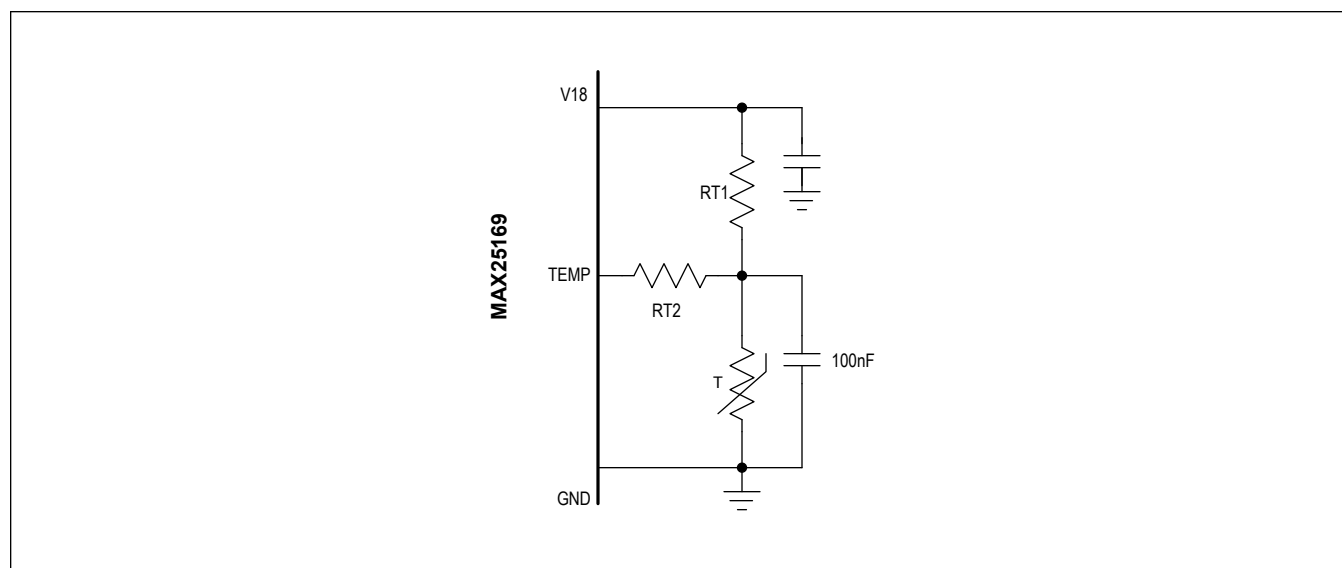


Figure 8. TEMP External Circuitry

### Fault Protection

The MAX25169 has robust fault and overload protection. If any of the V<sub>G<sub>OFF</sub></sub>, NAVDD, AVDD, or V<sub>G<sub>ON</sub></sub> outputs fall to less than 85% (typ) of their intended regulation voltage for more than 15ms (typ), or if a short-circuit condition occurs on any output for any duration, then all outputs latch off and a fault condition is set. The backlight section also includes comprehensive diagnostics and fault signaling.

Both device sections (TFT and backlight) have thermal-fault detection and thermal warnings; if there is a TFT overtemperature, the complete device is disabled, while an overtemperature on the backlight section causes only that section to be disabled.

Thermal faults are cleared when the die temperature drops by 17°C.

When a fault is detected, the open-drain FLTB output goes low unless the fault is masked. The FLTB output pin is an active-low, open-drain output that is used to signal various device faults. The FLTB output can flag any or all of the conditions listed as follows.

In the TFT section:

- Undervoltage fault on HVINP, AVDD, NAVDD, VGON or VGOFF
- Overvoltage fault on HVINP, AVDD, NAVDD, VGON or VGOFF
- Thermal warning in the TFT bias section
- Thermal shutdown in the TFT bias section

In the backlight section:

- Open fault on any of the OUT\_ pins
- Shorted-LED fault on any of the OUT\_ pins
- Any OUT\_ shorted to GND
- LED boost converter undervoltage
- IREF resistor short to GND
- RT resistor out of range
- NTC fault
- V5 supply out of range
- Undervoltage on BATT
- Thermal warning in the backlight section
- Thermal shutdown in the backlight section

In addition, the following general faults are signaled:

- I<sup>2</sup>C parity error
- Undervoltage on the IN pin
- Nonvolatile memory fault
- Bandgap out of range fault based on comparison with redundant reference
- Internal oscillator failure
- V18 out-of-range

Some of the above conditions can be masked from causing FLTB to go low by using the corresponding mask bit in the TFTMASK1, TFTMASK2, and BL\_MASK registers.

In standalone mode, if the fltb\_mode bit is 0, the duty-cycle on the FLTB pin indicates the type of fault according to the following scheme:

- FLTB continuously low: Thermal-shutdown fault on either block, undervoltage on IN, nonvolatile memory fault, clock error, or V18 out-of-range
- 25% duty cycle on FLTB: Faults in both LED and TFT sections
- 50% duty cycle on FLTB: Fault in TFT section
- 75% duty cycle on FLTB: Fault in LED section

This list is in order of priority where FLTB continuously low takes highest precedence.

## ASIL B Features

The following diagnostics are implemented in the TFT section of the device:

- OV/UV on all outputs
- Redundant reference for OV/UV comparators. If the two bandgaps are too different, undervoltage and overvoltage faults are signaled simultaneously on HVINP.

The backlight section includes these diagnostic features:

- An analog-to-digital converter (ADC) which measures the current in each of the OUT\_ pins and the BSTMON voltage
- Overvoltage detection on V5 supply

The following features are common to both functional blocks:

- FLTB diagnostic to detect PCB open or stuck faults
- Monitor for internal oscillator
- I<sup>2</sup>C transactions: Optional parity check

## Analog-to-Digital Converter (ADC)

The ADC is used to measure the current in each of the strings and the voltage on the BSTMON pin.

A conversion cycle is started by setting the convert bit in the CONVERT (0x01) register to 1. At the end of the cycle, the convert bit is reset to 0 to indicate a complete cycle, and the IOUT1–IOUT6 and VBSTMON registers contain the updated values. The full-scale value of the current measurement is 160mA (resolution 0.64mA) with an IREF resistor of 22kΩ. Values higher than this read as full scale or 0xFF. Current measurements are not performed on channels that are in low-dim mode; before performing a conversion, this can be checked by reading the lo\_dim\_ bits. If a conversion is attempted on a channel that is in low-dim mode, the current value returned will be 0x00. In the same way, any channels that are disabled, open circuit, or in the shorted-LED condition will read zero current.

The full-scale value of the BSTMON pin voltage conversion is 1V with a resolution of 3.92mV.

The duration of a complete conversion depends on whether or not phase shifting is enabled. With phase shifting enabled, a complete conversion can take up to two dimming cycles. With phase shifting disabled, one dimming cycle is the worst-case latency (the conversion is initiated at the beginning of a DIM cycle and concluded < 50μs later).

## Serial Interface

The MAX25169 IC features an I<sup>2</sup>C, 2-wire serial interface consisting of a serial-data line (SDA) and a serial-clock line (SCL). SDA and SCL facilitate communication between the IC and the controller at clock rates up to 400kHz. The controller, typically a microcontroller, generates SCL and initiates data transfer on the bus. The operation mode of the device is controlled by the ADD and MODE pins as shown in [Table 4](#).

**Table 4. Add/Mode Pins**

| MODE | ADD | OPERATION MODE                              | FLTB                  |
|------|-----|---------------------------------------------|-----------------------|
| GND  | GND | Full I <sup>2</sup> C read/write access     | Low with fault        |
| GND  | V18 | Full I <sup>2</sup> C read/write access     | Low with fault        |
| V18  | GND | Standalone mode, no I <sup>2</sup> C access | PWM output with fault |
| V18  | V18 | I <sup>2</sup> C read-only access           | Low with fault        |

If the device powers up in standalone mode, it is latched in that mode, and the mode of operation can only be changed by powering off the device.

The read and write addresses are shown in [Table 5](#).

**Table 5. I<sup>2</sup>C Address**

| ADD PIN<br>CONNECTION | DEVICE ADDRESS |    |    |    |    |    |    | WRITE<br>ADDRESS | READ<br>ADDRESS |
|-----------------------|----------------|----|----|----|----|----|----|------------------|-----------------|
|                       | A6             | A5 | A4 | A3 | A2 | A1 | A0 |                  |                 |
| GND                   | 1              | 0  | 0  | 0  | 1  | 1  | 0  | 0x8C             | 0x8D            |
| V18                   | 1              | 0  | 0  | 0  | 1  | 1  | 1  | 0x8E             | 0x8F            |

A controller device communicates with the MAX25169 by transmitting the correct peripheral ID followed by the register address and data word. Each transmit sequence is framed by a START (S) or Repeated START (Sr) condition, and a STOP (P) condition. Each word transmitted over the bus is 8 bits long and is always followed by an acknowledge clock pulse.

The IC's SDA line operates as both an input and an open-drain output. A pull-up resistor greater than 500Ω is required on the SDA bus. In general, the resistor has to be selected as a function of bus capacitance such that the rise time on the bus is not greater than 120ns. The IC's SCL line operates as an input only. A pull-up resistor greater than 500Ω is required on SCL if there are multiple controllers on the bus, or if the controller in a single-controller system has an open-drain SCL output. In general, for the SCL-line resistor selection, the same SDA recommendations apply. Series resistors in line with SDA and SCL are optional. The SCL and SDA inputs suppress noise spikes to assure proper device operation, even on a noisy bus.

### Parity Checking

Even parity checking for write transactions can be enabled by setting the par\_en bit in the DELAY register to 1. The parity bit is the most significant bit (MSB) of the register address byte and should be set to attain even parity. The parity check is performed over all 3 bytes received by the device: the slave address, the register address, and the data payload. Burst-mode write is not supported when parity checking is enabled; a complete I<sup>2</sup>C transaction is needed to write to each single register. When a parity bit error is detected, the par\_err bit is set, the I<sup>2</sup>C interface issues a NACK, and no write is performed.

When writing any of the BURN, REBOOT, and RESTART commands, parity must be adjusted by changing the third or payload byte; the command byte must not be changed.

### Nonvolatile (NV) Memory

The MAX25169 includes six blocks of one-time-programmable memory (the number of writes performed so far can be read from nv\_count[2:0] in the REG\_CTRL register). The user can store the block of volatile registers from 0x07 to 0x15 in nonvolatile memory, which is in turn mapped to register locations 0x17 to 0x25. Note that before the nonvolatile memory has been written to the first time, a read from the locations 0x17 to 0x25 yields the result 0xFF.

The contents of the nonvolatile memory are protected by a single-error correction/double-error detection (SEDED) redundant code, while data transfer from nonvolatile memory to registers 0x07 to 0x15 is protected by a parity check. If the parity check fails, a retry is performed two times. If all three attempts are unsuccessful, the device does not start up, the nv\_flg bit is set, and the FLTB pin is asserted low. If the SEDED check fails, the device does not start up, the nv\_flg bit is set, and the FLTB pin is asserted low.

If there are no errors, the outputs are turned on with the stored values and in the stored sequence.

To store the contents of registers 0x07 to 0x15 to nonvolatile memory a voltage source of 8.5V ±2% capable of supplying

more than 25mA should be connected to the V<sub>PROG</sub> pin. When the V<sub>PROG</sub> voltage is stable, an I<sup>2</sup>C NV write command can be performed by writing to the burn\_otp\_reg register. If the NV write is unsuccessful (because the V<sub>PROG</sub> voltage was out of range or because of a general memory error), the nv\_flt bit is set and the FLTB pin goes low. After an NV write command is executed, the nv\_flt bit should be checked. If nv\_flt is high, another NV write can be attempted.

Connect V<sub>PROG</sub> to GND if there is no need to program the nonvolatile memory.

### Autorefresh Function

When the refresh bit in register CONFIG is set, the device reads from the nonvolatile registers at intervals of 1s and writes the data into the corresponding volatile registers. This avoids the effect of possible corruption of the volatile registers. Autorefresh reads are subject to error correction in the same way as the initial read after device power-up.

See the [Using the NV Memory](#) section when programming the nonvolatile memory.

### BURN, REBOOT, and RESTART Commands

The BURN and REBOOT commands are used to store the contents of registers 0x07 to 0x15 in nonvolatile memory or to fetch the contents of nonvolatile memory and load them into registers 0x07 to 0x15, respectively. The RESTART command is used to restart the device from a latched-fault mode. When a RESTART command is performed, all fault bits are cleared.

A BURN command is performed by writing 0xA5 to register address 0x78 (burn\_otp\_reg).

A REBOOT command is performed by writing 0x5A to register address 0x79 (reboot\_otp\_reg).

A RESTART command is performed by writing 0xC3 to register address 0x7A (soft\_restart).

When parity checking is enabled and one of these user commands is sent to the device, the third byte should be such as to have even parity over the 3 bytes sent.

## Register Map

## MAX25169

| ADDRESS        | NAME                               | MSB                |              |                  |               |                 |              |                | LSB           |
|----------------|------------------------------------|--------------------|--------------|------------------|---------------|-----------------|--------------|----------------|---------------|
| USER REGISTERS |                                    |                    |              |                  |               |                 |              |                |               |
| 0x00           | <a href="#">DEVICE[7:0]</a>        | –                  | –            | dev_id[5:0]      |               |                 |              |                |               |
| 0x01           | <a href="#">CONVERT[7:0]</a>       | convert            | –            | –                | –             | –               | –            | –              | –             |
| 0x02           | <a href="#">REG_CTRL[7:0]</a>      | –                  | dis_refr     | nv_count[2:0]    |               |                 | rev_id[2:0]  |                |               |
| 0x03           | <a href="#">TFTMASK1[7:0]</a>      | hvinp_ov_mask      | avdd_uv_mask | navdd_ov_mask    | navdd_uv_mask | vgon_ov_mask    | vgon_uv_mask | vgoff_ov_mask  | vgoff_uv_mask |
| 0x04           | <a href="#">TFTMASK2[7:0]</a>      | flt_flt            | par_err_mask | vin_uvlo_mask    | hvinp_uv_mask | –               | –            | clk_err_mask   | th_warn_mask  |
| 0x05           | <a href="#">TFT_FAULT1[7:0]</a>    | hvinp_ov           | avdd_uv      | navdd_ov_v       | navdd_uv_v    | vgon_ov         | vgon_uv      | vgoff_ov       | vgoff_uv      |
| 0x06           | <a href="#">TFT_FAULT2[7:0]</a>    | v18oor             | par_err      | vin_uvlo         | hvinp_uv      | th_shdn         | nv_flt       | clk_err        | th_warn       |
| 0x07           | <a href="#">TFT_CONFIG[7:0]</a>    | dis_navd_d         | refresh      | en_ss            | fSW           | tretry[1:0]     |              | tfault[1:0]    |               |
| 0x08           | <a href="#">DELAY[7:0]</a>         | delayt1[1:0]       |              | delayt2[1:0]     |               | delayt3[1:0]    |              | –              | par_en        |
| 0x09           | <a href="#">SEQ[7:0]</a>           | seq_set[2:0]       |              |                  | pfo_th        | tstart[1:0]     |              | lxp_lim_low    | start         |
| 0x0A           | <a href="#">ISET[7:0]</a>          | –                  | iset[6:0]    |                  |               |                 |              |                |               |
| 0x0B           | <a href="#">BL_CONFIG1[7:0]</a>    | dim_ext            | hdim         | hdim_thr[1:0]    |               | bstforce        | fast_ss      | psen           | fltb_mode     |
| 0x0C           | <a href="#">BL_CONFIG2[7:0]</a>    | bl_ilim            | fpwm[2:0]    |                  |               | bl_ss_off       | bl_ssl       | sldet[1:0]     |               |
| 0x0D           | <a href="#">BL_DIS[7:0]</a>        | cp_dis             | –            | dis_bl           | dis6          | dis5            | dis4         | dis3           | dis2          |
| 0x0E           | <a href="#">BL_FADING[7:0]</a>     | –                  | –            | –                | fade_gain     | fade_in_out     | tfade[2:0]   |                |               |
| 0x0F           | <a href="#">CUSTOMER_USE1[7:0]</a> | customer_use1[7:0] |              |                  |               |                 |              |                |               |
| 0x10           | <a href="#">CUSTOMER_USE2[7:0]</a> | customer_use2[7:0] |              |                  |               |                 |              |                |               |
| 0x11           | <a href="#">CUSTOMER_USE3[7:0]</a> | customer_use3[7:0] |              |                  |               |                 |              |                |               |
| 0x12           | <a href="#">CUSTOMER_USE4[7:0]</a> | customer_use4[7:0] |              |                  |               |                 |              |                |               |
| 0x13           | <a href="#">AVDD_SET[7:0]</a>      | –                  | –            | avdd[5:0]        |               |                 |              |                |               |
| 0x14           | <a href="#">VGON[7:0]</a>          | –                  | –            | vgon[5:0]        |               |                 |              |                |               |
| 0x15           | <a href="#">VGOFF[7:0]</a>         | –                  | –            | vgoff[5:0]       |               |                 |              |                |               |
| 0x17           | <a href="#">NV_CONFIG[7:0]</a>     | nv_dis_n_avdd      | nv_refresh   | nv_en_ss         | nv_fSW        | nv_tretry[1:0]  |              | nv_tfault[1:0] |               |
| 0x18           | <a href="#">NV_DELAY[7:0]</a>      | nv_delayt1[1:0]    |              | nv_delayt2[1:0]  |               | nv_delayt3[1:0] |              | unused         | nv_par_en     |
| 0x19           | <a href="#">NV_SEQ[7:0]</a>        | nv_seq_set[2:0]    |              |                  | nv_pfo_th     | nv_tstart[1:0]  |              | nv_lxp_lim_low | nv_start      |
| 0x1A           | <a href="#">NV_ISET[7:0]</a>       | unused             | nv_iset[6:0] |                  |               |                 |              |                |               |
| 0x1B           | <a href="#">NV_BL_CONFIG1[7:0]</a> | nv_dim_ext         | nv_hdim      | nv_hdim_thr[1:0] |               | nv_bstforce     | nv_fast_ss   | nv_psen        | nv_fltb_mode  |
| 0x1C           | <a href="#">NV_BL_CONFIG2[7:0]</a> | nv_bl_ili_m        | nv_fpwm[2:0] |                  |               | nv_bl_ss_off    | nv_bl_ssl    | nv_sldet[1:0]  |               |

## MAX25169

Automotive, I<sup>2</sup>C-Controlled, 6-Channel, 150mA  
Backlight Driver and 4-Output TFT-LCD Bias with  
ASIL B Features

| ADDRESS | NAME                                  | MSB                   |        |               |              |                |               |              | LSB     |
|---------|---------------------------------------|-----------------------|--------|---------------|--------------|----------------|---------------|--------------|---------|
| 0x1D    | <a href="#">NV_BL_DIS[7:0]</a>        | nv_cp_dis             | unused | nv_dis_b<br>l | nv_dis6      | nv_dis5        | nv_dis4       | nv_dis3      | nv_dis2 |
| 0x1E    | <a href="#">NV_BL_FADING[7:0]</a>     | unused[2:0]           |        |               | nv_fade_gain | nv_fade_in_out | nv_tfade[2:0] |              |         |
| 0x1F    | <a href="#">NV_CUSTOMER_USE1[7:0]</a> | nv_customer_use1[7:0] |        |               |              |                |               |              |         |
| 0x20    | <a href="#">NV_CUSTOMER_USE2[7:0]</a> | nv_customer_use2[7:0] |        |               |              |                |               |              |         |
| 0x21    | <a href="#">NV_CUSTOMER_USE3[7:0]</a> | nv_customer_use3[7:0] |        |               |              |                |               |              |         |
| 0x22    | <a href="#">NV_CUSTOMER_USE4[7:0]</a> | nv_customer_use4[7:0] |        |               |              |                |               |              |         |
| 0x23    | <a href="#">NV_AVDD_SET[7:0]</a>      | unused[1:0]           |        | nv_avdd[5:0]  |              |                |               |              |         |
| 0x24    | <a href="#">NV_VGON[7:0]</a>          | unused[1:0]           |        | nv_vgon[5:0]  |              |                |               |              |         |
| 0x25    | <a href="#">NV_VGOFF[7:0]</a>         | unused[1:0]           |        | nv_vgoff[5:0] |              |                |               |              |         |
| 0x26    | <a href="#">AVDD_LIM[7:0]</a>         | –                     | –      | avdd_lim[5:0] |              |                |               |              |         |
| 0x27    | <a href="#">LO_DIM[7:0]</a>           | ton_master            | –      | lo_dim6       | lo_dim5      | lo_dim4        | lo_dim3       | lo_dim2      | lo_dim1 |
| 0x28    | <a href="#">TON1H[7:0]</a>            | ton1h[7:0]            |        |               |              |                |               |              |         |
| 0x29    | <a href="#">TON1L[7:0]</a>            | ton1l[7:0]            |        |               |              |                |               |              |         |
| 0x2A    | <a href="#">TON2H[7:0]</a>            | ton2h[7:0]            |        |               |              |                |               |              |         |
| 0x2B    | <a href="#">TON2L[7:0]</a>            | ton2l[7:0]            |        |               |              |                |               |              |         |
| 0x2C    | <a href="#">TON3H[7:0]</a>            | ton3h[7:0]            |        |               |              |                |               |              |         |
| 0x2D    | <a href="#">TON3L[7:0]</a>            | ton3l[7:0]            |        |               |              |                |               |              |         |
| 0x2E    | <a href="#">TON1_3LSB[7:0]</a>        | –                     | –      | ton3lsb[1:0]  |              | ton2lsb[1:0]   |               | ton1lsb[1:0] |         |
| 0x2F    | <a href="#">TON4H[7:0]</a>            | ton4h[7:0]            |        |               |              |                |               |              |         |
| 0x30    | <a href="#">TON4L[7:0]</a>            | ton4l[7:0]            |        |               |              |                |               |              |         |
| 0x31    | <a href="#">TON5H[7:0]</a>            | ton5h[7:0]            |        |               |              |                |               |              |         |
| 0x32    | <a href="#">TON5L[7:0]</a>            | ton5l[7:0]            |        |               |              |                |               |              |         |
| 0x33    | <a href="#">TON6H[7:0]</a>            | ton6h[7:0]            |        |               |              |                |               |              |         |
| 0x34    | <a href="#">TON6L[7:0]</a>            | ton6l[7:0]            |        |               |              |                |               |              |         |
| 0x35    | <a href="#">TON4_6LSB[7:0]</a>        | –                     | –      | ton6lsb[1:0]  |              | ton5lsb[1:0]   |               | ton4lsb[1:0] |         |
| 0x36    | <a href="#">OPEN_REG[7:0]</a>         | –                     | –      | out6o         | out5o        | out4o          | out3o         | out2o        | out1o   |
| 0x37    | <a href="#">SHORTGND_REG[7:0]</a>     | –                     | –      | out6sg        | out5sg       | out4sg         | out3sg        | out2sg       | out1sg  |
| 0x38    | <a href="#">SHORTED_LED_REG[7:0]</a>  | –                     | –      | out6sl        | out5sl       | out4sl         | out3sl        | out2sl       | out1sl  |
| 0x39    | <a href="#">BL_MASK[7:0]</a>          | –                     | battuv | battuvmask    | bstuvmask    | omask          | sgmask        | bl_otwmask   | slmask  |
| 0x3A    | <a href="#">BL_DIAG[7:0]</a>          | v5oor                 | rtoor  | irefoor       | bstuv        | bstov          | hw_rst        | bl_otw       | bl_ot   |
| 0x3B    | <a href="#">VBSTMON[7:0]</a>          | vbstmon[7:0]          |        |               |              |                |               |              |         |
| 0x3C    | <a href="#">IOUT1[7:0]</a>            | iout1[7:0]            |        |               |              |                |               |              |         |
| 0x3D    | <a href="#">IOUT2[7:0]</a>            | iout2[7:0]            |        |               |              |                |               |              |         |
| 0x3E    | <a href="#">IOUT3[7:0]</a>            | iout3[7:0]            |        |               |              |                |               |              |         |
| 0x3F    | <a href="#">IOUT4[7:0]</a>            | iout4[7:0]            |        |               |              |                |               |              |         |
| 0x40    | <a href="#">IOUT5[7:0]</a>            | iout5[7:0]            |        |               |              |                |               |              |         |

| ADDRESS       | NAME                                | MSB               |  |  |  |  |  | LSB |
|---------------|-------------------------------------|-------------------|--|--|--|--|--|-----|
| 0x41          | <a href="#">IOUT6[7:0]</a>          | iout6[7:0]        |  |  |  |  |  |     |
| USER COMMANDS |                                     |                   |  |  |  |  |  |     |
| 0x78          | <a href="#">burn_otp_reg[7:0]</a>   | burn_otp[7:0]     |  |  |  |  |  |     |
| 0x79          | <a href="#">reboot_otp_reg[7:0]</a> | reboot_otp[7:0]   |  |  |  |  |  |     |
| 0x7A          | <a href="#">soft_restart[7:0]</a>   | soft_restart[7:0] |  |  |  |  |  |     |

## Register Details

### [DEVICE \(0x00\)](#)

| BIT         | 7 | 6    | 5           | 4                      | 3 | 2 | 1 | 0 |
|-------------|---|------|-------------|------------------------|---|---|---|---|
| Field       | – | –    | dev_id[5:0] |                        |   |   |   |   |
| Reset       | – | –    |             |                        |   |   |   |   |
| Access Type | – | –    | Read Only   |                        |   |   |   |   |
| BITFIELD    |   | BITS |             | DESCRIPTION            |   |   |   |   |
| dev_id      |   | 5:0  |             | Device ID, reads 0x39. |   |   |   |   |

### [CONVERT \(0x01\)](#)

| BIT         | 7           | 6    | 5 | 4                                                                                                                                                         | 3 | 2 | 1 | 0 |
|-------------|-------------|------|---|-----------------------------------------------------------------------------------------------------------------------------------------------------------|---|---|---|---|
| Field       | convert     | –    | – | –                                                                                                                                                         | – | – | – | – |
| Reset       | 0b0         | –    | – | –                                                                                                                                                         | – | – | – | – |
| Access Type | Write, Read | –    | – | –                                                                                                                                                         | – | – | – | – |
| BITFIELD    |             | BITS |   | DESCRIPTION                                                                                                                                               |   |   |   |   |
| convert     |             | 7    |   | Write a 1 to this bit to start a conversion cycle of the ADC. When the cycle is finished, this bit is automatically reset to indicate that data is ready. |   |   |   |   |

### [REG\\_CTRL \(0x02\)](#)

| BIT         | 7    | 6           | 5                                                                                              | 4 | 3 | 2                                                                                 | 1 | 0 |
|-------------|------|-------------|------------------------------------------------------------------------------------------------|---|---|-----------------------------------------------------------------------------------|---|---|
| Field       | –    | dis_refr    | nv_count[2:0]                                                                                  |   |   | rev_id[2:0]                                                                       |   |   |
| Reset       | –    | 0b0         |                                                                                                |   |   | 0x0                                                                               |   |   |
| Access Type | –    | Write, Read | Read Only                                                                                      |   |   | Read Only                                                                         |   |   |
| BITFIELD    | BITS |             | DESCRIPTION                                                                                    |   |   | DECODE                                                                            |   |   |
| dis_refr    | 6    |             | Refresh disable bit. Use this bit to temporarily disable refresh before a burn_otp command.    |   |   | 0x0: Refresh bit determines whether refresh is on or off<br>0x1: Refresh disabled |   |   |
| nv_count    | 5:3  |             | This field indicates the total number of writes to nonvolatile memory. The maximum value is 6. |   |   |                                                                                   |   |   |
| rev_id      | 2:0  |             | Revision ID. Reads 0x0.                                                                        |   |   |                                                                                   |   |   |

**TFTMASK1 (0x03)**

| BIT         | 7             | 6            | 5             | 4             | 3            | 2            | 1             | 0             |
|-------------|---------------|--------------|---------------|---------------|--------------|--------------|---------------|---------------|
| Field       | hvinp_ov_mask | avdd_uv_mask | navdd_ov_mask | navdd_uv_mask | vgon_ov_mask | vgon_uv_mask | vgoff_ov_mask | vgoff_uv_mask |
| Reset       | 0x0           | 0x0          | 0x0           | 0x0           | 0x0          | 0x0          | 0x0           | 0x0           |
| Access Type | Write, Read   | Write, Read  | Write, Read   | Write, Read   | Write, Read  | Write, Read  | Write, Read   | Write, Read   |

| BITFIELD      | BITS | DESCRIPTION                                                                             |
|---------------|------|-----------------------------------------------------------------------------------------|
| hvinp_ov_mask | 7    | When 1, this bit prevents an overvoltage on AVDD from asserting FLTB low.               |
| avdd_uv_mask  | 6    | When 1, this bit prevents an undervoltage on AVDD from asserting FLTB low.              |
| navdd_ov_mask | 5    | When 1, this bit prevents an overvoltage on NAVDD from asserting FLTB low.              |
| navdd_uv_mask | 4    | When 1, this bit prevents an undervoltage on NAVDD from asserting FLTB low.             |
| vgon_ov_mask  | 3    | When 1, this bit prevents an overvoltage on VG <sub>ON</sub> from asserting FLTB low.   |
| vgon_uv_mask  | 2    | When 1, this bit prevents an undervoltage on VG <sub>ON</sub> from asserting FLTB low.  |
| vgoff_ov_mask | 1    | When 1, this bit prevents an overvoltage on VG <sub>OFF</sub> from asserting FLTB low.  |
| vgoff_uv_mask | 0    | When 1, this bit prevents an undervoltage on VG <sub>OFF</sub> from asserting FLTB low. |

**TFTMASK2 (0x04)**

| BIT         | 7         | 6            | 5             | 4             | 3 | 2 | 1            | 0            |
|-------------|-----------|--------------|---------------|---------------|---|---|--------------|--------------|
| Field       | flt_flt   | par_err_mask | vin_uvlo_mask | hvinp_uv_mask | – | – | clk_err_mask | th_warn_mask |
| Reset       | 0x0       | 0x0          | 0x0           | 0x0           | – | – | 0x0          | 0x1          |
| Access Type | Read Only | Write, Read  | Write, Read   | Write, Read   | – | – | Write, Read  | Write, Read  |

| BITFIELD      | BITS | DESCRIPTION                                                                                       |
|---------------|------|---------------------------------------------------------------------------------------------------|
| flt_flt       | 7    | When 1, this bit indicates that the FLTB pin is stuck high or low.                                |
| par_err_mask  | 6    | When 1, prevents parity errors from asserting the FLTB pin.                                       |
| vin_uvlo_mask | 5    | When 1, this bit prevents an undervoltage on IN from asserting the FLTB pin.                      |
| hvinp_uv_mask | 4    | Mask bit for hvinp_uv diagnostic. When 1, an undervoltage on HVINP does not cause FLTB to assert. |
| clk_err_mask  | 1    | When 1, this bit prevents a clk_err fault from asserting FLTB low.                                |
| th_warn_mask  | 0    | When 1, this bit prevents an overtemperature warning from asserting FLTB low.                     |

**TFT\_FAULT1 (0x05)**

| BIT         | 7                  | 6                  | 5                  | 4                  | 3                  | 2                  | 1                  | 0                  |
|-------------|--------------------|--------------------|--------------------|--------------------|--------------------|--------------------|--------------------|--------------------|
| Field       | hvinp_ov           | avdd_uv            | navdd_ov           | navdd_uv           | vgon_ov            | vgon_uv            | vgoff_ov           | vgoff_uv           |
| Reset       | 0x0                | 0x0                | 0x0                | 0x0                | 0x0                | 0x0                | 0x0                | 0x0                |
| Access Type | Read<br>Clears All | Read<br>Clears All | Read<br>Clears All | Read<br>Clears All | Read<br>Clears All | Read<br>Clears All | Read<br>Clears All | Read<br>Clears All |

| BITFIELD | BITS | DESCRIPTION                                        |
|----------|------|----------------------------------------------------|
| hvinp_ov | 7    | When 1, this bit indicates an overvoltage on AVDD. |

| BITFIELD | BITS | DESCRIPTION                                                       |
|----------|------|-------------------------------------------------------------------|
| avdd_uv  | 6    | When 1, this bit indicates an undervoltage on AVDD.               |
| navdd_ov | 5    | When 1, this bit indicates an overvoltage on NAVDD.               |
| navdd_uv | 4    | When 1, this bit indicates an undervoltage on NAVDD.              |
| vgon_ov  | 3    | When 1, this bit indicates an overvoltage on VG <sub>ON</sub> .   |
| vgon_uv  | 2    | When 1, this bit indicates an undervoltage on VG <sub>ON</sub> .  |
| vgoff_ov | 1    | When 1, this bit indicates an overvoltage on VG <sub>OFF</sub> .  |
| vgoff_uv | 0    | When 1, this bit indicates an undervoltage on VG <sub>OFF</sub> . |

**TFT\_FAULT2 (0x06)**

| BIT         | 7                  | 6                  | 5                  | 4                  | 3                  | 2                  | 1         | 0                  |
|-------------|--------------------|--------------------|--------------------|--------------------|--------------------|--------------------|-----------|--------------------|
| Field       | v18oor             | par_err            | vin_uvlo           | hvinp_uv           | th_shdn            | nv_flt             | clk_err   | th_warn            |
| Reset       | 0x0                | 0x0                | 0x0                | 0x0                | 0x0                | 0x0                | 0x0       | 0x0                |
| Access Type | Read<br>Clears All | Read<br>Clears All | Read<br>Clears All | Read<br>Clears All | Read<br>Clears All | Read<br>Clears All | Read Only | Read<br>Clears All |

| BITFIELD | BITS | DESCRIPTION                                                                                                                                                                                                                                                                                                     |
|----------|------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| v18oor   | 7    | Indicates that the 1.8V output is out of range, either above its overvoltage level or below its undervoltage level.                                                                                                                                                                                             |
| par_err  | 6    | Indicates that a parity error was detected on an I <sup>2</sup> C transaction.                                                                                                                                                                                                                                  |
| vin_uvlo | 5    | Indicates an undervoltage condition on the IN pin. When this happens, the device turns off all outputs and waits for IN to return above the IN UVLO level, after which the outputs are reenabled in the programmed sequence.                                                                                    |
| hvinp_uv | 4    | When 1, this bit indicates an undervoltage on the boost output, HVINP.                                                                                                                                                                                                                                          |
| th_shdn  | 3    | When 1, this bit indicates an overtemperature shutdown on the TFT section and that the complete device has been turned off.                                                                                                                                                                                     |
| nv_flt   | 2    | Nonvolatile memory failure – unsuccessful transfer of the contents of NV memory to working memory or more than one error detected.                                                                                                                                                                              |
| clk_err  | 1    | When this bit is 1, the clock for either the TFT or the backlight section has been inactive for 5μs or is out of range. Unless this fault is masked, the FLTB pin asserts low and the local microcontroller should disable the device using the EN pin. This fault can only be cleared by power-on reset (POR). |
| th_warn  | 0    | When 1, this bit indicates a thermal warning.                                                                                                                                                                                                                                                                   |

**TFT\_CONFIG (0x07)**

| BIT         | 7           | 6           | 5           | 4           | 3           | 2 | 1           | 0 |
|-------------|-------------|-------------|-------------|-------------|-------------|---|-------------|---|
| Field       | dis_navdd   | refresh     | en_ss       | fSW         | tretry[1:0] |   | tfault[1:0] |   |
| Reset       | 0x0         | 0x0         | 0x0         | 0x0         | 0x1         |   | 0x0         |   |
| Access Type | Write, Read | Write, Read | Write, Read | Write, Read | Write, Read |   | Write, Read |   |

| BITFIELD  | BITS | DESCRIPTION                                                                                                                                                                         | DECODE |
|-----------|------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--------|
| dis_navdd | 7    | When set to 1, this bit disables the NAVDD converter. Set this bit before enabling the device using the start bit. The dis_navdd bit should not be changed during device operation. |        |

| BITFIELD | BITS | DESCRIPTION                                                                                                           | DECODE                                                                                                                            |
|----------|------|-----------------------------------------------------------------------------------------------------------------------|-----------------------------------------------------------------------------------------------------------------------------------|
| refresh  | 6    | When this bit is 1, the contents of the NV registers are automatically copied to the volatile registers every second. | 0x0: Refresh disabled<br>0x1: Refresh enabled                                                                                     |
| en_ss    | 5    | Enable spread-spectrum by setting this bit to 1.                                                                      |                                                                                                                                   |
| fSW      | 4    | Sets switching frequency of TFT section.                                                                              | 0x0: 2.1MHz<br>0x1: 420kHz                                                                                                        |
| tretry   | 3:2  | Sets retry time after a fault.                                                                                        | 0x0: Retry disabled<br>0x1: Retry after 0.95s, total 3 retries<br>0x2: Retry after 1.9s, total 3 retries<br>0x3: Retry after 1.9s |
| tfault   | 1:0  | Sets fault delay time.                                                                                                | 0x0: 15ms<br>0x1: 30ms<br>0x2: 60ms<br>0x3: 90ms                                                                                  |

**DELAY (0x08)**

| BIT         | 7            | 6 | 5            | 4 | 3            | 2 | 1 | 0           |
|-------------|--------------|---|--------------|---|--------------|---|---|-------------|
| Field       | delayt1[1:0] |   | delayt2[1:0] |   | delayt3[1:0] |   | – | par_en      |
| Reset       | 0x2          |   | 0x2          |   | 0x2          |   | – | 0x0         |
| Access Type | Write, Read  |   | Write, Read  |   | Write, Read  |   | – | Write, Read |

| BITFIELD | BITS | DESCRIPTION                                                                                      |
|----------|------|--------------------------------------------------------------------------------------------------|
| delayt1  | 7:6  | Set delay t1 in the start-up sequence. Choose between 0, 5ms, 10ms, and 15ms.                    |
| delayt2  | 5:4  | Set delay t2 in the start-up sequence. Choose between 0, 5ms, 10ms, and 15ms.                    |
| delayt3  | 3:2  | Set delay t3 in the start-up sequence. Choose between 0, 5ms, 10ms, and 15ms.                    |
| par_en   | 0    | Parity enable bit. When 1, this bit enables parity checking on write transactions to the device. |

**SEQ (0x09)**

| BIT         | 7            | 6 | 5 | 4           | 3           | 2 | 1           | 0           |
|-------------|--------------|---|---|-------------|-------------|---|-------------|-------------|
| Field       | seq_set[2:0] |   |   | pfo_th      | tstart[1:0] |   | lxp_lim_low | start       |
| Reset       | 0x2          |   |   | 0x0         | 0x1         |   | 0b0         | 0x0         |
| Access Type | Write, Read  |   |   | Write, Read | Write, Read |   | Write, Read | Write, Read |

| BITFIELD | BITS | DESCRIPTION              | DECODE                                                                                                                                               |
|----------|------|--------------------------|------------------------------------------------------------------------------------------------------------------------------------------------------|
| seq_set  | 7:5  | Sequence selection bits. | 0x0: Sequence 1<br>0x1: Sequence 2<br>0x2: Sequence 3<br>0x3: Sequence 4<br>0x4: Sequence 5<br>0x5: Sequence 6<br>0x6: Sequence 7<br>0x7: Sequence 8 |

| BITFIELD    | BITS | DESCRIPTION                                                                                                                                                       | DECODE                                       |
|-------------|------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------------------------------------------|
| pfo_th      | 4    | This bit sets the nominal falling threshold for the PFO output.                                                                                                   | 0x0: 2.5V<br>0x1: 2.4V                       |
| tstart      | 3:2  | This field sets the start-up time for V <sub>GON</sub> and V <sub>GOFF</sub> between 1ms and 8ms. The AVDD startup is accordingly set to 0.5ms, 1ms, 2ms, or 4ms. | 0x0: 1ms<br>0x1: 2ms<br>0x2: 4ms<br>0x3: 8ms |
| lxp_lim_low | 1    | When 1, the HVINP boost converter current limit is reduced.                                                                                                       |                                              |
| start       | 0    | When this bit is set to 1, the device outputs are turned on in the sequence programmed by the seq_set bits in the SEQ register.                                   |                                              |

**ISSET (0x0A)**

| BIT         | 7 | 6           | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|---|-------------|---|---|---|---|---|---|
| Field       | — | iset[6:0]   |   |   |   |   |   |   |
| Reset       | — |             |   |   |   |   |   |   |
| Access Type | — | Write, Read |   |   |   |   |   |   |

| BITFIELD | BITS | DESCRIPTION                                                                     | DECODE                                                                                                        |
|----------|------|---------------------------------------------------------------------------------|---------------------------------------------------------------------------------------------------------------|
| iset     | 6:0  | The value in this register sets the OUT_LED current in the 23mA to 150mA range. | 0x0: 23mA<br>0x1: 24mA<br>...:<br>0xB: 34mA<br>0xC: 35mA<br>...:<br>0x7D: 148mA<br>0x7E: 149mA<br>0x7F: 150mA |

**BL\_CONFIG1 (0x0B)**

| BIT         | 7           | 6           | 5             | 4 | 3           | 2           | 1           | 0           |
|-------------|-------------|-------------|---------------|---|-------------|-------------|-------------|-------------|
| Field       | dim_ext     | hdim        | hdim_thr[1:0] |   | bstforce    | fast_ss     | psen        | fltb_mode   |
| Reset       | 0x1         | 0x0         | 0x00          |   | 0x0         | 0x0         | 0x1         | 0x0         |
| Access Type | Write, Read | Write, Read | Write, Read   |   | Write, Read | Write, Read | Write, Read | Write, Read |

| BITFIELD | BITS | DESCRIPTION                                                                                              | DECODE                                               |
|----------|------|----------------------------------------------------------------------------------------------------------|------------------------------------------------------|
| dim_ext  | 7    | When 1, dimming through the DIM pin is enabled. When 0, dimming is controlled using the TON__ registers. |                                                      |
| hdim     | 6    | When 1, hybrid dimming is enabled.                                                                       |                                                      |
| hdim_thr | 5:4  | Set hybrid-dimming threshold. Default value is 6.25% (00).                                               | 0x00: 6.25%<br>0x01: 12.5%<br>0x10: 25%<br>0x11: 50% |
| bstforce | 3    | When 1, this bit forces the boost converter to run continuously, independently of the dimming signal.    |                                                      |

| BITFIELD  | BITS | DESCRIPTION                                                                                                                                                                                | DECODE |
|-----------|------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--------|
| fast_ss   | 2    | Selects slow or fast boost soft-start. Set to 1 for fast soft-start.                                                                                                                       |        |
| psen      | 1    | When 0, phase shifting is disabled. When 1, phase shifting is enabled.                                                                                                                     |        |
| fltb_mode | 0    | This bit sets the mode of operation of the FLTB pin in standalone mode. When 0, the FLTB outputs a PWM signal to indicate the type of fault. When 1, FLTB is low when a fault is detected. |        |

**BL\_CONFIG2 (0x0C)**

| BIT         | 7           | 6           | 5 | 4 | 3           | 2           | 1           | 0 |
|-------------|-------------|-------------|---|---|-------------|-------------|-------------|---|
| Field       | bl_ilim     | fpwm[2:0]   |   |   | bl_ss_off   | bl_ssl      | sldet[1:0]  |   |
| Reset       | 0x1         | 0x001       |   |   | 0x0         | 0x0         | 0x00        |   |
| Access Type | Write, Read | Write, Read |   |   | Write, Read | Write, Read | Write, Read |   |

| BITFIELD  | BITS | DESCRIPTION                                                                                                                                                                                                                                                                                                                     | DECODE                                                                                                          |
|-----------|------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-----------------------------------------------------------------------------------------------------------------|
| bl_ilim   | 7    | Sets boost current limit to one of two levels. When 1, the lower current limit is selected.                                                                                                                                                                                                                                     |                                                                                                                 |
| fpwm      | 6:4  | These bits set the PWM frequency in internal PWM mode.                                                                                                                                                                                                                                                                          | 0x0: 153Hz<br>0x1: 203Hz<br>0x2: 305Hz<br>0x3: 610Hz<br>0x4: 980Hz<br>0x5: 1220Hz<br>0x6: 1401Hz<br>0x7: 1634Hz |
| bl_ss_off | 3    | When 1, spread-spectrum switching is disabled.                                                                                                                                                                                                                                                                                  |                                                                                                                 |
| bl_ssl    | 2    | When spread spectrum is enabled, the bl_ssl bit chooses the amount of spread: When 0, the spread is nominally $\pm 6\%$ ; when 1, the spread is $\pm 3\%$ . When changing the percentage, first disable spread spectrum using the SS_OFF bit, then change the value of SSL, and finally reenables spread spectrum using SS_OFF. |                                                                                                                 |
| sldet     | 1:0  | Shorted-LED threshold settings.                                                                                                                                                                                                                                                                                                 | 0x0: Disabled<br>0x1: 3V<br>0x2: 6V<br>0x3: 8V                                                                  |

**BL\_DIS (0x0D)**

| BIT         | 7           | 6 | 5           | 4           | 3           | 2           | 1           | 0           |
|-------------|-------------|---|-------------|-------------|-------------|-------------|-------------|-------------|
| Field       | cp_dis      | – | dis_bl      | dis6        | dis5        | dis4        | dis3        | dis2        |
| Reset       | 0x0         | – | 0x0         | 0x0         | 0x0         | 0x0         | 0x0         | 0x0         |
| Access Type | Write, Read | – | Write, Read | Write, Read | Write, Read | Write, Read | Write, Read | Write, Read |

| BITFIELD | BITS | DESCRIPTION                                                                                                                                                                                                                                 |
|----------|------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| cp_dis   | 7    | When 1, this bit disables the internal charge pump which drives the NGATE pin. Set to 1 when an external series switch is not used. Setting CP_DIS to 0 during operation will cause complete shutdown of the device and is not recommended. |
| dis_bl   | 5    | Disable bit for backlight section.                                                                                                                                                                                                          |
| dis6     | 4    | Set this bit to 1 to disable OUT6. This must be done before ENA is written to 1.                                                                                                                                                            |
| dis5     | 3    | Set this bit to 1 to disable OUT5. This must be done before ENA is written to 1.                                                                                                                                                            |
| dis4     | 2    | Set this bit to 1 to disable OUT4. This must be done before ENA is written to 1.                                                                                                                                                            |
| dis3     | 1    | Set this bit to 1 to disable OUT3. This must be done before ENA is written to 1.                                                                                                                                                            |
| dis2     | 0    | Set this bit to 1 to disable OUT2. This must be done before ENA is written to 1.                                                                                                                                                            |

**BL\_FADING (0x0E)**

| BIT         | 7 | 6 | 5 | 4           | 3           | 2           | 1 | 0 |
|-------------|---|---|---|-------------|-------------|-------------|---|---|
| Field       | – | – | – | fade_gain   | fade_in_out | tfade[2:0]  |   |   |
| Reset       | – | – | – | 0b0         | 0b0         | 0x0         |   |   |
| Access Type | – | – | – | Write, Read | Write, Read | Write, Read |   |   |

| BITFIELD    | BITS | DESCRIPTION                                                                                                                                                 | DECODE                                                                   |
|-------------|------|-------------------------------------------------------------------------------------------------------------------------------------------------------------|--------------------------------------------------------------------------|
| fade_gain   | 4    | When this bit is set to 1, the fade-in-out function has a gain of 12.5%, otherwise 6.25%.                                                                   |                                                                          |
| fade_in_out | 3    | When this bit is set to 1, the fade-in-out function for the LED dimming is enabled.                                                                         |                                                                          |
| tfade       | 2:0  | Sets the fading update time interval according to 2 <sup>TDIM</sup> . TDIM can be between 0 and 5. When set to 0, fading is updated on every dimming cycle. | 0x1: 2<br>0x2: 4<br>0x3: 8<br>0x4: 16<br>0x5: 32<br>0x6: N/A<br>0x7: N/A |

**CUSTOMER\_USE1 (0x0F)**

Register which can be used to store user data that can also be stored in nonvolatile memory.

| BIT           | 7                  | 6           | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|--------------------|-------------|---|---|---|---|---|---|
| Field         | customer_use1[7:0] |             |   |   |   |   |   |   |
| Reset         |                    |             |   |   |   |   |   |   |
| Access Type   | Write, Read        |             |   |   |   |   |   |   |
| BITFIELD      | BITS               | DESCRIPTION |   |   |   |   |   |   |
| customer_use1 | 7:0                |             |   |   |   |   |   |   |

**CUSTOMER\_USE2 (0x10)**

Register which can be used to store user data that can also be stored in nonvolatile memory.

| BIT         | 7                  | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|--------------------|---|---|---|---|---|---|---|
| Field       | customer_use2[7:0] |   |   |   |   |   |   |   |
| Reset       |                    |   |   |   |   |   |   |   |
| Access Type | Write, Read        |   |   |   |   |   |   |   |

| BITFIELD      | BITS | DESCRIPTION |
|---------------|------|-------------|
| customer_use2 | 7:0  |             |

**CUSTOMER\_USE3 (0x11)**

Register which can be used to store user data that can also be stored in nonvolatile memory.

| BIT         | 7                  | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|--------------------|---|---|---|---|---|---|---|
| Field       | customer_use3[7:0] |   |   |   |   |   |   |   |
| Reset       |                    |   |   |   |   |   |   |   |
| Access Type | Write, Read        |   |   |   |   |   |   |   |

| BITFIELD      | BITS | DESCRIPTION |
|---------------|------|-------------|
| customer_use3 | 7:0  |             |

**CUSTOMER\_USE4 (0x12)**

Register which can be used to store user data that can also be stored in nonvolatile memory.

| BIT         | 7                  | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|--------------------|---|---|---|---|---|---|---|
| Field       | customer_use4[7:0] |   |   |   |   |   |   |   |
| Reset       |                    |   |   |   |   |   |   |   |
| Access Type | Write, Read        |   |   |   |   |   |   |   |

| BITFIELD      | BITS | DESCRIPTION |
|---------------|------|-------------|
| customer_use4 | 7:0  |             |

**AVDD\_SET (0x13)**

| BIT         | 7 | 6 | 5           | 4 | 3 | 2 | 1 | 0 |
|-------------|---|---|-------------|---|---|---|---|---|
| Field       | – | – | avdd[5:0]   |   |   |   |   |   |
| Reset       | – | – | 0x1A        |   |   |   |   |   |
| Access Type | – | – | Write, Read |   |   |   |   |   |

| BITFIELD | BITS | DESCRIPTION                                                                                                                           |               |               |
|----------|------|---------------------------------------------------------------------------------------------------------------------------------------|---------------|---------------|
| avdd     | 5:0  | Sets AVDD and NAVDD voltages. When NAVDD is disabled using the dis_navdd bit, the voltage values represented by the avdd bits change. |               |               |
|          |      | Value                                                                                                                                 | dis_navdd = 1 | dis_navdd = 0 |
|          |      | 0x0                                                                                                                                   | 11.7          | N/A           |
|          |      | 0x1                                                                                                                                   | 11.8          | N/A           |
|          |      | 0x2                                                                                                                                   | 11.9          | N/A           |
|          |      | 0x3                                                                                                                                   | 12            | N/A           |
|          |      | 0x4                                                                                                                                   | 12.1          | N/A           |
|          |      | 0x5                                                                                                                                   | 12.2          | N/A           |
|          |      | 0x6                                                                                                                                   | 12.3          | N/A           |
|          |      | 0x7                                                                                                                                   | 12.4          | 4.9           |
|          |      | 0x8                                                                                                                                   | 12.5          | 5             |
|          |      | 0x9                                                                                                                                   | 12.6          | 5.1           |
|          |      | 0xA                                                                                                                                   | 12.7          | 5.2           |
|          |      | 0xB                                                                                                                                   | 12.8          | 5.3           |
|          |      | 0xC                                                                                                                                   | 12.9          | 5.4           |
|          |      | 0xD                                                                                                                                   | 13            | 5.5           |
|          |      | 0xE                                                                                                                                   | 13.1          | 5.6           |
|          |      | 0xF                                                                                                                                   | 13.2          | 5.7           |
|          |      | 0x10                                                                                                                                  | 13.3          | 5.8           |
|          |      | 0x11                                                                                                                                  | 13.4          | 5.9           |
|          |      | 0x12                                                                                                                                  | 13.5          | 6             |
|          |      | 0x13                                                                                                                                  | 13.6          | 6.1           |
|          |      | 0x14                                                                                                                                  | 13.7          | 6.2           |
|          |      | 0x15                                                                                                                                  | 13.8          | 6.3           |
|          |      | 0x16                                                                                                                                  | 13.9          | 6.4           |
|          |      | 0x17                                                                                                                                  | 14            | 6.5           |
|          |      | 0x18                                                                                                                                  | 14.1          | 6.6           |
|          |      | 0x19                                                                                                                                  | 14.2          | 6.7           |
|          |      | 0x1A                                                                                                                                  | 14.3          | 6.8           |
|          |      | 0x1B                                                                                                                                  | 14.4          | 6.9           |
|          |      | 0x1C                                                                                                                                  | 14.5          | 7V            |
|          |      | 0x1D                                                                                                                                  | 14.6          | 7.1           |
|          |      | 0x1E                                                                                                                                  | 14.7          | 7.2           |
|          |      | 0x1F                                                                                                                                  | 14.8          | 7.3           |
|          |      | 0x20                                                                                                                                  | 14.9          | 7.4           |
|          |      | 0x21                                                                                                                                  | 15            | 7.5           |
|          |      | 0x22                                                                                                                                  | 15.1          | 7.6           |
|          |      | 0x23                                                                                                                                  | 15.2          | 7.7           |
|          |      | 0x24                                                                                                                                  | 15.3          | 7.8           |
|          |      | 0x25                                                                                                                                  | 15.4          | 7.9           |
|          |      | 0x26                                                                                                                                  | 15.5          | 8             |

| BITFIELD | BITS | DESCRIPTION |             |          |
|----------|------|-------------|-------------|----------|
|          |      | Address     | Size (bits) | Function |
|          |      | 0x27        | 15.6        | 8.1      |
|          |      | 0x28        | 15.7        | 8.2      |
|          |      | 0x29        | 15.8        | 8.3      |
|          |      | 0x2A        | 15.9        | 8.4      |
|          |      | 0x2B        | 16          | 8.5      |
|          |      | 0x2C        | 16.1        | 8.6      |
|          |      | 0x2D        | 16.2        | 8.7      |
|          |      | 0x2E        | 16.3        | 8.8      |
|          |      | 0x2F        | 16.4        | 8.9      |
|          |      | 0x30        | 16.5        | 9        |
|          |      | 0x31        | 16.6        | 9.1      |
|          |      | 0x32        | 16.7        | 9.2      |
|          |      | 0x33        | 16.8        | 9.3      |
|          |      | 0x34        | 16.9        | 9.4      |
|          |      | 0x35        | 17          | 9.5      |
|          |      | 0x36        | 17.1        | 9.6      |
|          |      | 0x37        | 17.2        | 9.7      |
|          |      | 0x38        | 17.3        | 9.8      |
|          |      | 0x39        | 17.4        | 9.9      |
|          |      | 0x3A        | 17.5        | 10       |
|          |      | 0x3B        | 17.6        | 10.1     |
|          |      | 0x3C        | 17.7        | 10.2     |
|          |      | 0x3D        | 17.8        | 10.3     |
|          |      | 0x3E        | 17.9        | 10.4     |
|          |      | 0x3F        | 18          | 10.5     |

**VGON (0x14)**

| BIT         | 7 | 6 | 5           | 4 | 3 | 2 | 1 | 0 |
|-------------|---|---|-------------|---|---|---|---|---|
| Field       | — | — | vgon[5:0]   |   |   |   |   |   |
| Reset       | — | — | 0x16        |   |   |   |   |   |
| Access Type | — | — | Write, Read |   |   |   |   |   |

| BITFIELD | BITS | DESCRIPTION                    |               |               |
|----------|------|--------------------------------|---------------|---------------|
| vgon     | 5:0  | Sets V <sub>GON</sub> voltage. |               |               |
|          |      | Value                          | dis_navdd = 0 | dis_navdd = 1 |
|          |      | 0x0                            | 8.4           | 12.6          |
|          |      | 0x1                            | 8.6           | 12.9          |
|          |      | 0x2                            | 8.8           | 13.2          |
|          |      | 0x3                            | 9             | 13.5          |
|          |      | 0x4                            | 9.2           | 13.8          |
|          |      | 0x5                            | 9.4           | 14.1          |
|          |      | 0x6                            | 9.6           | 14.4          |
|          |      | 0x7                            | 9.8           | 14.7          |
|          |      | 0x8                            | 10            | 15            |
|          |      | 0x9                            | 10.2          | 15.3          |
|          |      | 0xA                            | 10.4          | 15.6          |
|          |      | 0xB                            | 10.6          | 15.9          |
|          |      | 0xC                            | 10.8          | 16.2          |
|          |      | 0xD                            | 11            | 16.5          |
|          |      | 0xE                            | 11.2          | 16.8          |
|          |      | 0xF                            | 11.4          | 17.1          |
|          |      | 0x10                           | 11.6          | 17.4          |
|          |      | 0x11                           | 11.8          | 17.7          |
|          |      | 0x12                           | 12            | 18            |
|          |      | 0x13                           | 12.2          | 18.3          |
|          |      | 0x14                           | 12.4          | 18.6          |
|          |      | 0x15                           | 12.6          | 18.9          |
|          |      | 0x16                           | 12.8          | 19.2          |
|          |      | 0x17                           | 13            | 19.5          |
|          |      | 0x18                           | 13.2          | 19.8          |
|          |      | 0x19                           | 13.4          | 20.1          |
|          |      | 0x1A                           | 13.6          | 20.4          |
|          |      | 0x1B                           | 13.8          | 20.7          |
|          |      | 0x1C                           | 14            | 21            |
|          |      | 0x1D                           | 14.2          | 21.3          |
|          |      | 0x1E                           | 14.4          | 21.6          |
|          |      | 0x1F                           | 14.6          | 21.9          |
|          |      | 0x20                           | 14.8          | 22.2          |
|          |      | 0x21                           | 15            | 22.5          |
|          |      | 0x22                           | 15.2          | 22.8          |
|          |      | 0x23                           | 15.4          | 23.1          |
|          |      | 0x24                           | 15.6          | 23.4          |
|          |      | 0x25                           | 15.8          | 23.7          |
|          |      | 0x26                           | 16            | 24            |
|          |      | 0x27                           | 16.2          | 24.3          |

| BITFIELD | BITS | DESCRIPTION |           |         |
|----------|------|-------------|-----------|---------|
|          |      | Address     | Start Bit | End Bit |
|          |      | 0x28        | 16.4      | 24.6    |
|          |      | 0x29        | 16.6      | 24.9    |
|          |      | 0x2A        | 16.8      | 25.2    |
|          |      | 0x2B        | 17        | 25.5    |
|          |      | 0x2C        | 17.2      | 25.8    |
|          |      | 0x2D        | 17.4      | 26.1    |
|          |      | 0x2E        | 17.6      | 26.4    |
|          |      | 0x2F        | 17.8      | 26.7    |
|          |      | 0x30        | 18        | 27      |
|          |      | 0x31        | 18.2      | 27.3    |
|          |      | 0x32        | 18.4      | 27.6    |
|          |      | 0x33        | 18.6      | 27.9    |
|          |      | 0x34        | 18.8      | 28.2    |
|          |      | 0x35        | 19        | 28.5    |
|          |      | 0x36        | 19.2      | 28.8    |
|          |      | 0x37        | 19.4      | 29.1    |
|          |      | 0x38        | 19.6      | 29.4    |
|          |      | 0x39        | 19.8      | 29.7    |
|          |      | 0x3A        | 20        | 30      |
|          |      | 0x3B        | 20.2      | 30.3    |
|          |      | 0x3C        | 20.4      | 30.6    |
|          |      | 0x3D        | 20.6      | 30.9    |
|          |      | 0x3E        | 20.8      | 31.2    |
|          |      | 0x3F        | 21        | 31.5    |

**VG OFF (0x15)**

| BIT         | 7 | 6 | 5           | 4 | 3 | 2 | 1 | 0 |
|-------------|---|---|-------------|---|---|---|---|---|
| Field       | — | — | vgoff[5:0]  |   |   |   |   |   |
| Reset       | — | — | 0x16        |   |   |   |   |   |
| Access Type | — | — | Write, Read |   |   |   |   |   |

| BITFIELD | BITS | DESCRIPTION                     | DECODE                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                            |
|----------|------|---------------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| vgoff    | 5:0  | Sets VG <sub>OFF</sub> voltage. | 0x0: -4<br>0x1: -4.25<br>0x2: -4.5<br>0x3: -4.75<br>0x4: -5<br>0x5: -5.25<br>0x6: -5.5<br>0x7: -5.75<br>0x8: -6<br>0x9: -6.25<br>0xA: -6.5<br>0xB: -6.75<br>0xC: -7<br>0xD: -7.25<br>0xE: -7.5<br>0xF: -7.75<br>0x10: -8<br>0x11: -8.25<br>0x12: -8.5<br>0x13: -8.75<br>0x14: -9<br>0x15: -9.25<br>0x16: -9.5<br>0x17: -9.75<br>0x18: -10<br>0x19: -10.25<br>0x1A: -10.5<br>0x1B: -10.75<br>0x1C: -11<br>0x1D: -11.25<br>0x1E: -11.5<br>0x1F: -11.75<br>0x20: -12<br>0x21: -12.25<br>0x22: -12.5<br>0x23: -12.75<br>0x24: -13<br>0x25: -13.25<br>0x26: -13.5<br>0x27: -13.75<br>0x28: -14<br>0x29: -14.25<br>0x2A: -14.5<br>0x2B: -14.75<br>0x2C: -15<br>0x2D: -15.25<br>0x2E: -15.5<br>0x2F: -15.75<br>0x30: -16<br>0x31: -16.25<br>0x32: -16.5<br>0x33: -16.75<br>0x34: -17<br>0x35: -17.25<br>0x36: -17.5<br>0x37: -17.75<br>0x38: -18<br>0x39: Do not use<br>0x3A: Do not use |

| BITFIELD | BITS | DESCRIPTION | DECODE                                                                                           |
|----------|------|-------------|--------------------------------------------------------------------------------------------------|
|          |      |             | 0x3B: Do not use<br>0x3C: Do not use<br>0x3D: Do not use<br>0x3E: Do not use<br>0x3F: Do not use |

**NV\_CONFIG (0x17)**

Nonvolatile configuration register

| BIT         | 7            | 6          | 5         | 4         | 3              | 2 | 1              | 0 |
|-------------|--------------|------------|-----------|-----------|----------------|---|----------------|---|
| Field       | nv_dis_navdd | nv_refresh | nv_en_ss  | nv_fSW    | nv_tretry[1:0] |   | nv_tfault[1:0] |   |
| Reset       | 0x1          | 0x1        | 0x1       | 0x1       | 0x3            |   | 0x3            |   |
| Access Type | Read Only    | Read Only  | Read Only | Read Only | Read Only      |   | Read Only      |   |

| BITFIELD     | BITS | DESCRIPTION                | DECODE                     |
|--------------|------|----------------------------|----------------------------|
| nv_dis_navdd | 7    | NV setting for dis_navdd   |                            |
| nv_refresh   | 6    | NV setting for refresh bit |                            |
| nv_en_ss     | 5    | NV setting for en_ss bit   |                            |
| nv_fSW       | 4    | NV setting for fSW bit     | 0x0: 2.2MHz<br>0x1: 440kHz |
| nv_tretry    | 3:2  | NV setting for tretry bits |                            |
| nv_tfault    | 1:0  | NV setting for tfault bits |                            |

**NV\_DELAY (0x18)**

| BIT         | 7               | 6 | 5               | 4 | 3               | 2 | 1         | 0         |
|-------------|-----------------|---|-----------------|---|-----------------|---|-----------|-----------|
| Field       | nv_delayt1[1:0] |   | nv_delayt2[1:0] |   | nv_delayt3[1:0] |   | unused    | nv_par_en |
| Reset       | 0x3             |   | 0x3             |   | 0x3             |   | 0x1       | 0x1       |
| Access Type | Read Only       |   | Read Only       |   | Read Only       |   | Read Only | Read Only |

| BITFIELD   | BITS | DESCRIPTION               |
|------------|------|---------------------------|
| nv_delayt1 | 7:6  | NV setting for delayt1    |
| nv_delayt2 | 5:4  | NV setting for delayt2    |
| nv_delayt3 | 3:2  | NV setting for delayt3    |
| unused     | 1    |                           |
| nv_par_en  | 0    | NV setting for par_en bit |

**NV\_SEQ (0x19)**

| BIT         | 7               | 6 | 5 | 4         | 3              | 2 | 1              | 0         |
|-------------|-----------------|---|---|-----------|----------------|---|----------------|-----------|
| Field       | nv_seq_set[2:0] |   |   | nv_pfo_th | nv_tstart[1:0] |   | nv_lxp_lim_low | nv_start  |
| Reset       | 0x7             |   |   | 0x1       | 0x3            |   | 0x1            | 0x1       |
| Access Type | Read Only       |   |   | Read Only | Read Only      |   | Read Only      | Read Only |

| BITFIELD       | BITS | DESCRIPTION                    |
|----------------|------|--------------------------------|
| nv_seq_set     | 7:5  | NV setting for seq_set bits    |
| nv_pfo_th      | 4    | NV setting for pfo_th bit      |
| nv_tstart      | 3:2  | NV setting for tstart bits     |
| nv_lxp_lim_low | 1    | NV setting for lxp_lim_low bit |
| nv_start       | 0    | NV setting for start bit       |

**NV\_ISET (0x1A)**

| BIT         | 7         | 6            | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|-----------|--------------|---|---|---|---|---|---|
| Field       | unused    | nv_iset[6:0] |   |   |   |   |   |   |
| Reset       | 0x1       | 0x7F         |   |   |   |   |   |   |
| Access Type | Read Only | Read Only    |   |   |   |   |   |   |

| BITFIELD | BITS | DESCRIPTION            |
|----------|------|------------------------|
| unused   | 7    |                        |
| nv_iset  | 6:0  | NV LED current setting |

**NV\_BL\_CONFIG1 (0x1B)**

| BIT         | 7          | 6         | 5                | 4 | 3           | 2          | 1         | 0                |
|-------------|------------|-----------|------------------|---|-------------|------------|-----------|------------------|
| Field       | nv_dim_ext | nv_hdim   | nv_hdim_thr[1:0] |   | nv_bstforce | nv_fast_ss | nv_psen   | nv_fltb_mod<br>e |
| Reset       | 0x1        | 0x1       | 0x3              |   | 0x1         | 0x1        | 0x1       | 0x1              |
| Access Type | Read Only  | Read Only | Read Only        |   | Read Only   | Read Only  | Read Only | Read Only        |

| BITFIELD     | BITS | DESCRIPTION                  |
|--------------|------|------------------------------|
| nv_dim_ext   | 7    | NV setting for dim_ext bit   |
| nv_hdim      | 6    | NV setting for hdim bit      |
| nv_hdim_thr  | 5:4  | NV setting for hdim_thr bits |
| nv_bstforce  | 3    | NV setting for bstforce bit  |
| nv_fast_ss   | 2    | NV setting for fast_ss bit   |
| nv_psen      | 1    | NV setting for psen bit      |
| nv_fltb_mode | 0    | NV setting for fltb_mode bit |

**NV\_BL\_CONFIG2 (0x1C)**

| BIT         | 7          | 6            | 5 | 4 | 3                | 2         | 1              | 0 |
|-------------|------------|--------------|---|---|------------------|-----------|----------------|---|
| Field       | nv_bl_ilim | nv_fpwm[2:0] |   |   | nv_bl_ss_of<br>f | nv_bl_ssl | nv_slidet[1:0] |   |
| Reset       | 0x1        | 0x7          |   |   | 0x1              | 0x1       | 0x3            |   |
| Access Type | Read Only  | Read Only    |   |   | Read Only        | Read Only | Read Only      |   |

| BITFIELD   | BITS | DESCRIPTION                |
|------------|------|----------------------------|
| nv_bl_ilim | 7    | NV setting for bl_ilim bit |
| nv_fpwm    | 6:4  | NV setting for fpwm bits   |

| BITFIELD     | BITS | DESCRIPTION                          |
|--------------|------|--------------------------------------|
| nv_bl_ss_off | 3    | NV setting for bl_ss_off bit         |
| nv_bl_ssl    | 2    | NV setting for bl_ssl bit            |
| nv_sldet     | 1:0  | NV setting for shorted-LED threshold |

**NV\_BL\_DIS (0x1D)**

| BIT         | 7         | 6         | 5         | 4         | 3         | 2         | 1         | 0         |
|-------------|-----------|-----------|-----------|-----------|-----------|-----------|-----------|-----------|
| Field       | nv_cp_dis | unused    | nv_dis_bl | nv_dis6   | nv_dis5   | nv_dis4   | nv_dis3   | nv_dis2   |
| Reset       | 0x1       | 0x1       | 0x1       | 0x1       | 0x1       | 0x1       | 0x1       | 0x1       |
| Access Type | Read Only | Read Only | Read Only | Read Only | Read Only | Read Only | Read Only | Read Only |

| BITFIELD  | BITS | DESCRIPTION               |
|-----------|------|---------------------------|
| nv_cp_dis | 7    | NV setting for cp_dis bit |
| unused    | 6    |                           |
| nv_dis_bl | 5    | NV setting for dis_bl bit |
| nv_dis6   | 4    | NV setting for dis6 bit   |
| nv_dis5   | 3    | NV setting for dis5 bit   |
| nv_dis4   | 2    | NV setting for dis4 bit   |
| nv_dis3   | 1    | NV setting for dis3 bit   |
| nv_dis2   | 0    | NV setting for dis2 bit   |

**NV\_BL\_FADING (0x1E)**

| BIT         | 7           | 6 | 5 | 4            | 3              | 2             | 1 | 0 |
|-------------|-------------|---|---|--------------|----------------|---------------|---|---|
| Field       | unused[2:0] |   |   | nv_fade_gain | nv_fade_in_out | nv_tfade[2:0] |   |   |
| Reset       | 0x7         |   |   | 0x1          | 0x1            | 0x7           |   |   |
| Access Type | Read Only   |   |   | Read Only    | Read Only      | Read Only     |   |   |

| BITFIELD       | BITS | DESCRIPTION                  |
|----------------|------|------------------------------|
| unused         | 7:5  |                              |
| nv_fade_gain   | 4    | NV setting for fade_gain bit |
| nv_fade_in_out | 3    | NV setting for fade_in_out   |
| nv_tfade       | 2:0  | NV setting for tfade bits    |

**NV\_CUSTOMER\_USE1 (0x1F)**

Register which can be used to store user data.

| BIT         | 7                     | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|-----------------------|---|---|---|---|---|---|---|
| Field       | nv_customer_use1[7:0] |   |   |   |   |   |   |   |
| Reset       | 0xff                  |   |   |   |   |   |   |   |
| Access Type | Read Only             |   |   |   |   |   |   |   |

| BITFIELD         | BITS | DESCRIPTION |
|------------------|------|-------------|
| nv_customer_use1 | 7:0  |             |

**NV\_CUSTOMER\_USE2 (0x20)**

Register which can be used to store user data.

| BIT         | 7                     | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|-----------------------|---|---|---|---|---|---|---|
| Field       | nv_customer_use2[7:0] |   |   |   |   |   |   |   |
| Reset       | 0xff                  |   |   |   |   |   |   |   |
| Access Type | Read Only             |   |   |   |   |   |   |   |

| BITFIELD         | BITS | DESCRIPTION |
|------------------|------|-------------|
| nv_customer_use2 | 7:0  |             |

**NV\_CUSTOMER\_USE3 (0x21)**

Register which can be used to store user data.

| BIT         | 7                     | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|-----------------------|---|---|---|---|---|---|---|
| Field       | nv_customer_use3[7:0] |   |   |   |   |   |   |   |
| Reset       | 0xff                  |   |   |   |   |   |   |   |
| Access Type | Read Only             |   |   |   |   |   |   |   |

| BITFIELD         | BITS | DESCRIPTION |
|------------------|------|-------------|
| nv_customer_use3 | 7:0  |             |

**NV\_CUSTOMER\_USE4 (0x22)**

Register which can be used to store user data.

| BIT         | 7                     | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|-----------------------|---|---|---|---|---|---|---|
| Field       | nv_customer_use4[7:0] |   |   |   |   |   |   |   |
| Reset       | 0xff                  |   |   |   |   |   |   |   |
| Access Type | Read Only             |   |   |   |   |   |   |   |

| BITFIELD         | BITS | DESCRIPTION |
|------------------|------|-------------|
| nv_customer_use4 | 7:0  |             |

**NV\_AVDD\_SET (0x23)**

| BIT         | 7           | 6 | 5            | 4 | 3 | 2 | 1 | 0 |
|-------------|-------------|---|--------------|---|---|---|---|---|
| Field       | unused[1:0] |   | nv_avdd[5:0] |   |   |   |   |   |
| Reset       | 0x3         |   | 0x3f         |   |   |   |   |   |
| Access Type | Read Only   |   | Read Only    |   |   |   |   |   |

| BITFIELD | BITS | DESCRIPTION              |
|----------|------|--------------------------|
| unused   | 7:6  |                          |
| nv_avdd  | 5:0  | NV setting for avdd bits |

[NV\\_VGON \(0x24\)](#)

| BIT         | 7           | 6 | 5            | 4 | 3 | 2 | 1 | 0 |
|-------------|-------------|---|--------------|---|---|---|---|---|
| Field       | unused[1:0] |   | nv_vgon[5:0] |   |   |   |   |   |
| Reset       | 0x3         |   | 0x3f         |   |   |   |   |   |
| Access Type | Read Only   |   | Read Only    |   |   |   |   |   |

| BITFIELD | BITS | DESCRIPTION              |
|----------|------|--------------------------|
| unused   | 7:6  |                          |
| nv_vgon  | 5:0  | NV setting for vgon bits |

[NV\\_VGOFF \(0x25\)](#)

| BIT         | 7           | 6 | 5             | 4 | 3 | 2 | 1 | 0 |
|-------------|-------------|---|---------------|---|---|---|---|---|
| Field       | unused[1:0] |   | nv_vgoff[5:0] |   |   |   |   |   |
| Reset       | 0x3         |   | 0x3f          |   |   |   |   |   |
| Access Type | Read Only   |   | Read Only     |   |   |   |   |   |

| BITFIELD | BITS | DESCRIPTION               |
|----------|------|---------------------------|
| unused   | 7:6  |                           |
| nv_vgoff | 5:0  | NV setting for vgoff bits |

[AVDD\\_LIM \(0x26\)](#)

| BIT         | 7 | 6 | 5             | 4 | 3 | 2 | 1 | 0 |
|-------------|---|---|---------------|---|---|---|---|---|
| Field       | – | – | avdd_lim[5:0] |   |   |   |   |   |
| Reset       | – | – | 0x3F          |   |   |   |   |   |
| Access Type | – | – | Write, Read   |   |   |   |   |   |

| BITFIELD | BITS | DESCRIPTION                                                                                                                                            |
|----------|------|--------------------------------------------------------------------------------------------------------------------------------------------------------|
| avdd_lim | 5:0  | Maximum limit setting for avdd. To use this function, write to this register before setting avdd. An avdd setting above avdd_lim will not be accepted. |

[LO\\_DIM \(0x27\)](#)

| BIT         | 7           | 6 | 5         | 4         | 3         | 2         | 1         | 0         |
|-------------|-------------|---|-----------|-----------|-----------|-----------|-----------|-----------|
| Field       | ton_master  | – | lo_dim6   | lo_dim5   | lo_dim4   | lo_dim3   | lo_dim2   | lo_dim1   |
| Reset       | 0x0         | – | 0x0       | 0x0       | 0x0       | 0x0       | 0x0       | 0x0       |
| Access Type | Write, Read | – | Read Only | Read Only | Read Only | Read Only | Read Only | Read Only |

| BITFIELD   | BITS | DESCRIPTION                                                                                                 |
|------------|------|-------------------------------------------------------------------------------------------------------------|
| ton_master | 7    | When this bit is set, the 18-bit PWM setting for channel 1 (TON1H:TON1L:TON1LSB) applies to all 6 channels. |
| lo_dim6    | 5    | When 1, indicates that channel 6 is in low-dim mode.                                                        |
| lo_dim5    | 4    | When 1, indicates that channel 5 is in low-dim mode.                                                        |
| lo_dim4    | 3    | When 1, indicates that channel 4 is in low-dim mode.                                                        |

| BITFIELD | BITS | DESCRIPTION                                          |
|----------|------|------------------------------------------------------|
| lo_dim3  | 2    | When 1, indicates that channel 3 is in low-dim mode. |
| lo_dim2  | 1    | When 1, indicates that channel 2 is in low-dim mode. |
| lo_dim1  | 0    | When 1, indicates that channel 1 is in low-dim mode. |

**TON1H (0x28)**

| BIT         | 7           | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|-------------|---|---|---|---|---|---|---|
| Field       | ton1h[7:0]  |   |   |   |   |   |   |   |
| Reset       | 0xFF        |   |   |   |   |   |   |   |
| Access Type | Write, Read |   |   |   |   |   |   |   |

| BITFIELD | BITS | DESCRIPTION                                                                                     |
|----------|------|-------------------------------------------------------------------------------------------------|
| ton1h    | 7:0  | Most significant byte of 18-bit on-time setting for channel 1. This value is set in 50ns units. |

**TON1L (0x29)**

| BIT         | 7           | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|-------------|---|---|---|---|---|---|---|
| Field       | ton1l[7:0]  |   |   |   |   |   |   |   |
| Reset       | 0xFF        |   |   |   |   |   |   |   |
| Access Type | Write, Read |   |   |   |   |   |   |   |

| BITFIELD | BITS | DESCRIPTION                                                                                      |
|----------|------|--------------------------------------------------------------------------------------------------|
| ton1l    | 7:0  | Least significant byte of 18-bit on-time setting for channel 1. This value is set in 50ns units. |

**TON2H (0x2A)**

| BIT         | 7           | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|-------------|---|---|---|---|---|---|---|
| Field       | ton2h[7:0]  |   |   |   |   |   |   |   |
| Reset       | 0xFF        |   |   |   |   |   |   |   |
| Access Type | Write, Read |   |   |   |   |   |   |   |

| BITFIELD | BITS | DESCRIPTION                                                                                     |
|----------|------|-------------------------------------------------------------------------------------------------|
| ton2h    | 7:0  | Most significant byte of 18-bit on-time setting for channel 2. This value is set in 50ns units. |

**TON2L (0x2B)**

| BIT         | 7           | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|-------------|---|---|---|---|---|---|---|
| Field       | ton2l[7:0]  |   |   |   |   |   |   |   |
| Reset       | 0xFF        |   |   |   |   |   |   |   |
| Access Type | Write, Read |   |   |   |   |   |   |   |

MAX25169

# Automotive, I<sup>2</sup>C-Controlled, 6-Channel, 150mA Backlight Driver and 4-Output TFT-LCD Bias with ASIL B Features

| BITFIELD | BITS | DESCRIPTION                                                                                      |
|----------|------|--------------------------------------------------------------------------------------------------|
| ton2l    | 7:0  | Least significant byte of 18-bit on-time setting for channel 2. This value is set in 50ns units. |

**TON3H (0x2C)**

| BIT         | 7           | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|-------------|---|---|---|---|---|---|---|
| Field       | ton3h[7:0]  |   |   |   |   |   |   |   |
| Reset       | 0xFF        |   |   |   |   |   |   |   |
| Access Type | Write, Read |   |   |   |   |   |   |   |

| BITFIELD | BITS | DESCRIPTION                                                                                     |
|----------|------|-------------------------------------------------------------------------------------------------|
| ton3h    | 7:0  | Most significant byte of 18-bit on-time setting for channel 3. This value is set in 50ns units. |

**TON3L (0x2D)**

| BIT         | 7           | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|-------------|---|---|---|---|---|---|---|
| Field       | ton3l[7:0]  |   |   |   |   |   |   |   |
| Reset       | 0xFF        |   |   |   |   |   |   |   |
| Access Type | Write, Read |   |   |   |   |   |   |   |

| BITFIELD | BITS | DESCRIPTION                                                                                      |
|----------|------|--------------------------------------------------------------------------------------------------|
| ton3l    | 7:0  | Least significant byte of 18-bit on-time setting for channel 3. This value is set in 50ns units. |

**TON1\_3LSB (0x2E)**

| BIT         | 7 | 6 | 5            | 4 | 3            | 2 | 1            | 0 |
|-------------|---|---|--------------|---|--------------|---|--------------|---|
| Field       | – | – | ton3lsb[1:0] |   | ton2lsb[1:0] |   | ton1lsb[1:0] |   |
| Reset       | – | – | 0x3          |   | 0x3          |   | 0x3          |   |
| Access Type | – | – | Write, Read  |   | Write, Read  |   | Write, Read  |   |

| BITFIELD | BITS | DESCRIPTION                                                                                      |
|----------|------|--------------------------------------------------------------------------------------------------|
| ton3lsb  | 5:4  | Least significant bits of 18-bit on-time setting for channel 3. This value is set in 50ns units. |
| ton2lsb  | 3:2  | Least significant bits of 18-bit on-time setting for channel 2. This value is set in 50ns units. |
| ton1lsb  | 1:0  | Least significant bits of 18-bit on-time setting for channel 1. This value is set in 50ns units. |

**TON4H (0x2F)**

| BIT         | 7           | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|-------------|---|---|---|---|---|---|---|
| Field       | ton4h[7:0]  |   |   |   |   |   |   |   |
| Reset       | 0xFF        |   |   |   |   |   |   |   |
| Access Type | Write, Read |   |   |   |   |   |   |   |

| BITFIELD | BITS | DESCRIPTION                                                                                     |
|----------|------|-------------------------------------------------------------------------------------------------|
| ton4h    | 7:0  | Most significant byte of 18-bit on-time setting for channel 4. This value is set in 50ns units. |

**TON4L (0x30)**

| BIT         | 7           | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|-------------|---|---|---|---|---|---|---|
| Field       | ton4l[7:0]  |   |   |   |   |   |   |   |
| Reset       | 0xFF        |   |   |   |   |   |   |   |
| Access Type | Write, Read |   |   |   |   |   |   |   |

| BITFIELD | BITS | DESCRIPTION                                                                                      |
|----------|------|--------------------------------------------------------------------------------------------------|
| ton4l    | 7:0  | Least significant byte of 18-bit on-time setting for channel 4. This value is set in 50ns units. |

**TON5H (0x31)**

| BIT         | 7           | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|-------------|---|---|---|---|---|---|---|
| Field       | ton5h[7:0]  |   |   |   |   |   |   |   |
| Reset       | 0xFF        |   |   |   |   |   |   |   |
| Access Type | Write, Read |   |   |   |   |   |   |   |

| BITFIELD | BITS | DESCRIPTION                                                                                     |
|----------|------|-------------------------------------------------------------------------------------------------|
| ton5h    | 7:0  | Most significant byte of 18-bit on-time setting for channel 5. This value is set in 50ns units. |

**TON5L (0x32)**

| BIT         | 7           | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|-------------|---|---|---|---|---|---|---|
| Field       | ton5l[7:0]  |   |   |   |   |   |   |   |
| Reset       | 0xFF        |   |   |   |   |   |   |   |
| Access Type | Write, Read |   |   |   |   |   |   |   |

| BITFIELD | BITS | DESCRIPTION                                                                                      |
|----------|------|--------------------------------------------------------------------------------------------------|
| ton5l    | 7:0  | Least significant byte of 18-bit on-time setting for channel 5. This value is set in 50ns units. |

**TON6H (0x33)**

| BIT         | 7           | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|-------------|---|---|---|---|---|---|---|
| Field       | ton6h[7:0]  |   |   |   |   |   |   |   |
| Reset       | 0xFF        |   |   |   |   |   |   |   |
| Access Type | Write, Read |   |   |   |   |   |   |   |

| BITFIELD | BITS | DESCRIPTION                                                                                     |
|----------|------|-------------------------------------------------------------------------------------------------|
| ton6h    | 7:0  | Most significant byte of 18-bit on-time setting for channel 6. This value is set in 50ns units. |

[TON6L \(0x34\)](#)

| BIT         | 7           | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|-------------|---|---|---|---|---|---|---|
| Field       | ton6l[7:0]  |   |   |   |   |   |   |   |
| Reset       | 0xFF        |   |   |   |   |   |   |   |
| Access Type | Write, Read |   |   |   |   |   |   |   |

| BITFIELD | BITS | DESCRIPTION                                                                                      |
|----------|------|--------------------------------------------------------------------------------------------------|
| ton6l    | 7:0  | Least significant byte of 18-bit on-time setting for channel 6. This value is set in 50ns units. |

[TON4\\_6LSB \(0x35\)](#)

| BIT         | 7 | 6 | 5            | 4 | 3            | 2 | 1            | 0 |
|-------------|---|---|--------------|---|--------------|---|--------------|---|
| Field       | – | – | ton6lsb[1:0] |   | ton5lsb[1:0] |   | ton4lsb[1:0] |   |
| Reset       | – | – | 0x3          |   | 0x3          |   | 0x3          |   |
| Access Type | – | – | Write, Read  |   | Write, Read  |   | Write, Read  |   |

| BITFIELD | BITS | DESCRIPTION                                                                                      |
|----------|------|--------------------------------------------------------------------------------------------------|
| ton6lsb  | 5:4  | Least significant bits of 18-bit on-time setting for channel 6. This value is set in 50ns units. |
| ton5lsb  | 3:2  | Least significant bits of 18-bit on-time setting for channel 5. This value is set in 50ns units. |
| ton4lsb  | 1:0  | Least significant bits of 18-bit on-time setting for channel 4. This value is set in 50ns units. |

[OPEN\\_REG \(0x36\)](#)

| BIT         | 7 | 6 | 5                  | 4                  | 3                  | 2                  | 1                  | 0                  |
|-------------|---|---|--------------------|--------------------|--------------------|--------------------|--------------------|--------------------|
| Field       | – | – | out6o              | out5o              | out4o              | out3o              | out2o              | out1o              |
| Reset       | – | – | 0x0                | 0x0                | 0x0                | 0x0                | 0x0                | 0x0                |
| Access Type | – | – | Read<br>Clears All | Read<br>Clears All | Read<br>Clears All | Read<br>Clears All | Read<br>Clears All | Read<br>Clears All |

| BITFIELD | BITS | DESCRIPTION                                                   |
|----------|------|---------------------------------------------------------------|
| out6o    | 5    | When 1, this bit indicates an open-circuit condition on OUT6. |
| out5o    | 4    | When 1, this bit indicates an open-circuit condition on OUT5. |
| out4o    | 3    | When 1, this bit indicates an open-circuit condition on OUT4. |
| out3o    | 2    | When 1, this bit indicates an open-circuit condition on OUT3. |
| out2o    | 1    | When 1, this bit indicates an open-circuit condition on OUT2. |
| out1o    | 0    | When 1, this bit indicates an open-circuit condition on OUT1. |

[SHORTGND\\_REG \(0x37\)](#)

| BIT         | 7 | 6 | 5                  | 4                  | 3                  | 2                  | 1                  | 0                  |
|-------------|---|---|--------------------|--------------------|--------------------|--------------------|--------------------|--------------------|
| Field       | – | – | out6sg             | out5sg             | out4sg             | out3sg             | out2sg             | out1sg             |
| Reset       | – | – | 0x0                | 0x0                | 0x0                | 0x0                | 0x0                | 0x0                |
| Access Type | – | – | Read<br>Clears All | Read<br>Clears All | Read<br>Clears All | Read<br>Clears All | Read<br>Clears All | Read<br>Clears All |

| BITFIELD | BITS | DESCRIPTION                                                     |
|----------|------|-----------------------------------------------------------------|
| out6sg   | 5    | When 1, this bit indicates a short-to-ground condition on OUT6. |
| out5sg   | 4    | When 1, this bit indicates a short-to-ground condition on OUT5. |
| out4sg   | 3    | When 1, this bit indicates a short-to-ground condition on OUT4. |
| out3sg   | 2    | When 1, this bit indicates a short-to-ground condition on OUT3. |
| out2sg   | 1    | When 1, this bit indicates a short-to-ground condition on OUT2. |
| out1sg   | 0    | When 1, this bit indicates a short-to-ground condition on OUT1. |

[SHORTED\\_LED\\_REG \(0x38\)](#)

| BIT         | 7 | 6 | 5                  | 4                | 3                  | 2                  | 1                  | 0                  |
|-------------|---|---|--------------------|------------------|--------------------|--------------------|--------------------|--------------------|
| Field       | – | – | out6sl             | out5sl           | out4sl             | out3sl             | out2sl             | out1sl             |
| Reset       | – | – | 0x0                | 0x0              | 0x0                | 0x0                | 0x0                | 0x0                |
| Access Type | – | – | Read<br>Clears All | Read Sets<br>All | Read<br>Clears All | Read<br>Clears All | Read<br>Clears All | Read<br>Clears All |

| BITFIELD | BITS | DESCRIPTION                                                 |
|----------|------|-------------------------------------------------------------|
| out6sl   | 5    | When 1, this bit indicates a shorted-LED condition on OUT6. |
| out5sl   | 4    | When 1, this bit indicates a shorted-LED condition on OUT5. |
| out4sl   | 3    | When 1, this bit indicates a shorted-LED condition on OUT4. |
| out3sl   | 2    | When 1, this bit indicates a shorted-LED condition on OUT3. |
| out2sl   | 1    | When 1, this bit indicates a shorted-LED condition on OUT2. |
| out1sl   | 0    | When 1, this bit indicates a shorted-LED condition on OUT1. |

[BL\\_MASK \(0x39\)](#)

| BIT         | 7 | 6                  | 5           | 4           | 3           | 2           | 1           | 0           |
|-------------|---|--------------------|-------------|-------------|-------------|-------------|-------------|-------------|
| Field       | – | battuv             | battuvmask  | bstuvmask   | omask       | sgmask      | bl_otwmask  | slmask      |
| Reset       | – | –                  | 0x1         | 0x0         | 0x0         | 0x0         | 0x1         | 0x0         |
| Access Type | – | Read<br>Clears All | Write, Read | Write, Read | Write, Read | Write, Read | Write, Read | Write, Read |

| BITFIELD   | BITS | DESCRIPTION                                                                                                                |
|------------|------|----------------------------------------------------------------------------------------------------------------------------|
| battuv     | 6    | This bit indicates an undervoltage on the BATT pin, which causes the backlight boost to be disabled.                       |
| battuvmask | 5    | Mask bit for BATT undervoltage indication. When 1, an undervoltage on BATT does not cause FLTB to assert low.              |
| bstuvmask  | 4    | Mask bit for boost undervoltage indication. When 1, an undervoltage on the boost output does not cause FLTB to assert low. |
| omask      | 3    | Mask bit for open-LED indication.                                                                                          |
| sgmask     | 2    | Mask bit for short-to-GND indication.                                                                                      |

| BITFIELD   | BITS | DESCRIPTION                                                                                    |
|------------|------|------------------------------------------------------------------------------------------------|
| bl_otwmask | 1    | When 1, this bit prevents a backlight overtemperature warning from asserting the FLTb pin low. |
| slmask     | 0    | Mask bit for shorted-LED indication.                                                           |

**BL\_DIAG (0x3A)**

| BIT         | 7                  | 6                  | 5                  | 4                  | 3                  | 2                  | 1                  | 0                  |
|-------------|--------------------|--------------------|--------------------|--------------------|--------------------|--------------------|--------------------|--------------------|
| Field       | v5oor              | rtoor              | irefoor            | bstuv              | bstov              | hw_rst             | bl_otw             | bl_ot              |
| Reset       |                    | 0x0                | 0x0                | 0x0                | 0x0                | 0x1                | 0x0                | 0x0                |
| Access Type | Read<br>Clears All | Read<br>Clears All | Read<br>Clears All | Read<br>Clears All | Read<br>Clears All | Read<br>Clears All | Read<br>Clears All | Read<br>Clears All |

| BITFIELD | BITS | DESCRIPTION                                                                                                                                                               |
|----------|------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| v5oor    | 7    | When 1, this bit indicates that the V5 supply for the NDRV output is out of range. When V5 out of range is detected, the backlight block is disabled.                     |
| rtoor    | 6    | When set to 1, this bit indicates that the resistor on RT is out of the prescribed range.                                                                                 |
| irefoor  | 5    | When 1, this bit indicates that the IREF current is too high. This is probably due to an incorrect resistor value on IREF. In this condition, the IC stops operation.     |
| bstuv    | 4    | If 1, an undervoltage has been detected on the boost output and the boost was disabled.                                                                                   |
| bstov    | 3    | If 1, the boost converter is at its overvoltage limit.                                                                                                                    |
| hw_rst   | 2    | If 1, the device has just emerged from a hardware reset (power-up). This bit is reset after the first read from this register.                                            |
| bl_otw   | 1    | If 1, the temperature of the backlight section is over +125°C or the temperature foldback circuit has reached the temperature T1.                                         |
| bl_ot    | 0    | If 1, the temperature of the backlight section exceeded +165°C and the backlight block was shut down or the TEMP input reached the level that shuts off the LED currents. |

**VBSTMON (0x3B)**

| BIT         | 7            | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|--------------|---|---|---|---|---|---|---|
| Field       | vbstmon[7:0] |   |   |   |   |   |   |   |
| Reset       | 0x00         |   |   |   |   |   |   |   |
| Access Type | Read Only    |   |   |   |   |   |   |   |

| BITFIELD | BITS | DESCRIPTION                          |
|----------|------|--------------------------------------|
| vbstmon  | 7:0  | ADC measurement result on BSTMON pin |

**IOUT1 (0x3C)**

| BIT         | 7          | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|------------|---|---|---|---|---|---|---|
| Field       | iout1[7:0] |   |   |   |   |   |   |   |
| Reset       | 0x00       |   |   |   |   |   |   |   |
| Access Type | Read Only  |   |   |   |   |   |   |   |

MAX25169

# Automotive, I<sup>2</sup>C-Controlled, 6-Channel, 150mA Backlight Driver and 4-Output TFT-LCD Bias with ASIL B Features

| BITFIELD | BITS | DESCRIPTION                             |
|----------|------|-----------------------------------------|
| iout1    | 7:0  | ADC current measurement result for OUT1 |

**IOUT2 (0x3D)**

| BIT         | 7          | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|------------|---|---|---|---|---|---|---|
| Field       | iout2[7:0] |   |   |   |   |   |   |   |
| Reset       | 0x00       |   |   |   |   |   |   |   |
| Access Type | Read Only  |   |   |   |   |   |   |   |

| BITFIELD | BITS | DESCRIPTION                             |
|----------|------|-----------------------------------------|
| iout2    | 7:0  | ADC current measurement result for OUT2 |

**IOUT3 (0x3E)**

| BIT         | 7          | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|------------|---|---|---|---|---|---|---|
| Field       | iout3[7:0] |   |   |   |   |   |   |   |
| Reset       | 0x00       |   |   |   |   |   |   |   |
| Access Type | Read Only  |   |   |   |   |   |   |   |

| BITFIELD | BITS | DESCRIPTION                             |
|----------|------|-----------------------------------------|
| iout3    | 7:0  | ADC current measurement result for OUT3 |

**IOUT4 (0x3F)**

| BIT         | 7          | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|------------|---|---|---|---|---|---|---|
| Field       | iout4[7:0] |   |   |   |   |   |   |   |
| Reset       | 0x00       |   |   |   |   |   |   |   |
| Access Type | Read Only  |   |   |   |   |   |   |   |

| BITFIELD | BITS | DESCRIPTION                             |
|----------|------|-----------------------------------------|
| iout4    | 7:0  | ADC current measurement result for OUT4 |

**IOUT5 (0x40)**

| BIT         | 7          | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|------------|---|---|---|---|---|---|---|
| Field       | iout5[7:0] |   |   |   |   |   |   |   |
| Reset       | 0x00       |   |   |   |   |   |   |   |
| Access Type | Read Only  |   |   |   |   |   |   |   |

| BITFIELD | BITS | DESCRIPTION                             |
|----------|------|-----------------------------------------|
| iout5    | 7:0  | ADC current measurement result for OUT5 |

[IOUT6 \(0x41\)](#)

| BIT         | 7          | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|------------|---|---|---|---|---|---|---|
| Field       | iout6[7:0] |   |   |   |   |   |   |   |
| Reset       | 0x00       |   |   |   |   |   |   |   |
| Access Type | Read Only  |   |   |   |   |   |   |   |

| BITFIELD | BITS | DESCRIPTION                             |
|----------|------|-----------------------------------------|
| iout6    | 7:0  | ADC current measurement result for OUT6 |

[burn\\_otp\\_reg \(0x78\)](#)

| BIT         | 7             | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|---------------|---|---|---|---|---|---|---|
| Field       | burn_otp[7:0] |   |   |   |   |   |   |   |
| Reset       | 0x0           |   |   |   |   |   |   |   |
| Access Type | Write Only    |   |   |   |   |   |   |   |

| BITFIELD | BITS | DESCRIPTION                                                                                                                                                    |
|----------|------|----------------------------------------------------------------------------------------------------------------------------------------------------------------|
| burn_otp | 7:0  | Command to copy the contents of registers 0x07–0x15 to the nonvolatile registers 0x17–0x25. Send the data 8'hA5 after the address 8'h78 to enable the command. |

[reboot\\_otp\\_reg \(0x79\)](#)

| BIT         | 7               | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|-----------------|---|---|---|---|---|---|---|
| Field       | reboot_otp[7:0] |   |   |   |   |   |   |   |
| Reset       |                 |   |   |   |   |   |   |   |
| Access Type | Write Only      |   |   |   |   |   |   |   |

| BITFIELD   | BITS | DESCRIPTION                                                                                                                                                                |
|------------|------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| reboot_otp | 7:0  | Command to copy the contents of the nonvolatile registers 0x17–0x15 to the working registers 0x17–0x25. Send the data 8'h5A after the address 8'h79 to enable the command. |

[soft\\_restart \(0x7A\)](#)

| BIT         | 7                 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|-------------------|---|---|---|---|---|---|---|
| Field       | soft_restart[7:0] |   |   |   |   |   |   |   |
| Reset       | 0x00              |   |   |   |   |   |   |   |
| Access Type | Write Only        |   |   |   |   |   |   |   |

| BITFIELD     | BITS | DESCRIPTION                                                                                                                                                                            |
|--------------|------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| soft_restart | 7:0  | Command used to restart the device from a latched fault mode. All faults are cleared when this command is executed. Send the data 8'hC3 after the address 8'h7A to enable the command. |

## Applications Information

### TFT Power Section

#### AVDD Boost Converter

##### Boost Converter Inductor Selection

Three key inductor parameters must be specified for operation with the device: inductance value (L), inductor saturation current ( $I_{SAT}$ ), and DC resistance ( $R_{DC}$ ). Use a 2.2 $\mu$ H inductor when the boost converter operates at 2.1MHz and 10 $\mu$ H at 420kHz. In unipolar mode, use a 3.3 $\mu$ H inductor at 2.1MHz.

The inductor's saturation rating must exceed the maximum LXP current limit.

##### Boost Output-Filter Capacitor Selection

The primary criterion for selecting the output-filter capacitor is low effective series resistance (ESR). The product of the peak inductor current and the output filter capacitor's ESR determine the amplitude of the high-frequency ripple seen on the output voltage. For stability, the boost output-filter capacitor should have a value of 10 $\mu$ F or greater at 2.1MHz and 20 $\mu$ F at 420kHz.

To avoid a large drop on HVINP when NAVDD is enabled, the capacitance on the HVINP node should be larger than that on NAVDD.

##### Boost Converter External Diode Selection

Select a diode with a peak current rating of at least the LXP current limit for use with the HVINP output. The diode breakdown-voltage rating should exceed the absolute value of the HVINP voltage. A Schottky diode improves the overall efficiency of the converter, but should be selected to have low leakage at the maximum operating temperature.

##### Setting the AVDD Voltage

The AVDD output is set by writing a 6-bit value to the avdd[5:0] field in the AVDD\_SET register (address 0x13). The output voltage also depends on the setting of the dis\_navdd bit in the TFT\_CONFIG register (address 0x07).

##### NAVDD Inverting Regulator

The NAVDD converter outputs a negative voltage whose absolute value is the same as AVDD. The most negative voltage NAVDD can output is -10.5V. NAVDD can be disabled using the dis\_navdd bit in the TFT\_CONFIG register.

##### NAVDD Regulator Inductor Selection

Three key inductor parameters must be specified for operation with the device: inductance value (L), inductor saturation current ( $I_{SAT}$ ), and DC resistance ( $R_{DC}$ ). Use a 2.2 $\mu$ H inductor when the converter operates at 2.1MHz and 10 $\mu$ H at 420kHz.

The inductor's saturation current rating must exceed the maximum LXN current limit.

##### NAVDD External Diode Selection

Select a diode with a peak current rating of at least the LXN current limit for use with the NAVDD output. The diode breakdown-voltage rating should exceed the sum of the maximum INN voltage and the absolute value of the NAVDD voltage. A Schottky diode improves the overall efficiency of the converter.

##### NAVDD Output Capacitor Selection

The primary criteria for selecting the output filter capacitor are low ESR and capacitance values, as the NAVDD capacitor provides the load current when the internal switch is on. The voltage ripple on the NAVDD output has two components:

- Ripple due to ESR, which is the product of the peak inductor current and the output filter capacitor's ESR
- Ripple due to bulk capacitance, which can be determined as follows:

$$\Delta V_{\text{BULK}} = \frac{I_{\text{NAVDDG}} \times \frac{D}{f_{\text{SW}}}}{C_{\text{NAVDD}}}$$

For stability, the NAVDD output capacitor should have a value of 10µF or greater when the switching frequency is 2.1MHz and greater than 15µF at 420kHz.

### Setting the V<sub>GON</sub> and V<sub>GOFF</sub> Output Voltages

Choose the external charge pump circuitry based on the ratios V<sub>GON</sub>/HV<sub>INP</sub> and V<sub>GOFF</sub>/HV<sub>INP</sub>. In all cases, the V<sub>GON</sub> and V<sub>GOFF</sub> voltages should be maintained within their permitted operating ranges.

The V<sub>GON</sub> and V<sub>GOFF</sub> voltages are set by writing 6-bit values to the V<sub>GON</sub> (0x14) and V<sub>GOFF</sub> (0x15) registers. Note that the V<sub>GON</sub> voltage range depends on the setting of dis\_navdd bit.

## LED Driver Section

### DC-DC Converter for LED Driver

Two different converter topologies are possible with the DC-DC controller in the device, which has the ground-referenced outputs necessary to use the constant-current sink drivers. If the LED string forward voltage is always higher than the input supply voltage range, use the boost-converter topology. If the LED string forward voltage falls within the supply-voltage range, use the SEPIC topology.

Note that the boost converter topology provides the highest efficiency.

### Power-Circuit Design

First select a converter topology based on the above factors. Determine the required input supply-voltage range, the maximum voltage needed to drive the LED strings, including the worst-case 0.875V across the constant LED current sink (V<sub>LED</sub>), and the total output current needed to drive the LED strings (I<sub>LED</sub>) as follows:

$$I_{\text{LED}} = I_{\text{STRING}} \times N_{\text{STRING}}$$

where I<sub>STRING</sub> is the LED current per string in amperes and N<sub>STRING</sub> is the number of strings used. Calculate the maximum duty cycle (D<sub>MAX</sub>) using the following equations:

#### Boost Configuration:

$$D_{\text{MAX}} = \frac{(V_{\text{LED}} + V_{\text{D1}} - V_{\text{IN\_MIN}})}{(V_{\text{LED}} + V_{\text{D1}} - V_{\text{DS}} - 0.42)}$$

#### SEPIC Configuration:

$$D_{\text{MAX}} = \frac{(V_{\text{LED}} + V_{\text{D1}})}{(V_{\text{IN\_MIN}} - V_{\text{DS}} - 0.42 + V_{\text{LED}} + V_{\text{D1}})}$$

where V<sub>D1</sub> is the forward drop of the rectifier diode in volts (approximately 0.6V), V<sub>IN\_MIN</sub> is the minimum input supply voltage in volts, V<sub>DS</sub> is the drain-to-source voltage of the external MOSFET in volts when it is on, and 0.42V is the peak current-sense voltage. Initially, use an approximate value of 0.2V for V<sub>DS</sub> to calculate D<sub>MAX</sub>. Calculate a more accurate value of D<sub>MAX</sub> after the power MOSFET is selected based on the maximum inductor current.

### Boost Configuration

The average inductor current varies with the line voltage, and the maximum average current occurs at the lowest line voltage. For the boost converter, the average inductor current is equal to the input current. Select the maximum peak-to-peak ripple on the inductor current (ΔI<sub>L</sub>). The recommended peak-to-peak ripple is 60% of the average inductor current.

Use the following equations to calculate the maximum average inductor current (I<sub>LAVG</sub>) and peak inductor current (I<sub>LP</sub>) in amperes.

$$I_{\text{LAVG}} = \frac{I_{\text{LED}}}{1 - D_{\text{MAX}}}$$

Allowing the peak-to-peak inductor ripple ( $\Delta I_L$ ) to be  $\pm 30\%$  of the average inductor current:

$$\Delta I_L = I_{L_{AVG}} \times 0.3 \times 2$$

and

$$I_{L_P} = I_{L_{AVG}} + \frac{\Delta I_L}{2}$$

Calculate the minimum inductance value ( $L_{MIN}$ ) in henries with the inductor-current ripple set to the maximum value.

$$L_{MIN} = \frac{(V_{IN\_MIN} - V_{DS} - 0.41) \times D_{MAX}}{f_{SW} \times \Delta I_L}$$

where 0.41V is the peak current-sense voltage (with  $bl\_ilim$  set to 0, if  $bl\_ilim$  is set to 1 use 0.3V in this equation). Choose an inductor that has a minimum inductance greater than the calculated  $L_{MIN}$  and current rating greater than  $I_{L_P}$ . The recommended saturation current limit of the selected inductor is 10% higher than the inductor peak current for boost configuration.

### SEPIC Configuration

Power-circuit design for the SEPIC configuration is very similar to a conventional design, with the output voltage referenced to the input supply voltage. For SEPIC, the output is referenced to ground and the inductor is split into two parts (see the [SEPIC Application Circuit](#)). One of the inductors (L2) has the LED current as the average current, and the other inductor (L1) has the input current as its average current. Use the following equations to calculate the average inductor currents ( $I_{L1_{AVG}}$ ,  $I_{L2_{AVG}}$ ) and peak inductor currents ( $I_{L1_P}$ ,  $I_{L2_P}$ ) in amperes:

$$I_{L1_{AVG}} = \frac{I_{LED} \times D_{MAX} \times 1.1}{1 - D_{MAX}}$$

The factor 1.1 provides a 10% margin to account for the converter losses:

$$I_{L2_{AVG}} = I_{LED}$$

Assuming the peak-to-peak inductor ripple ( $\Delta I_L$ ) is  $\pm 30\%$  of the average inductor current:

$$\Delta I_{L1} = I_{L1_{AVG}} \times 0.3 \times 2$$

and

$$I_{L1_P} = I_{L1_{AVG}} + \frac{\Delta I_{L1}}{2}$$

$$\Delta I_{L2} = I_{L2_{AVG}} \times 0.3 \times 2$$

and

$$I_{L2_P} = I_{L2_{AVG}} + \frac{\Delta I_{L2}}{2}$$

Calculate the minimum inductance values  $L1_{MIN}$  and  $L2_{MIN}$  in henries with the inductor current ripples set to the maximum value as follows:

$$L1_{MIN} = \frac{(V_{IN\_MIN} - V_{DS} - 0.42) \times D_{MAX}}{f_{SW} \times \Delta I_{L1}}$$

$$L2_{MIN} = \frac{(V_{IN\_MIN} - V_{DS} - 0.42) \times D_{MAX}}{f_{SW} \times \Delta I_{L2}}$$

where 0.42V is the peak current-sense voltage. Choose inductors that have a minimum inductance greater than the calculated  $L1_{MIN}$  and  $L2_{MIN}$ , and current ratings greater than  $I_{L1_P}$  and  $I_{L2_P}$ , respectively. The recommended saturation current limit of the selected inductor is 10% higher than the inductor peak current.

For simplifying further calculations, consider L1 and L2 as a single inductor with L1/L2 connected in parallel. The combined inductance value and current is calculated as follows:

$$L_{\text{MIN}} = \frac{L1_{\text{MIN}} \times L2_{\text{MIN}}}{L1_{\text{MIN}} + L2_{\text{MIN}}}$$

and

$$IL_{\text{AVG}} = IL1_{\text{AVG}} + IL2_{\text{AVG}}$$

where  $IL_{\text{AVG}}$  represents the total average current through both the inductors, connected together for SEPIC configuration. Use these values in the calculations for the SEPIC configuration in the following sections.

Select coupling capacitor CS so that the peak-to-peak ripple on it is less than 2% of the minimum input supply voltage. This ensures that the second-order effects created by the series resonant circuit comprising L1, CS, and L2 do not affect the normal operation of the converter. Use the following equation to calculate the minimum value of CS:

$$CS \geq \frac{I_{\text{LED}} \times D_{\text{MAX}}}{V_{\text{IN\_MIN}} \times 0.02 \times f_{\text{SW}}}$$

where CS is the minimum value of the coupling capacitor in farads,  $I_{\text{LED}}$  is the LED current in amperes, and the factor 0.02 accounts for 2% ripple.

### Current-Sense Resistor and Slope Compensation

The MAX25169 backlight boost generates a current ramp for slope compensation. This ramp current is synchronized to the switching frequency, starting from zero at the beginning of every clock cycle and rising linearly to reach 50μA at the end of the clock cycle. The slope-compensating resistor ( $R_{\text{SC}}$ ) is connected between the CSP input and the source of the external MOSFET. This adds a programmable ramp voltage to the CSP input voltage to provide slope compensation.

Use the following equations to calculate the value of slope-compensation resistance ( $R_{\text{SC}}$ ):

#### Boost Configuration:

$$R_{\text{SC}} = \frac{(V_{\text{LED}} - 2 \times V_{\text{IN\_MIN}}) \times R_{\text{CS}} \times 3}{L_{\text{MIN}} \times 50\mu\text{A} \times f_{\text{SW}} \times 4}$$

#### SEPIC and Coupled-Inductor Configurations:

$$R_{\text{SC}} = \frac{(V_{\text{LED}} - V_{\text{IN\_MIN}}) \times R_{\text{CS}} \times 3}{L_{\text{MIN}} \times 50\mu\text{A} \times f_{\text{SW}} \times 4}$$

where  $V_{\text{LED}}$  and  $V_{\text{IN\_MIN}}$  are in volts,  $R_{\text{SC}}$  and  $R_{\text{CS}}$  are in ohms,  $L_{\text{MIN}}$  is in henries, and  $f_{\text{SW}}$  is in hertz. The value of the switch current-sense resistor ( $R_{\text{CS}}$ ) can be calculated as follows:

#### Boost Configuration:

$$R_{\text{CS}} = \frac{4 \times L_{\text{MIN}} \times f_{\text{SW}} \times V_{\text{CS\_MAX}} \times 0.9}{I_{\text{LP}} \times 4 \times L_{\text{MIN}} \times f_{\text{SW}} + D_{\text{MAX}} \times (V_{\text{LED}} - 2 \times V_{\text{IN\_MIN}}) \times 3}$$

#### SEPIC and Coupled-Inductor Configurations:

$$R_{\text{CS}} = \frac{4 \times L_{\text{MIN}} \times f_{\text{SW}} \times V_{\text{CS\_MAX}} \times 0.9}{I_{\text{LP}} \times 4 \times L_{\text{MIN}} \times f_{\text{SW}} + D_{\text{MAX}} \times (V_{\text{LED}} - V_{\text{IN\_MIN}}) \times 3}$$

where  $V_{\text{CS\_MAX}}$  is the minimum value of the peak current-sense threshold or 0.38 with  $bl\_ilim = 0$  and 0.275 when  $bl\_ilim$  is set to 1. The current-sense threshold also includes the slope-compensation component. The minimum current-sense threshold is multiplied by 0.9 to take tolerances into account.

### Output Capacitor Selection

For all converter topologies, the output capacitor supplies the load current when the main switch is on. The function of the output capacitor is to reduce the converter output ripple to acceptable levels. The entire output-voltage ripple appears across the constant-current sink outputs because the LED string voltages are stable due to the constant current. For the MAX25169, limit the peak-to-peak output-voltage ripple to 250mV to get stable output current.

The ESR, ESL, and bulk capacitance of the output capacitor contribute to the output ripple. In most applications, using low-ESR ceramic capacitors can dramatically reduce the output ESR and ESL effects, connecting multiple ceramic

capacitors in parallel to achieve the required bulk capacitance. To minimize audible noise during PWM dimming however, it may be desirable to limit the use of ceramic capacitors on the boost output. In such cases, an additional electrolytic or tantalum capacitor can provide the majority of the bulk capacitance.

### External Switching-MOSFET Selection

The external switching MOSFET should have a voltage rating sufficient to withstand the maximum boost output voltage, together with the rectifier diode drop and any possible overshoot due to ringing caused by parasitic inductance and capacitance. The recommended MOSFET  $V_{DS}$  voltage rating is 30% higher than the sum of the maximum output voltage and the rectifier diode drop.

The continuous drain-current rating of the MOSFET ( $I_D$ ), when the case temperature is at the maximum operating ambient temperature, should be greater than that calculated as follows:

$$I_{D_{RMS}} = \left( \sqrt{I_{L_{AVG}}^2 \times D_{MAX}} \right) \times 1.3$$

The MOSFET dissipates power due to both switching losses and conduction losses. Use the following equation to calculate the conduction losses in the MOSFET:

$$P_{COND} = I_{L_{AVG}}^2 \times D_{MAX} \times R_{DS(ON)}$$

where  $R_{DS(ON)}$  is the on-state drain-to-source resistance of the MOSFET. Use the following equation to calculate the switching losses in the MOSFET:

$$P_{SW} = \frac{I_{L_{AVG}} \times V_{LED}^2 \times C_{GD} \times f_{SW}}{2} \times \left( \frac{1}{I_{GON}} + \frac{1}{I_{GOFF}} \right)$$

where  $I_{GON}$  and  $I_{GOFF}$  are the gate currents of the MOSFET in amperes when it is turned on and turned off, respectively.  $C_{GD}$  is the gate-to-drain MOSFET capacitance in farads.

### Rectifier Diode Selection

Using a Schottky rectifier diode produces less forward drop and puts the least burden on the MOSFET during reverse recovery. A diode with considerable reverse-recovery time increases the MOSFET switching loss. Select a Schottky diode with a voltage rating 20% higher than the maximum boost-converter output voltage and current rating greater than the following:

$$I_D = I_{L_{AVG}} \times (1 - D_{MAX}) \times 1.2$$

### Feedback Compensation

During normal operation, the feedback control loop regulates the minimum  $OUT_{-}$  voltage to fall within the window comparator limits of 0.58V and 0.85V when LED string currents are enabled during PWM dimming. When LED currents are off during PWM dimming, the control loop turns off the converter. When the PWM dimming pulses are narrower than 50μs, the converter operates continuously.

The worst-case condition for the feedback loop is when the LED driver is in normal mode regulating the minimum  $OUT_{-}$  voltage. The switching converter small-signal transfer function has a right-half plane (RHP) zero for boost configuration if the inductor current is in continuous-conduction mode. The RHP zero adds a 20dB/decade gain and a 90° phase lag, which is difficult to compensate.

The worst-case RHP zero frequency ( $f_{ZRHP}$ ) is calculated as follows:

#### Boost Configuration:

$$f_{ZRHP} = \frac{V_{LED} \times (1 - D_{MAX})^2}{2\pi \times L \times I_{LED}}$$

#### SEPIC Configuration:

$$f_{ZRHP} = \frac{V_{LED} \times (1 - D_{MAX})^2}{2\pi \times L \times I_{LED} \times D_{MAX}}$$

where  $f_{ZRHP}$  is in hertz,  $V_{LED}$  is in volts,  $L$  is the inductance value of L1 in henries, and  $I_{LED}$  is in amperes. A simple way to avoid this zero is to roll off the loop gain to 0dB at a frequency less than 1/5 of the RHP zero frequency with a -20dB/decade slope.

The switching converter small-signal transfer function also has an output pole. The effective output impedance, together with the output filter capacitance, determines the output pole frequency ( $f_{P1}$ ), calculated as follows:

**Boost Configuration:**

$$f_{P1} = \frac{I_{LED}}{2\pi \times V_{LED} \times C_{OUT}}$$

**SEPIC Configuration:**

$$f_{P1} = \frac{I_{LED} \times D_{MAX}}{2\pi \times V_{LED} \times C_{OUT}}$$

where  $f_{P1}$  is in hertz,  $V_{LED}$  is in volts,  $I_{LED}$  is in amperes, and  $C_{OUT}$  is in farads. Compensation components ( $R_{COMP}$  and  $C_{COMP}$ ) perform two functions:  $C_{COMP}$  introduces a low-frequency pole that presents a -20dB/decade slope to the loop gain, and  $R_{COMP}$  flattens the gain of the error amplifier for frequencies above the zero formed by  $R_{COMP}$  and  $C_{COMP}$ . For compensation, this zero is placed at the output pole frequency ( $f_{P1}$ ), so it provides a -20dB/decade slope for frequencies above  $f_{P1}$  to the combined modulator and compensator response.

The value of  $R_{COMP}$  needed to fix the total loop gain at  $f_{P1}$ , so the total loop gain crosses 0dB with -20dB/decade slope at 1/5 the RHP zero frequency, is calculated as follows:

**Boost Configuration:**

$$R_{COMP} = \frac{f_{ZRHP} \times R_{CS} \times I_{LED}}{5 \times f_{P1} \times GM_{COMP} \times V_{LED} \times (1 - D_{MAX})}$$

**SEPIC Configuration:**

$$R_{COMP} = \frac{f_{ZRHP} \times R_{CS} \times I_{LED} \times D_{MAX}}{5 \times f_{P1} \times GM_{COMP} \times V_{LED} \times (1 - D_{MAX})}$$

where  $R_{COMP}$  is the compensation resistor in ohms,  $f_{ZRHP}$  and  $f_{P2}$  are in hertz,  $R_{CS}$  is the switch current-sense resistor in ohms, and  $GM_{COMP}$  is the transconductance of the error amplifier (700 $\mu$ S).

The value of  $C_{COMP}$  is calculated as follows:

$$C_{COMP} = \frac{1}{2\pi \times R_{COMP} \times f_{Z1}}$$

where  $f_{Z1}$  is the compensation zero placed at 1/5 of the crossover frequency that is, in turn, set at 1/5 of the  $f_{ZRHP}$ . If the output capacitors do not have low ESR, the ESR zero frequency may fall within the 0dB crossover frequency. An additional pole may be required to cancel out this pole placed at the same frequency. This can be implemented by connecting a capacitor from COMP directly to GND.

## Using NV Memory

Follow the sequence below to perform nonvolatile programming of the device when the autorefresh function is not used:

1. Apply a voltage between 3.3V and 5V to the IN and INN pins with the device in full I<sup>2</sup>C mode.
2. Write the desired values to be stored in OTP to the registers from 0x07 to 0x15.
3. Apply 8.5V to  $V_{PROG}$ .
4. Optionally wait to ensure the 8.5V at  $V_{PROG}$  is stable.
5. Send burn\_otp\_reg (write 0xA5 to register address 0x78) command. If parity is enabled, ensure the overall parity is even by altering the final byte if necessary.
6. Wait 20ms.
7. If the nv\_flg bit is 0, the write was successful; go to the next step. If nv\_flg = 1, perform retry (steps 5 and 6).
8. Send reboot\_otp (write 0x5A to register address 0x79) command or power-cycle the part.

Special care is required when performing nonvolatile programming with the autorefresh feature enabled. In such cases,

follow the sequence below when at least one calibration has already been performed:

1. Apply a voltage between 3.3V and 5V to the IN and INN pins with the device in full I<sup>2</sup>C mode.
2. Set REG\_CTRL[6] = 1. This dis\_refresh bit inhibits refresh during programming operations.
3. Write the desired data to volatile registers.
4. Apply 8.5V to V<sub>PROG</sub>.
5. Send the burn\_otp\_reg (write 0xA5 to 0x78) command.
6. Wait 20ms.
7. If the nvflt bit is 0, the write was successful; go to the next step. If nvflt = 1, perform retry (steps 5 and 6).
8. Send reboot\_otp (write 0x5A to register address 0x79) command or power-cycle the part.
9. Check/set REG\_CTRL[6] = 0.

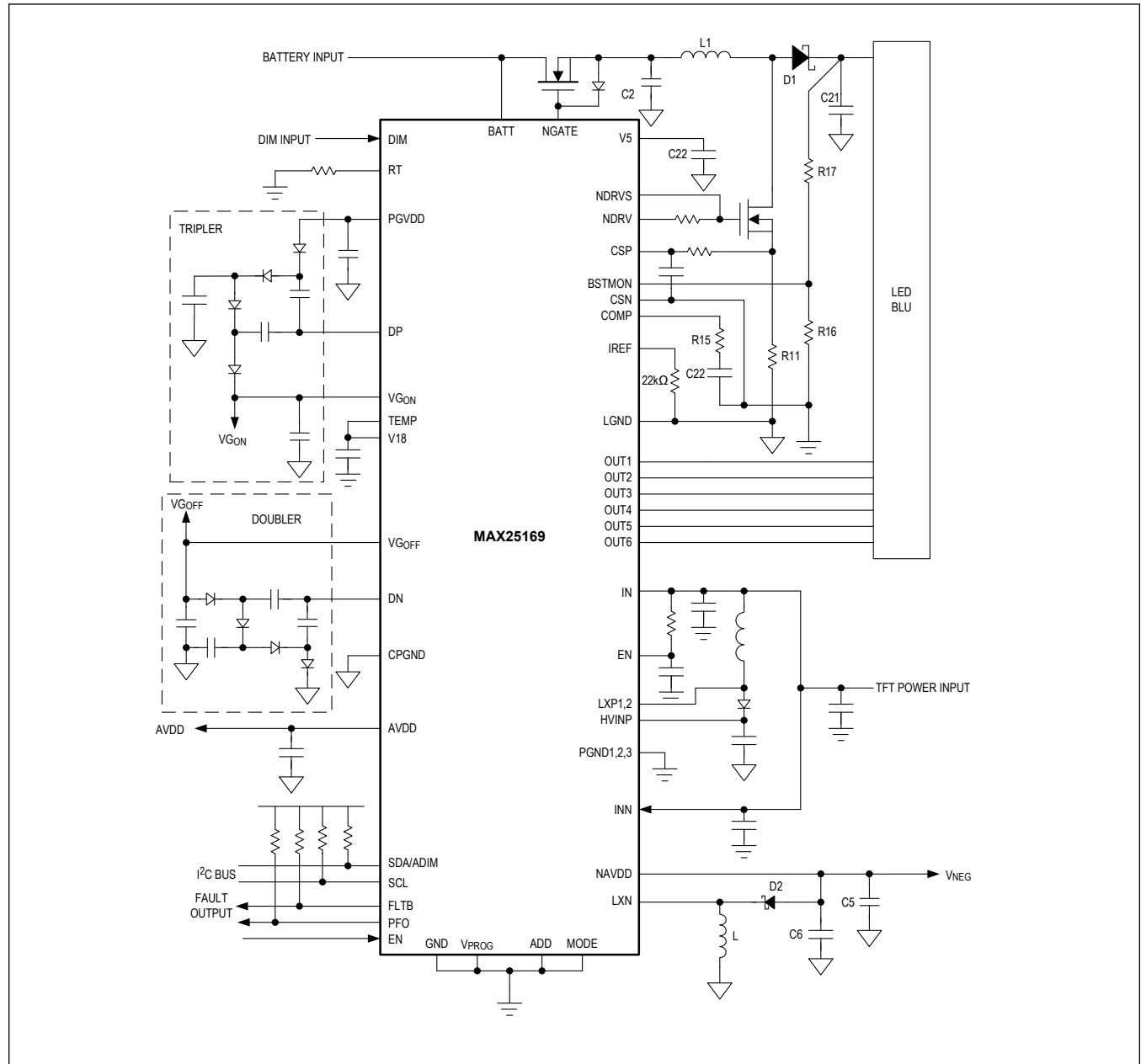
The nonvolatile memory can be written to a total of six times.

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Backlight Driver and 4-Output TFT-LCD Bias with  
ASIL B Features

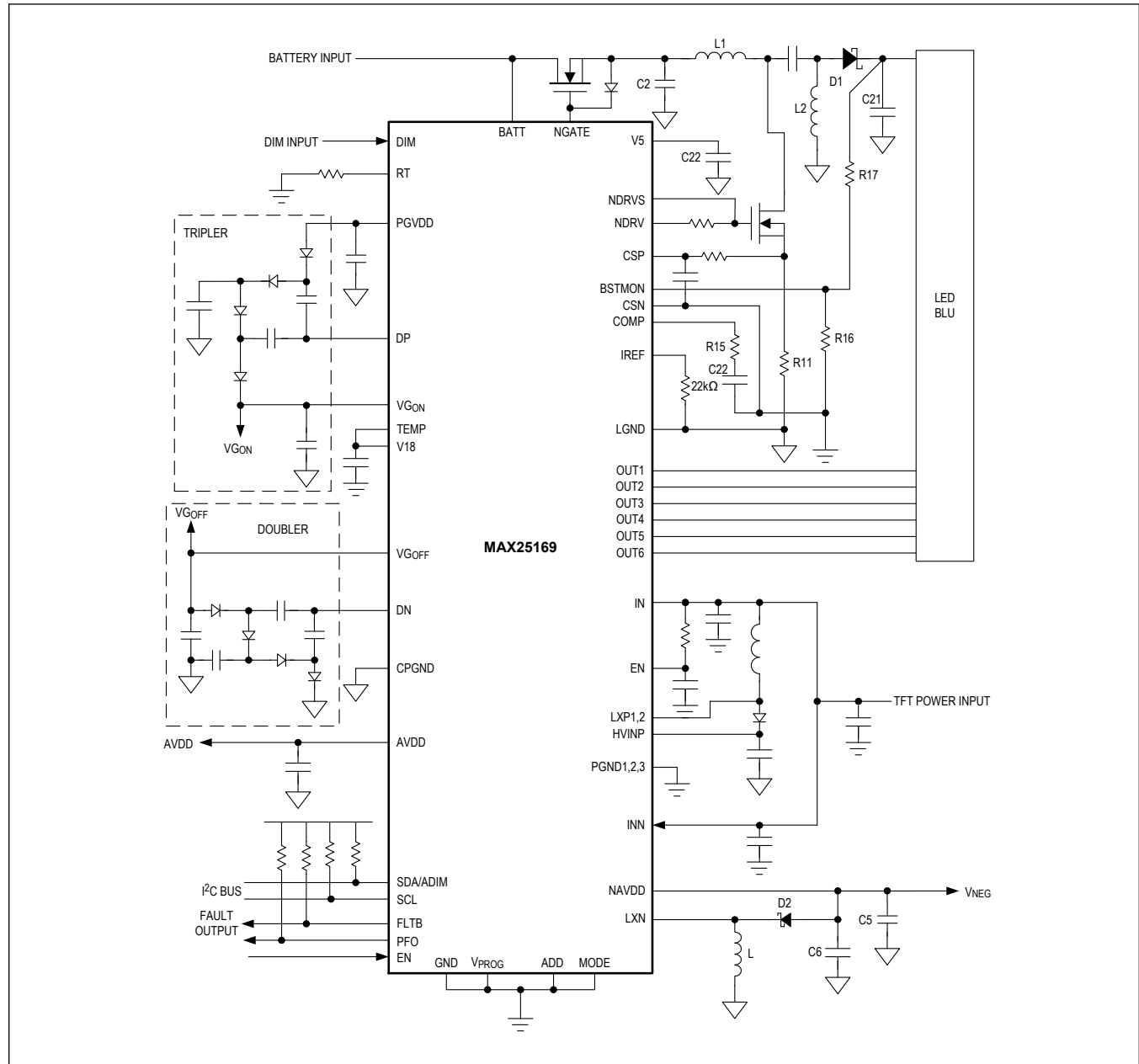
## Typical Application Circuit

### Basic Application Circuit



## Typical Application Circuit (continued)

## SEPIC Application Circuit



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### Ordering Information

| PART              | TEMP RANGE      | PACKAGE CODE | PIN-PACKAGE | FEATURES                                     | 7-BIT I <sup>2</sup> C ADDRESSES |
|-------------------|-----------------|--------------|-------------|----------------------------------------------|----------------------------------|
| MAX25169ATM/V+    | -40°C to +125°C | T4877+9C     | 48 TQFN-EP* | —                                            | 0x46/0x47                        |
| MAX25169ATM/VY+   | -40°C to +125°C | T4877Y+9C    | 48 TQFN-EP* | —                                            | 0x46/0x47                        |
| MAX25169ATMB/V+** | -40°C to +125°C | T4877+9C     | 48 TQFN-EP* | V <sub>GON</sub> /V <sub>GOFF</sub> disabled | 0x46/0x47                        |

/V Denotes an automotive-qualified part.

+ Denotes a lead(Pb)-free/RoHS-compliant package.

\*EP = Exposed pad.

Y = Side-wettable (SW) package.

\*\*Future product—contact factory for availability.

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## Revision History

| REVISION<br>NUMBER | REVISION<br>DATE | DESCRIPTION                                                                                     | PAGES<br>CHANGED |
|--------------------|------------------|-------------------------------------------------------------------------------------------------|------------------|
| 0                  | 9/22             | Initial release                                                                                 | —                |
| 1                  | 6/23             | Removed future product designation from side-wettable package, added parity checking paragraph. | 38, 77           |